# GigaDevice Semiconductor Inc.

# GD32F307xx Arm® Cortex®-M4 32-bit MCU

**Datasheet** 

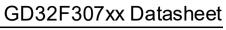


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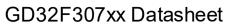
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### 1. General description

The GD32F307xx device belongs to the mainstream line of GD32 MCU Family. It is a new 32-bit general-purpose microcontroller based on the Arm® Cortex®-M4 RISC core with best cost-performance ratio in terms of enhanced processing capacity, reduced power consumption and peripheral set. The Cortex®-M4 core features implements a full set of DSP instructions to address digital signal control markets that demand an efficient, easy-to-use blend of control and signal processing capabilities. It also provides a Memory Protection Unit (MPU) and powerful trace technology for enhanced application security and advanced debug support.

The GD32F307xx device incorporates the Arm® Cortex®-M4 32-bit processor core operating at 120 MHz frequency with Flash accesses zero wait states to obtain maximum efficiency. It provides up to 1024 KB on-chip Flash memory and 96 KB SRAMmemory. An extensive range of enhanced I/Os and peripherals connected to two APB buses. The devices offer up to two 12-bit 2.6 MSPS ADCs, two 12-bit DACs, up to ten general 16-bit timers, two 16-bit PWM advanced timers, and two 16-bit basic timers, as well as standard and advanced communication interfaces: up to three SPIs, two I2Cs, three USARTs and two UARTs, two I2Ss, two CANs, a USBFS and an ENET.

The device operates from a 2.6 to 3.6 V power supply and available in –40 to +85 °C temperature range. Several power saving modes provide the flexibility for maximum optimization between wakeup latency and power consumption, an especially important consideration in low power applications.

The above features make GD32F307xx devices suitable for a wide range of interconnection and advanced applications, especially in areas such as industrial control, consumer and handheld equipment, communication networks, embedded modules, human machine interface, security and alarm systems, graphic display, automotive navigation, IoT and so on.





## 2. Device overview

## 2.1. Device information

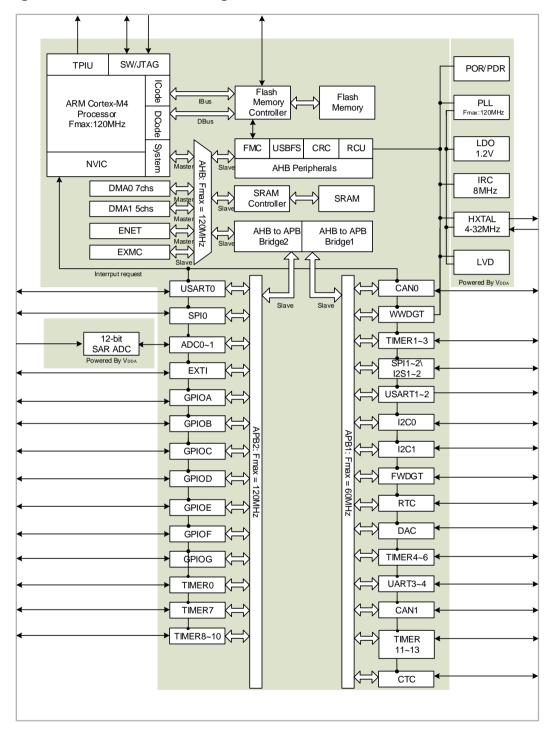
Table 2-1. GD32F307xx devices features and peripheral list

|                |                   |             |             | feature     |             | D32F307     |             |             |             |             |
|----------------|-------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| ı              | Part Number       | RC          | RE          | RG          | VC          | VE          | VG          | zc          | ZE          | ZG          |
|                | Code area<br>(KB) | 256         | 256         | 256         | 256         | 256         | 256         | 256         | 256         | 256         |
| Flash          | Data area<br>(KB) | 0           | 256         | 768         | 0           | 256         | 768         | 0           | 256         | 768         |
|                | Total (KB)        | 256         | 512         | 1024        | 256         | 512         | 1024        | 256         | 512         | 1024        |
|                | SRAM (KB)         | 96          | 96          | 96          | 96          | 96          | 96          | 96          | 96          | 96          |
|                | General           | 4           | 4           | 10          | 4           | 4           | 10          | 4           | 4           | 10          |
|                | timer(16-bit)     | (1-4)       | (1-4)       | (1-4,8-13)  | (1-4)       | (1-4)       | (1-4,8-13)  | (1-4)       | (1-4)       | (1-4,8-13)  |
|                | Advanced          | 1           | 2           | 2           | 1           | 2           | 2           | 2           | 2           | 2           |
| ,              | timer(16-bit)     | (0)         | (0,7)       | (0,7)       | (0)         | (0,7)       | (0,7)       | (0,7)       | (0,7)       | (0,7)       |
| Timers         | Basic             | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           |
| F              | timer(16-bit)     | (5-6)       | (5-6)       | (5-6)       | (5-6)       | (5-6)       | (5-6)       | (5-6)       | (5-6)       | (5-6)       |
|                | SysTick           | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           |
|                | Watchdog          | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           |
|                | RTC               | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           |
|                | USART             | 3           | 3           | 3           | 3           | 3           | 3           | 3           | 3           | 3           |
|                |                   | (0-2)       | (0-2)       | (0-2)       | (0-2)       | (0-2)       | (0-2)       | (0-2)       | (0-2)       | (0-2)       |
|                |                   | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           |
| <u>;</u>       |                   | (3-4)       | (3-4)       | (3-4)       | (3-4)       | (3-4)       | (3-4)       | (3-4)       | (3-4)       | (3-4)       |
| ctiv           | I2C               | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           |
| Connectivity   | SPI/I2S           | 3/2         | 3/2         | 3/2         | 3/2         | 3/2         | 3/2         | 3/2         | 3/2         | 3/2         |
| ပိ             |                   | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) | (0-2)/(1-2) |
|                | ENET              | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           |
|                | CAN               | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           |
|                | USBFS             | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           | 1           |
|                | GPIO              | 51          | 51          | 51          | 80          | 80          | 80          | 112         | 112         | 112         |
|                | EXMC              | 0           | 0           | 0           | 1           | 1           | 1           | 1           | 1           | 1           |
|                | EXTI              | 16          | 16          | 16          | 16          | 16          | 16          | 16          | 16          | 16          |
| ADC Unit (CHs) |                   | 2(16)       | 2(16)       | 2(16)       | 2(16)       | 2(16)       | 2(16)       | 2(16)       | 2(16)       | 2(16)       |
|                | DAC               | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           | 2           |
|                | Package           |             | LQFP64      |             |             | LQFP100     |             |             | LQFP144     | ļ           |



## 2.2. Block diagram

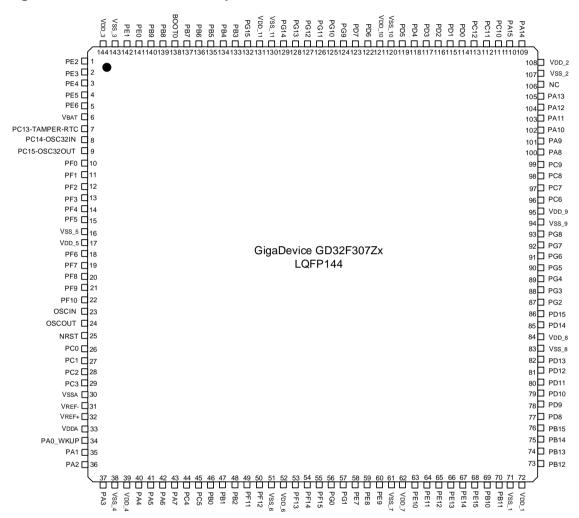
Figure 2-1 GD32F307xx block diagram





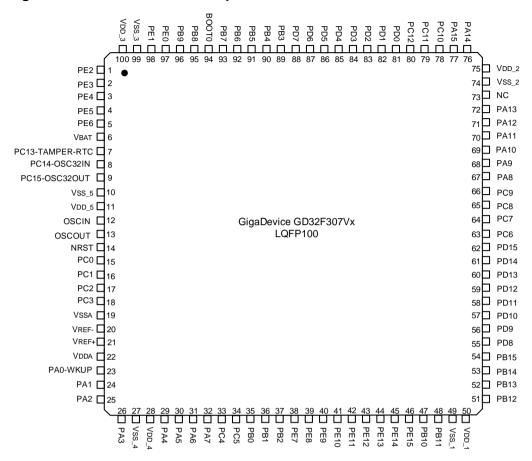
### 2.3. Pinouts and pin assignment

#### Figure 2-2 GD32F307Zx LQFP144 pinouts



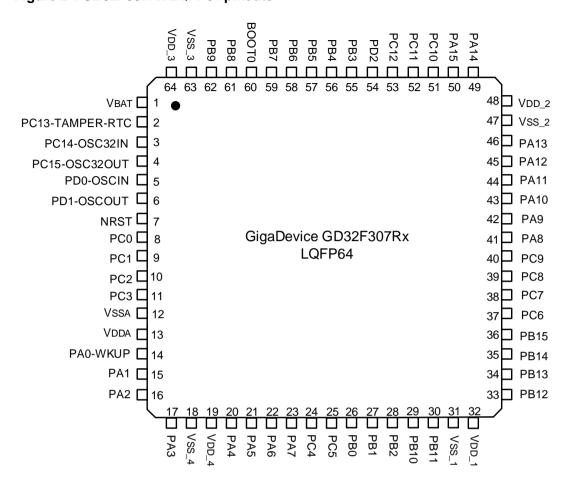


#### Figure 2-3 GD32F307Vx LQFP100 pinouts





#### Figure 2-4 GD32F307Rx LQFP64 pinouts

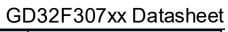




## 2.4. Memory map

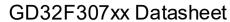
Table 2-2. GD32F307xx memory map

| Pre-defined     | Bus   | Address                   | Peripherals           |
|-----------------|-------|---------------------------|-----------------------|
| Regions         | Dus   | Address                   | renpherais            |
| External device |       | 0xA000 0000 - 0xA000 0FFF | EXMC - SWREG          |
|                 | AHB3  | 0x9000 0000 - 0x9FFF FFFF | EXMC - PC CARD        |
| External RAM    | ALIDS | 0x7000 0000 - 0x8FFF FFFF | EXMC - NAND           |
|                 |       | 0x6000 0000 - 0x6FFF FFFF | EXMC - NOR/PSRAM/SRAM |
|                 |       | 0x5000 0000 - 0x5003 FFFF | USBFS                 |
|                 |       | 0x4008 0000 - 0x4FFF FFFF | Reserved              |
|                 |       | 0x4004 0000 - 0x4007 FFFF | Reserved              |
|                 |       | 0x4002 BC00 - 0x4003 FFFF | Reserved              |
|                 |       | 0x4002 B000 - 0x4002 BBFF | Reserved              |
|                 |       | 0x4002 A000 - 0x4002 AFFF | Reserved              |
|                 |       | 0x4002 8000 - 0x4002 9FFF | ENET                  |
|                 |       | 0x4002 6800 - 0x4002 7FFF | Reserved              |
|                 |       | 0x4002 6400 - 0x4002 67FF | Reserved              |
|                 |       | 0x4002 6000 - 0x4002 63FF | Reserved              |
|                 |       | 0x4002 5000 - 0x4002 5FFF | Reserved              |
|                 | AHB1  | 0x4002 4000 - 0x4002 4FFF | Reserved              |
|                 |       | 0x4002 3C00 - 0x4002 3FFF | Reserved              |
|                 |       | 0x4002 3800 - 0x4002 3BFF | Reserved              |
|                 |       | 0x4002 3400 - 0x4002 37FF | Reserved              |
|                 |       | 0x4002 3000 - 0x4002 33FF | CRC                   |
| Peripheral      |       | 0x4002 2C00 - 0x4002 2FFF | Reserved              |
|                 |       | 0x4002 2800 - 0x4002 2BFF | Reserved              |
|                 |       | 0x4002 2400 - 0x4002 27FF | Reserved              |
|                 |       | 0x4002 2000 - 0x4002 23FF | FMC                   |
|                 |       | 0x4002 1C00 - 0x4002 1FFF | Reserved              |
|                 |       | 0x4002 1800 - 0x4002 1BFF | Reserved              |
|                 |       | 0x4002 1400 - 0x4002 17FF | Reserved              |
|                 |       | 0x4002 1000 - 0x4002 13FF | RCU                   |
|                 |       | 0x4002 0C00 - 0x4002 0FFF | Reserved              |
|                 |       | 0x4002 0800 - 0x4002 0BFF | Reserved              |
|                 |       | 0x4002 0400 - 0x4002 07FF | DMA1                  |
|                 |       | 0x4002 0000 - 0x4002 03FF | DMA0                  |
|                 |       | 0x4001 8400 - 0x4001 FFFF | Reserved              |
|                 |       | 0x4001 8000 - 0x4001 83FF | Reserved              |
|                 |       | 0x4001 7C00 - 0x4001 7FFF | Reserved              |
|                 | APB2  | 0x4001 7800 - 0x4001 7BFF | Reserved              |
|                 |       | 0x4001 7400 - 0x4001 77FF | Reserved              |





| Pre-defined |      | 321 307 XX Datastice      |                    |  |
|-------------|------|---------------------------|--------------------|--|
| Regions Bus |      | Address                   | Peripherals        |  |
| 3           |      | 0x4001 7000 - 0x4001 73FF | Reserved           |  |
|             |      | 0x4001 6C00 - 0x4001 6FFF | Reserved           |  |
|             |      | 0x4001 6800 - 0x4001 6BFF | Reserved           |  |
|             |      | 0x4001 5C00 - 0x4001 67FF | Reserved           |  |
|             |      | 0x4001 5800 - 0x4001 5BFF | Reserved           |  |
|             |      | 0x4001 5400 - 0x4001 57FF | TIMER10            |  |
|             |      | 0x4001 5000 - 0x4001 53FF | TIMER9             |  |
|             |      | 0x4001 4C00 - 0x4001 4FFF | TIMER8             |  |
|             |      | 0x4001 4800 - 0x4001 4BFF | Reserved           |  |
|             |      | 0x4001 4400 - 0x4001 47FF | Reserved           |  |
|             |      | 0x4001 4000 - 0x4001 43FF | Reserved           |  |
|             |      | 0x4001 3C00 - 0x4001 3FFF | Reserved           |  |
|             |      | 0x4001 3800 - 0x4001 3BFF | USART0             |  |
|             |      | 0x4001 3400 - 0x4001 37FF | TIMER7             |  |
|             |      | 0x4001 3000 - 0x4001 33FF | SPI0               |  |
|             |      | 0x4001 2C00 - 0x4001 2FFF | TIMER0             |  |
|             |      | 0x4001 2800 - 0x4001 2BFF | ADC1               |  |
|             |      | 0x4001 2400 - 0x4001 27FF | ADC0               |  |
|             |      | 0x4001 2000 - 0x4001 23FF | GPIOG              |  |
|             |      | 0x4001 1C00 - 0x4001 1FFF | GPIOF              |  |
|             |      | 0x4001 1800 - 0x4001 1BFF | GPIOE              |  |
|             |      | 0x4001 1400 - 0x4001 17FF | GPIOD              |  |
|             |      | 0x4001 1000 - 0x4001 13FF | GPIOC              |  |
|             |      | 0x4001 0C00 - 0x4001 0FFF | GPIOB              |  |
|             |      | 0x4001 0800 - 0x4001 0BFF | GPIOA              |  |
|             |      | 0x4001 0400 - 0x4001 07FF | EXTI               |  |
|             |      | 0x4001 0000 - 0x4001 03FF | AFIO               |  |
|             |      | 0x4000 CC00 - 0x4000 FFFF | Reserved           |  |
|             |      | 0x4000 C800 - 0x4000 CBFF | CTC                |  |
|             |      | 0x4000 C400 - 0x4000 C7FF | Reserved           |  |
|             |      | 0x4000 C000 - 0x4000 C3FF | Reserved           |  |
|             |      | 0x4000 8000 - 0x4000 BFFF | Reserved           |  |
|             |      | 0x4000 7C00 - 0x4000 7FFF | Reserved           |  |
|             | APB1 | 0x4000 7800 - 0x4000 7BFF | Reserved           |  |
|             |      | 0x4000 7400 - 0x4000 77FF | DAC                |  |
|             |      | 0x4000 7000 - 0x4000 73FF | PMU                |  |
|             |      | 0x4000 6C00 - 0x4000 6FFF | ВКР                |  |
|             |      | 0x4000 6800 - 0x4000 6BFF | CAN1               |  |
|             |      | 0x4000 6400 - 0x4000 67FF | CAN0               |  |
|             |      | 0x4000 6000 - 0x4000 63FF | CAN SRAM 512 bytes |  |





|                        | JOET GOT AX Datastice |                           |              |
|------------------------|-----------------------|---------------------------|--------------|
| Pre-defined<br>Regions | Bus                   | Address                   | Peripherals  |
|                        |                       | 0x4000 5C00 - 0x4000 5FFF | Reserved     |
|                        |                       | 0x4000 5800 - 0x4000 5BFF | I2C1         |
|                        |                       | 0x4000 5400 - 0x4000 57FF | I2C0         |
|                        |                       | 0x4000 5000 - 0x4000 53FF | UART4        |
|                        |                       | 0x4000 4C00 - 0x4000 4FFF | UART3        |
|                        |                       | 0x4000 4800 - 0x4000 4BFF | USART2       |
|                        |                       | 0x4000 4400 - 0x4000 47FF | USART1       |
|                        |                       | 0x4000 4000 - 0x4000 43FF | Reserved     |
|                        |                       | 0x4000 3C00 - 0x4000 3FFF | SPI2/I2S2    |
|                        |                       | 0x4000 3800 - 0x4000 3BFF | SPI1/I2S1    |
|                        |                       | 0x4000 3400 - 0x4000 37FF | Reserved     |
|                        |                       | 0x4000 3000 - 0x4000 33FF | FWDGT        |
|                        |                       | 0x4000 2C00 - 0x4000 2FFF | WWDGT        |
|                        |                       | 0x4000 2800 - 0x4000 2BFF | RTC          |
|                        |                       | 0x4000 2400 - 0x4000 27FF | Reserved     |
|                        |                       | 0x4000 2000 - 0x4000 23FF | TIMER13      |
|                        |                       | 0x4000 1C00 - 0x4000 1FFF | TIMER12      |
|                        |                       | 0x4000 1800 - 0x4000 1BFF | TIMER11      |
|                        |                       | 0x4000 1400 - 0x4000 17FF | TIMER6       |
|                        |                       | 0x4000 1000 - 0x4000 13FF | TIMER5       |
|                        |                       | 0x4000 0C00 - 0x4000 0FFF | TIMER4       |
|                        |                       | 0x4000 0800 - 0x4000 0BFF | TIMER3       |
|                        |                       | 0x4000 0400 - 0x4000 07FF | TIMER2       |
|                        |                       | 0x4000 0000 - 0x4000 03FF | TIMER1       |
|                        |                       | 0x2007 0000 - 0x3FFF FFFF | Reserved     |
|                        |                       | 0x2006 0000 - 0x2006 FFFF | Reserved     |
| SRAM                   | AHB                   | 0x2003 0000 - 0x2005 FFFF | Reserved     |
|                        |                       | 0x2001 8000 - 0x2002 FFFF | Reserved     |
|                        |                       | 0x2000 0000 - 0x2001 7FFF | SRAM         |
|                        |                       | 0x1FFF F810 - 0x1FFF FFFF | Reserved     |
|                        |                       | 0x1FFF F800 - 0x1FFF F80F | Option Bytes |
|                        |                       | 0x1FFF F000 - 0x1FFF F7FF |              |
|                        |                       | 0x1FFF C010 - 0x1FFF EFFF | Bootloader   |
|                        |                       | 0x1FFF C000 - 0x1FFF C00F | Doctioadel   |
| Code                   | AHB                   | 0x1FFF B000 - 0x1FFF BFFF |              |
|                        |                       | 0x1FFF 7A10 - 0x1FFF AFFF | Reserved     |
|                        |                       | 0x1FFF 7800 - 0x1FFF 7A0F | Reserved     |
|                        |                       | 0x1FFF 0000 - 0x1FFF 77FF | Reserved     |
|                        |                       | 0x1FFE C010 - 0x1FFE FFFF | Reserved     |
|                        |                       | 0x1FFE C000 - 0x1FFE C00F | Reserved     |



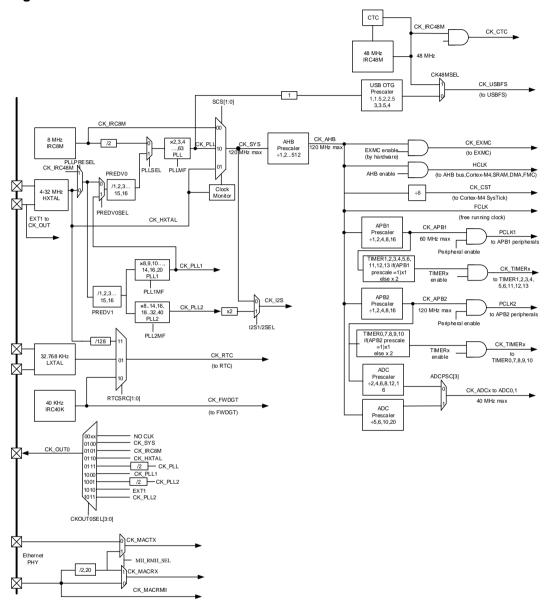
# GD32F307xx Datasheet

| Pre-defined<br>Regions | Bus | Address                   | Peripherals                             |
|------------------------|-----|---------------------------|---|
|                        |     | 0x1001 0000 - 0x1FFE BFFF | Reserved                                |
|                        |     | 0x1000 0000 - 0x1000 FFFF | Reserved                                |
|                        |     | 0x083C 0000 - 0x0FFF FFFF | Reserved                                |
|                        |     | 0x0830 0000 - 0x083B FFFF | Reserved                                |
|                        |     | 0x0810 0000 - 0x082F FFFF | Reserved                                |
|                        |     | 0x0800 0000 - 0x080F FFFF | Main Flash                              |
|                        |     | 0x0030 0000 - 0x07FF FFFF | Reserved                                |
|                        |     | 0x0010 0000 - 0x002F FFFF | Alice of to Main Flesh or Post          |
|                        |     | 0x0002 0000 - 0x000F FFFF | Aliased to Main Flash or Boot<br>loader |
|                        |     | 0x0000 0000 - 0x0001 FFFF | ioadei                                  |



### 2.5. Clock tree

Figure 2-5 GD32F307xx clock tree



#### Legend:

HXTAL: High speed crystal oscillator LXTAL: Low speed crystal oscillator IRC8M: Internal 8M RC oscillators IRC40K: Internal 40K RC oscillator IRC48M: Internal 48M RC oscillators



## 2.6. Pin definitions

## 2.6.1. GD32F307Zx LQFP144 pin definitions

Table 2-3. GD32F307Zx LQFP144 pin definitions

| Table 2-3. GD32F3072X EQFP144 pin definitions |      |                            |                             |   |  |
|---|------|----------------------------|-----------------------------|---|--|
| Pin Name                                      | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |  |
| PE2   | 1    | I/O                        | 5VT                         | Default: PE2 Alternate: TRACECK, EXMC_A23                                 |  |
| PE3   | 2    | I/O                        | 5VT                         | Default: PE3 Alternate: TRACED0, EXMC_A19                                 |  |
| PE4   | 3    | I/O                        | 5VT                         | Default: PE4 Alternate:TRACED1, EXMC_A20                                  |  |
| PE5   | 4    | I/O                        | 5VT                         | Default: PE5 Alternate:TRACED2, EXMC_A21 Remap: TIMER8_CH0 <sup>(3)</sup> |  |
| PE6   | 5    | I/O                        | 5VT                         | Default: PE6 Alternate:TRACED3, EXMC_A22 Remap: TIMER8_CH1 <sup>(3)</sup> |  |
| V <sub>BAT</sub>                              | 6    | Р                          |                             | Default: V <sub>BAT</sub>   |  |
| PC13-<br>TAMPER-<br>RTC                       | 7    | I/O                        |                             | Default: PC13<br>Alternate: TAMPER-RTC                                    |  |
| PC14-<br>OSC32IN                              | 8    | I/O                        |                             | Default: PC14<br>Alternate: OSC32IN                                       |  |
| PC15-<br>OSC32OUT                             | 9    | I/O                        |                             | Default: PC15<br>Alternate: OSC32OUT                                      |  |
| PF0   | 10   | I/O                        | 5VT                         | Default: PF0 Alternate: EXMC_A0 Remap: CTC_SYNC                           |  |
| PF1   | 11   | I/O                        | 5VT                         | Default: PF1 Alternate: EXMC_A1   |  |
| PF2   | 12   | I/O                        | 5VT                         | Default: PF2 Alternate: EXMC_A2   |  |
| PF3   | 13   | I/O                        | 5VT                         | Default: PF3 Alternate: EXMC_A3   |  |
| PF4   | 14   | I/O                        | 5VT                         | Default: PF4 Alternate: EXMC_A4   |  |
| PF5   | 15   | I/O                        | 5VT                         | Default: PF5 Alternate: EXMC_A5   |  |
| V <sub>SS_5</sub>                             | 16   | Р                          |                             | Default: V <sub>SS_5</sub>  |  |
| V <sub>DD_5</sub>                             | 17   | Р                          |                             | Default: V <sub>DD_5</sub>  |  |



| Pin Name           | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description                              |
|--------------------|------|----------------------------|-----------------------------|--|
| PF6                | 18   | 1/0                        |                             | Default: PF6 Alternate: EXMC_NIORD                 |
| 110                | 10   | 1,0                        |                             | Remap: TIMER9_CH0                                  |
|                    |      |                            |                             | Default: PF7                                       |
| PF7                | 19   | I/O                        |                             | Alternate: EXMC_NREG                               |
|                    |      |                            |                             | Remap: TIMER10_CH0 <sup>(3)</sup>                  |
|                    |      |                            |                             | Default: PF8                                       |
| PF8                | 20   | I/O                        |                             | Alternate: EXMC_NIOWR                              |
|                    |      |                            |                             | Remap: TIMER12_CH0 <sup>(3)</sup>                  |
| PF9                | 21   | I/O                        |                             | Default: PF9 Alternate: EXMC_CD                    |
| 113                | 21   | 1/0                        |                             | Remap: TIMER13_CH0 <sup>(3)</sup>                  |
|                    |      |                            |                             | Default: PF10                                      |
| PF10               | 22   | I/O                        |                             | Alternate: EXMC_INTR                               |
| OCCINI             | 22   |                            |                             | Default: OSCIN                                     |
| OSCIN              | 23   | I                          |                             | Remap: PD0   |
| OSCOUT             | 24   | 0                          |                             | Default: OSCOUT                                    |
| 030001             | 24   | U                          |                             | Remap: PD1   |
| NRST               | 25   | I/O                        |                             | Default: NRST                                      |
| PC0                | 26   | I/O                        |                             | Default: PC0                                       |
|                    |      |                            |                             | Alternate: ADC01_IN10                              |
| PC1                | 27   | I/O                        |                             | Default: PC1                                       |
|                    |      |                            |                             | Alternate: ADC01_IN11, ENET_MDC  Default: PC2      |
| PC2                | 28   | I/O                        |                             | Alternate: ADC01_IN12, ENET_MII_TXD2               |
|                    |      |                            |                             | Default: PC3                                       |
| PC3                | 29   | I/O                        |                             | Alternate: ADC01_IN13, ENET_MII_TX_CLK             |
| V <sub>SSA</sub>   | 30   | Р                          |                             | Default: V <sub>SSA</sub>                          |
| V <sub>REF</sub> - | 31   | Р                          |                             | Default: V <sub>REF-</sub>                         |
| V <sub>REF+</sub>  | 32   | Р                          |                             | Default: V <sub>REF+</sub>                         |
| V <sub>DDA</sub>   | 33   | Р                          |                             | Default: V <sub>DDA</sub>                          |
|                    |      |                            |                             | Default: PA0                                       |
| PA0-WKUP           | 34   | I/O                        |                             | Alternate: WKUP, USART1_CTS, ADC01_IN0,            |
| FA0-WROF           | 34   | 1/0                        |                             | TIMER1_CH0, TIMER1_ETI, TIMER4_CH0,                |
|                    |      |                            |                             | TIMER7_ETI, ENET_MII_CRS                           |
|                    |      |                            |                             | Default: PA1                                       |
| PA1                | 35   | I/O                        |                             | Alternate: USART1_RTS, ADC01_IN1, TIMER1_CH1,      |
|                    |      |                            |                             | TIMER4_CH1, ENET_MII_RX_CLK,                       |
|                    |      |                            |                             | ENET_RMII_REF_CLK Default: PA2                     |
| PA2                | 36   | I/O                        |                             | Alternate: USART1_TX, ADC01_IN2, TIMER1_CH2,       |
| 1,74               | 00   | ,,,                        |                             | TIMER4_CH2, TIMER8_CH0 <sup>(3)</sup> , ENET_MDIO, |



|                   |      |                            |                             | ODOZI OOTAA Datasiice   |
|-------------------|------|----------------------------|-----------------------------|---|
| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |
|                   |      |                            |                             | SPI0_IO2  |
| PA3               | 37   | I/O                        |                             | Default: PA3 Alternate: USART1_RX, ADC01_IN3, TIMER1_CH3, TIMER4_CH3, TIMER8_CH1 <sup>(3)</sup> , ENET_MII_COL, SPI0_IO3                                    |
| V <sub>SS_4</sub> | 38   | Р                          |                             | Default: V <sub>SS_4</sub>  |
| $V_{DD\_4}$       | 39   | Р                          |                             | Default: V <sub>DD 4</sub>  |
| PA4               | 40   | I/O                        |                             | Default: PA4 Alternate: SPI0_NSS, USART1_CK, ADC01_IN4, DAC_OUT0 Remap:SPI2_NSS, I2S2_WS  |
| PA5               | 41   | I/O                        |                             | Default: PA5 Alternate: SPI0_SCK, ADC01_IN5, DAC_OUT1   |
| PA6               | 42   | I/O                        |                             | Default: PA6 Alternate: SPI0_MISO, ADC01_IN6, TIMER2_CH0, TIMER7_BRKIN, TIMER12_CH0 <sup>(3)</sup> Remap: TIMER0_BRKIN                                      |
| PA7               | 43   | I/O                        |                             | Default: PA7 Alternate: SPI0_MOSI, ADC01_IN7, TIMER2_CH1, TIMER7_CH0_ON, TIMER13_CH0 <sup>(3)</sup> , ENET_MII_RX_DV, ENET_RMII_CRS_DV Remap: TIMER0_CH0_ON |
| PC4               | 44   | I/O                        |                             | Default: PC4 Alternate: ADC01_IN14, ENET_MII_RXD0, ENET_RMII_RXD0   |
| PC5               | 45   | I/O                        |                             | Default: PC5 Alternate: ADC01_IN15, ENET_MII_RXD1, ENET_RMII_RXD1   |
| PB0               | 46   | I/O                        |                             | Default: PB0 Alternate: ADC01_IN8, TIMER2_CH2, TIMER7_CH1_ON, ENET_MII_RXD2 Remap: TIMER0_CH1_ON  |
| PB1               | 47   | I/O                        |                             | Default: PB1 Alternate: ADC01_IN9, TIMER2_CH3, TIMER7_CH2_ON, ENET_MII_RXD3 Remap: TIMER0_CH2_ON  |
| PB2               | 48   | I/O                        | 5VT                         | Default: PB2, BOOT1   |
| PF11              | 49   | I/O                        | 5VT                         | Default: PF11 Alternate: EXMC_NIOS16  |
| PF12              | 50   | I/O                        | 5VT                         | Default: PF12 Alternate: EXMC_A6  |
| V <sub>SS_6</sub> | 51   | Р                          |                             | Default: Vss_6  |
|                   |      |                            |                             | _   |



| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |
|-------------------|------|----------------------------|-----------------------------|--|
| $V_{DD\_6}$       | 52   | Р                          |                             | Default: V <sub>DD_6</sub>                                   |
| PF13              | 53   | I/O                        | 5VT                         | Default: PF13<br>Alternate: EXMC_A7                          |
| PF14              | 54   | I/O                        | 5VT                         | Default: PF14<br>Alternate: EXMC_A8                          |
| PF15              | 55   | I/O                        | 5VT                         | Default: PF15<br>Alternate: EXMC_A9                          |
| PG0               | 56   | I/O                        | 5VT                         | Default: PG0<br>Alternate: EXMC_A10                          |
| PG1               | 57   | I/O                        | 5VT                         | Default: PG1 Alternate: EXMC_A11                             |
| PE7               | 58   | I/O                        | 5VT                         | Default: PE7 Alternate: EXMC_D4 Remap: TIMER0_ETI            |
| PE8               | 59   | I/O                        | 5VT                         | Default: PE8 Alternate: EXMC_D5 Remap: TIMER0_CH0_ON         |
| PE9               | 60   | I/O                        | 5VT                         | Default: PE9 Alternate: EXMC_D6 Remap: TIMER0_CH0            |
| V <sub>SS_7</sub> | 61   | Р                          |                             | Default: V <sub>SS_7</sub>                                   |
| V <sub>DD_7</sub> | 62   | Р                          |                             | Default: V <sub>DD_7</sub>                                   |
| PE10              | 63   | I/O                        | 5VT                         | Default: PE10 Alternate: EXMC_D7 Remap: TIMER0_CH1_ON        |
| PE11              | 64   | I/O                        | 5VT                         | Default: PE11 Alternate: EXMC_D8 Remap: TIMER0_CH1           |
| PE12              | 65   | I/O                        | 5VT                         | Default: PE12 Alternate: EXMC_D9 Remap: TIMER0_CH2_ON        |
| PE13              | 66   | I/O                        | 5VT                         | Default: PE13 Alternate: EXMC_D10 Remap: TIMER0_CH2          |
| PE14              | 67   | I/O                        | 5VT                         | Default: PE14 Alternate: EXMC_D11 Remap: TIMER0_CH3          |
| PE15              | 68   | I/O                        | 5VT                         | Default: PE15 Alternate: EXMC_D12 Remap: TIMER0_BRKIN        |
| PB10              | 69   | I/O                        | 5VT                         | Default: PB10 Alternate: I2C1_SCL, USART2_TX, ENET_MII_RX_ER |



| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |
|-------------------|------|----------------------------|-----------------------------|--|
|                   |      |                            |                             | Remap: TIMER1_CH2  |
| PB11              | 70   | I/O                        | 5VT                         | Default: PB11 Alternate: I2C1_SDA, USART2_RX, ENET_MII_TX_EN, ENET_RMII_TX_EN Remap: TIMER1_CH3                        |
| V <sub>SS_1</sub> | 71   | Р                          |                             | Default: V <sub>SS 1</sub>   |
| $V_{DD_1}$        | 72   | Р                          |                             | Default: V <sub>DD 1</sub>   |
| PB12              | 73   | I/O                        | 5VT                         | Default: PB12 Alternate: SPI1_NSS, I2C1_SMBA, USART2_CK, TIMER0_BRKIN, I2S1_WS, CAN1_RX, ENET_MII_TXD0, ENET_RMII_TXD0 |
| PB13              | 74   | I/O                        | 5VT                         | Default: PB13 Alternate: SPI1_SCK, USART2_CTS, TIMER0_CH0_ON, I2S1_CK, CAN1_TX, ENET_MII_TXD1, ENET_RMII_TXD1          |
| PB14              | 75   | I/O                        | 5VT                         | Default: PB14 Alternate: SPI1_MISO, USART2_RTS, TIMER0_CH1_ON, TIMER11_CH0 <sup>(3)</sup>                              |
| PB15              | 76   | I/O                        | 5VT                         | Default: PB15 Alternate: SPI1_MOSI, TIMER0_CH2_ON, I2S1_SD, TIMER11_CH1 <sup>(3)</sup>                                 |
| PD8               | 77   | I/O                        | 5VT                         | Default: PD8 Alternate: EXMC_D13 Remap: USART2_TX, ENET_MII_RX_DV, ENET_RMII_CRS_DV                                    |
| PD9               | 78   | I/O                        | 5VT                         | Default: PD9 Alternate: EXMC_D14 Remap: USART2_RX, ENET_MII_RXD0, ENET_RMII_RXD0                                       |
| PD10              | 79   | I/O                        | 5VT                         | Default: PD10 Alternate: EXMC_D15 Remap: USART2_CK, ENET_MII_RXD1, ENET_RMII_RXD1                                      |
| PD11              | 80   | I/O                        | 5VT                         | Default: PD11 Alternate: EXMC_A16 Remap: USART2_CTS, ENET_MII_RXD2   |
| PD12              | 81   | I/O                        | 5VT                         | Default: PD12 Alternate: EXMC_A17 Remap: TIMER3_CH0, USART2_RTS, ENET_MII_RXD3   |
| PD13              | 82   | I/O                        | 5VT                         | Default: PD13 Alternate: EXMC_A18 Remap: TIMER3_CH1  |



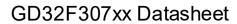
| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |
|-------------------|------|----------------------------|-----------------------------|---|
| V <sub>SS_8</sub> | 83   | Р                          |                             | Default: V <sub>SS_8</sub>  |
| V <sub>DD_8</sub> | 84   | Р                          |                             | Default: V <sub>DD_8</sub>  |
| PD14              | 85   | I/O                        | 5VT                         | Default: PD14 Alternate: EXMC_D0 Remap: TIMER3_CH2                          |
| PD15              | 86   | I/O                        | 5VT                         | Default: PD15 Alternate: EXMC_D1 Remap: TIMER3_CH3, CTC_SYNC                |
| PG2               | 87   | I/O                        | 5VT                         | Default: PG2<br>Alternate: EXMC_A12   |
| PG3               | 88   | I/O                        | 5VT                         | Default: PG3<br>Alternate: EXMC_A13   |
| PG4               | 89   | I/O                        | 5VT                         | Default: PG4<br>Alternate: EXMC_A14   |
| PG5               | 90   | I/O                        | 5VT                         | Default: PG5 Alternate: EXMC_A15  |
| PG6               | 91   | I/O                        | 5VT                         | Default: PG6 Alternate: EXMC_INT1   |
| PG7               | 92   | I/O                        | 5VT                         | Default: PG7 Alternate: EXMC_INT2   |
| PG8               | 93   | I/O                        | 5VT                         | Default: PG8  |
| V <sub>SS_9</sub> | 94   | Р                          |                             | Default: V <sub>SS_9</sub>  |
| $V_{DD_9}$        | 95   | Р                          |                             | Default: V <sub>DD_9</sub>  |
| PC6               | 96   | I/O                        | 5VT                         | Default: PC6 Alternate: I2S1_MCK, TIMER7_CH0 Remap: TIMER2_CH0              |
| PC7               | 97   | I/O                        | 5VT                         | Default: PC7 Alternate: I2S2_MCK, TIMER7_CH1 Remap: TIMER2_CH1              |
| PC8               | 98   | I/O                        | 5VT                         | Default: PC8 Alternate: TIMER7_CH2 Remap: TIMER2_CH2                        |
| PC9               | 99   | I/O                        | 5VT                         | Default: PC9 Alternate: TIMER7_CH3 Remap: TIMER2_CH3                        |
| PA8               | 100  | I/O                        | 5VT                         | Default: PA8 Alternate: USART0_CK, TIMER0_CH0, CK_OUT0, USBFS_SOF, CTC_SYNC |
| PA9               | 101  | I/O                        | 5VT                         | Default: PA9 Alternate: USART0_TX, TIMER0_CH1, USBFS_VBUS                   |
| PA10              | 102  | I/O                        | 5VT                         | Default: PA10   |



| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |
|-------------------|------|----------------------------|-----------------------------|--|
|                   |      |                            |                             | Alternate: USART0_RX, TIMER0_CH2, USBFS_ID   |
| PA11              | 103  | I/O                        | 5VT                         | Default: PA11 Alternate: USART0_CTS, CAN0_RX, USBFS_DM, TIMER0_CH3                       |
| PA12              | 104  | I/O                        | 5VT                         | Default: PA12 Alternate: USART0_RTS, USBFS_DP, CAN0_TX, TIMER0_ETI                       |
| PA13              | 105  | I/O                        | 5VT                         | Default: JTMS, SWDIO<br>Remap: PA13  |
| NC                | 106  | -                          | -                           | -  |
| V <sub>SS_2</sub> | 107  | Р                          |                             | Default: V <sub>SS 2</sub>   |
| V <sub>DD_2</sub> | 108  | Р                          |                             | Default: V <sub>DD_2</sub>   |
| PA14              | 109  | I/O                        | 5VT                         | Default: JTCK, SWCLK<br>Remap: PA14  |
| PA15              | 110  | I/O                        | 5VT                         | Default: JTDI Alternate: SPI2_NSS, I2S2_WS Remap: TIMER1_CH0, TIMER1_ETI, PA15, SPI0_NSS |
| PC10              | 111  | I/O                        | 5VT                         | Default: PC10 Alternate: UART3_TX Remap: USART2_TX, SPI2_SCK, I2S2_CK                    |
| PC11              | 112  | I/O                        | 5VT                         | Default: PC11 Alternate: UART3_RX Remap: USART2_RX, SPI2_MISO                            |
| PC12              | 113  | I/O                        | 5VT                         | Default: PC12<br>Alternate: UART4_TX<br>Remap: USART2_CK, SPI2_MOSI, I2S2_SD             |
| PD0               | 114  | I/O                        | 5VT                         | Default: PD0 Alternate: EXMC_D2 Remap: CAN0_RX, OSCIN                                    |
| PD1               | 115  | I/O                        | 5VT                         | Default: PD1 Alternate: EXMC_D3 Remap: CAN0_TX, OSCOUT                                   |
| PD2               | 116  | I/O                        | 5VT                         | Default: PD2<br>Alternate: TIMER2_ETI, UART4_RX  |
| PD3               | 117  | I/O                        | 5VT                         | Default: PD3 Alternate: EXMC_CLK Remap: USART1_CTS                                       |
| PD4               | 118  | I/O                        | 5VT                         | Default: PD4 Alternate: EXMC_NOE Remap: USART1_RTS                                       |
| PD5               | 119  | I/O                        | 5VT                         | Default: PD5<br>Alternate: EXMC_NWE  |



|                    |      |                            |                             | ODOZI OOI AA Datasiice                      |
|--------------------|------|----------------------------|-----------------------------|---|
| Pin Name           | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description                       |
|                    |      |                            |                             | Remap: USART1_TX                            |
| V <sub>SS_10</sub> | 120  | Р                          |                             | Default: V <sub>SS_10</sub>                 |
| V <sub>DD_10</sub> | 121  | Р                          |                             | Default: V <sub>DD 10</sub>                 |
|                    |      |                            |                             | Default: PD6                                |
| PD6                | 122  | I/O                        | 5VT                         | Alternate: EXMC_NWAIT                       |
|                    |      |                            |                             | Remap: USART1_RX                            |
|                    |      |                            |                             | Default: PD7                                |
| PD7                | 123  | I/O                        | 5VT                         | Alternate: EXMC_NE0, EXMC_NCE1              |
|                    |      |                            |                             | Remap: USART1_CK                            |
|                    |      |                            |                             | Default: PG9                                |
| PG9                | 124  | I/O                        | 5VT                         | Alternate: EXMC_NE1, EXMC_NCE2              |
|                    |      |                            |                             | Default: PG10                               |
| PG10               | 125  | I/O                        | 5VT                         | Alternate: EXMC_NCE3_0, EXMC_NE2            |
| _                  |      |                            |                             | Default: PG11                               |
| PG11               | 126  | I/O                        | 5VT                         | Alternate: EXMC_NCE3_1                      |
|                    |      |                            |                             | Default: PG12                               |
| PG12               | 127  | I/O                        | 5VT                         | Alternate: EXMC NE3                         |
|                    |      |                            |                             | Default: PG13                               |
| PG13               | 128  | I/O                        | 5VT                         | Alternate: EXMC_A24                         |
| _                  |      |                            |                             | Default: PG14                               |
| PG14               | 129  | I/O                        | 5VT                         | Alternate: EXMC_A25                         |
| V <sub>SS_11</sub> | 130  | Р                          |                             | Default: V <sub>SS_11</sub>                 |
| V <sub>DD_11</sub> | 131  | Р                          |                             | Default: V <sub>DD_11</sub>                 |
| PG15               | 132  | I/O                        | 5VT                         | Default: PG15                               |
| 1010               | 102  | 1/0                        | 011                         | Default: JTDO                               |
|                    |      |                            |                             | Alternate:SPI2 SCK, I2S2 CK                 |
| PB3                | 133  | I/O                        | 5VT                         | Remap: PB3, TRACESWO, TIMER1_CH1,           |
|                    |      |                            |                             | SPIO_SCK                                    |
|                    |      |                            |                             | Default: NJTRST                             |
| PB4                | 134  | I/O                        | 5VT                         | Alternate: SPI2_MISO                        |
|                    |      |                            |                             | Remap: TIMER2_CH0, PB4, SPI0_MISO           |
|                    |      |                            |                             | Default: PB5                                |
|                    |      |                            |                             | Alternate: I2C0_SMBA, SPI2_MOSI, I2S2_SD,   |
| PB5                | 135  | I/O                        |                             | ENET_MII_PPS_OUT, ENET_RMII_PPS_OUT         |
|                    |      |                            |                             | Remap: TIMER2_CH1, SPI0_MOSI, CAN1_RX       |
|                    |      |                            |                             | Default: PB6                                |
| PB6                | 136  | I/O                        | 5VT                         | Alternate: I2C0_SCL, TIMER3_CH0             |
|                    |      |                            |                             | Remap: USART0_TX, CAN1_TX, SPI0_IO2         |
|                    |      |                            |                             | Default: PB7                                |
| PB7                | 137  | I/O                        | 5VT                         | Alternate: I2C0_SDA , TIMER3_CH1, EXMC_NADV |
|                    |      |                            |                             | Remap: USART0_RX, SPI0_IO3                  |
| воото              | 138  | ı                          |                             | Default: BOOT0                              |
| -                  |      |                            | -                           | •   |





| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description                              |
|-------------------|------|----------------------------|-----------------------------|--|
|                   |      |                            |                             | Default: PB8                                       |
| PB8               | 139  | I/O                        | 5VT                         | Alternate: TIMER3_CH2, TIMER9_CH0 <sup>(3)</sup> , |
|                   |      |                            |                             | ENET_MII_TXD3                                      |
|                   |      |                            |                             | Remap: I2C0_SCL, CAN0_RX  Default: PB9             |
| PB9               | 140  | I/O                        | 5VT                         | Alternate: TIMER3_CH3, TIMER10_CH0 <sup>(3)</sup>  |
| 1 55              | 140  | 1/0                        | 3 7 1                       | Remap: I2C0_SDA, CAN0_TX                           |
|                   |      |                            |                             | Default: PE0                                       |
| PE0               | 141  | I/O                        | 5VT                         | Alternate: TIMER3_ETI, EXMC_NBL0                   |
| DE4               | 140  | 1/0                        | 5VT                         | Default: PE1                                       |
| PE1               | 142  | I/O                        | 571                         | Alternate: EXMC_NBL1                               |
| V <sub>SS_3</sub> | 143  | Р                          |                             | Default: V <sub>SS_3</sub>                         |
| V <sub>DD_3</sub> | 144  | Р                          |                             | Default: V <sub>DD_3</sub>                         |

#### Notes:

(1) Type: I = input, O = output, P = power.

(2)I/O Level: 5VT = 5 V tolerant.

(3)Functions are available in GD32F307ZG devices.



## 2.6.2. GD32F307Vx LQFP100 pin definitions

Table 2-4. GD32F307Vx LQFP100 pin definitions

| Table 2-4. GD321 307 VX LQ1 |      |                            | 1 100 pin dennitions        |   |  |
|-----------------------------|------|----------------------------|-----------------------------|---|--|
| Pin Name                    | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |  |
| PE2                         | 1    | I/O                        | 5VT                         | Default: PE2<br>Alternate: TRACECK, EXMC_A23                              |  |
| PE3                         | 2    | I/O                        | 5VT                         | Default: PE3 Alternate: TRACED0, EXMC_A19                                 |  |
| PE4                         | 3    | I/O                        | 5VT                         | Default: PE4 Alternate:TRACED1, EXMC_A20                                  |  |
| PE5                         | 4    | 1/0                        | 5VT                         | Default: PE5 Alternate:TRACED2, EXMC_A21 Remap: TIMER8_CH0 <sup>(3)</sup> |  |
| PE6                         | 5    | I/O                        | 5VT                         | Default: PE6 Alternate:TRACED3, EXMC_A22 Remap: TIMER8_CH1 <sup>(3)</sup> |  |
| V <sub>BAT</sub>            | 6    | Р                          |                             | Default: V <sub>BAT</sub>   |  |
| PC13-<br>TAMPER-<br>RTC     | 7    | I/O                        |                             | Default: PC13<br>Alternate: TAMPER-RTC                                    |  |
| PC14-<br>OSC32IN            | 8    | I/O                        |                             | Default: PC14<br>Alternate: OSC32IN                                       |  |
| PC15-<br>OSC32OUT           | 9    | I/O                        |                             | Default: PC15 Alternate: OSC32OUT   |  |
| V <sub>SS_5</sub>           | 10   | Р                          |                             | Default: V <sub>SS_5</sub>  |  |
| $V_{DD_5}$                  | 11   | Р                          |                             | Default: V <sub>DD_5</sub>  |  |
| OSCIN                       | 12   | I                          |                             | Default: OSCIN<br>Remap: PD0  |  |
| OSCOUT                      | 13   | 0                          |                             | Default: OSCOUT<br>Remap: PD1   |  |
| NRST                        | 14   | I/O                        |                             | Default: NRST   |  |
| PC0                         | 15   | I/O                        |                             | Default: PC0 Alternate: ADC01_IN10  |  |
| PC1                         | 16   | I/O                        |                             | Default: PC1 Alternate: ADC01_IN11, ENET_MDC                              |  |
| PC2                         | 17   | I/O                        |                             | Default: PC2 Alternate: ADC01_IN12, ENET_MII_TXD2                         |  |
| PC3                         | 18   | I/O                        |                             | Default: PC3 Alternate: ADC01_IN13, ENET_MII_TX_CLK                       |  |
| V <sub>SSA</sub>            | 19   | Р                          |                             | Default: V <sub>SSA</sub>   |  |
| V <sub>REF</sub> -          | 20   | Р                          |                             | Default: V <sub>REF</sub> -   |  |
| V <sub>REF+</sub>           | 21   | Р                          |                             | Default: V <sub>REF+</sub>  |  |



|                  |      |                            |                             | ODOZI OOI XX Datastice  |
|------------------|------|----------------------------|-----------------------------|---|
| Pin Name         | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |
| V <sub>DDA</sub> | 22   | Р                          |                             | Default: V <sub>DDA</sub>   |
| PA0-WKUP         | 23   | I/O                        |                             | Default: PA0 Alternate: WKUP, USART1_CTS, ADC01_IN0, TIMER1_CH0, TIMER1_ETI, TIMER4_CH0, TIMER7_ETI <sup>(4)</sup> , ENET_MII_CRS   |
| PA1              | 24   | I/O                        |                             | Default: PA1 Alternate: USART1_RTS, ADC01_IN1, TIMER1_CH1, TIMER4_CH1, ENET_MII_RX_CLK, ENET_RMII_REF_CLK   |
| PA2              | 25   | I/O                        |                             | Default: PA2 Alternate: USART1_TX, ADC01_IN2, TIMER1_CH2, TIMER4_CH2, TIMER8_CH0 <sup>(3)</sup> , ENET_MDIO,SPI0_IO2  |
| PA3              | 26   | I/O                        |                             | Default: PA3 Alternate: USART1_RX, ADC01_IN3, TIMER1_CH3, TIMER4_CH3, TIMER8_CH1 <sup>(3)</sup> , ENET_MII_COL, SPI0_IO3  |
| $V_{SS\_4}$      | 27   | Р                          |                             | Default: V <sub>SS_4</sub>  |
| $V_{DD\_4}$      | 28   | Р                          |                             | Default: V <sub>DD_4</sub>  |
| PA4              | 29   | I/O                        |                             | Default: PA4 Alternate: SPI0_NSS, USART1_CK, ADC01_IN4, DAC_OUT0 Remap:SPI2_NSS, I2S2_WS  |
| PA5              | 30   | I/O                        |                             | Default: PA5 Alternate: SPI0_SCK, ADC01_IN5, DAC_OUT1   |
| PA6              | 31   | I/O                        |                             | Default: PA6 Alternate: SPI0_MISO, ADC01_IN6, TIMER2_CH0, TIMER7_BRKIN <sup>(4)</sup> , TIMER12_CH0 <sup>(3)</sup> Remap: TIMER0_BRKIN                                      |
| PA7              | 32   | I/O                        |                             | Default: PA7 Alternate: SPI0_MOSI, ADC01_IN7, TIMER2_CH1, TIMER7_CH0_ON <sup>(4)</sup> , TIMER13_CH0 <sup>(3)</sup> , ENET_MII_RX_DV, ENET_RMII_CRS_DV Remap: TIMER0_CH0_ON |
| PC4              | 33   | I/O                        |                             | Default: PC4 Alternate: ADC01_IN14, ENET_MII_RXD0, ENET_RMII_RXD0   |
| PC5              | 34   | I/O                        |                             | Default: PC5 Alternate: ADC01_IN15, ENET_MII_RXD1, ENET_RMII_RXD1   |
| PB0              | 35   | I/O                        |                             | Default: PB0 Alternate: ADC01_IN8, TIMER2_CH2, TIMER7_CH1_ON <sup>(4)</sup> , ENET_MII_RXD2   |



|                   |      |                            |                             | ODOZI OOI AA Datasiice                       |
|-------------------|------|----------------------------|-----------------------------|--|
| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description                        |
|                   |      |                            |                             | Remap: TIMER0_CH1_ON                         |
|                   |      |                            |                             | Default: PB1                                 |
|                   |      |                            |                             | Alternate: ADC01_IN9, TIMER2_CH3,            |
| PB1               | 36   | I/O                        |                             | TIMER7_CH2_ON <sup>(4)</sup> , ENET_MII_RXD3 |
|                   |      |                            |                             | Remap: TIMER0_CH2_ON                         |
| PB2               | 37   | I/O                        | 5VT                         | Default: PB2, BOOT1                          |
|                   |      |                            |                             | Default: PE7                                 |
| PE7               | 38   | I/O                        | 5VT                         | Alternate: EXMC_D4                           |
|                   |      |                            |                             | Remap: TIMER0_ETI                            |
|                   |      |                            |                             | Default: PE8                                 |
| PE8               | 39   | I/O                        | 5VT                         | Alternate: EXMC_D5                           |
|                   |      |                            |                             | Remap: TIMER0_CH0_ON                         |
|                   |      |                            |                             | Default: PE9                                 |
| PE9               | 40   | I/O                        | 5VT                         | Alternate: EXMC_D6                           |
|                   |      |                            |                             | Remap: TIMER0_CH0                            |
|                   |      |                            |                             | Default: PE10                                |
| PE10              | 41   | I/O                        | 5VT                         | Alternate: EXMC_D7                           |
|                   |      |                            |                             | Remap: TIMER0_CH1_ON                         |
|                   |      |                            |                             | Default: PE11                                |
| PE11              | 42   | I/O                        | 5VT                         | Alternate: EXMC_D8                           |
|                   |      |                            |                             | Remap: TIMER0_CH1                            |
|                   |      |                            |                             | Default: PE12                                |
| PE12              | 43   | I/O                        | 5VT                         | Alternate: EXMC_D9                           |
|                   |      |                            |                             | Remap: TIMER0_CH2_ON                         |
|                   |      |                            |                             | Default: PE13                                |
| PE13              | 44   | I/O                        | 5VT                         | Alternate: EXMC_D10                          |
|                   |      |                            |                             | Remap: TIMER0_CH2                            |
|                   |      |                            |                             | Default: PE14                                |
| PE14              | 45   | I/O                        | 5VT                         | Alternate: EXMC_D11                          |
|                   |      |                            |                             | Remap: TIMER0_CH3                            |
|                   |      |                            |                             | Default: PE15                                |
| PE15              | 46   | I/O                        | 5VT                         | Alternate: EXMC_D12                          |
|                   |      |                            |                             | Remap: TIMER0_BRKIN                          |
|                   |      |                            |                             | Default: PB10                                |
| PB10              | 47   | I/O                        | 5VT                         | Alternate: I2C1_SCL, USART2_TX,              |
|                   |      |                            |                             | ENET_MII_RX_ER                               |
|                   |      |                            |                             | Remap: TIMER1_CH2                            |
|                   |      |                            |                             | Default: PB11                                |
| PB11              | 48   | I/O                        | 5VT                         | Alternate: I2C1_SDA, USART2_RX,              |
|                   |      |                            |                             | ENET_MII_TX_EN, ENET_RMII_TX_EN              |
|                   | 40   | _                          |                             | Remap: TIMER1_CH3                            |
| V <sub>SS_1</sub> | 49   | Р                          |                             | Default: V <sub>SS_1</sub>                   |
| $V_{DD_1}$        | 50   | Р                          |                             | Default: V <sub>DD_1</sub>                   |



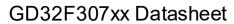
| Pin Name | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |
|----------|------|----------------------------|-----------------------------|--|
| PB12     | 51   | I/O                        | 5VT                         | Default: PB12 Alternate: SPI1_NSS, I2C1_SMBA, USART2_CK, TIMER0_BRKIN, I2S1_WS, CAN1_RX, ENET_MII_TXD0, ENET_RMII_TXD0 |
| PB13     | 52   | I/O                        | 5VT                         | Default: PB13 Alternate: SPI1_SCK, USART2_CTS, TIMER0_CH0_ON, I2S1_CK, CAN1_TX, ENET_MII_TXD1, ENET_RMII_TXD1          |
| PB14     | 53   | I/O                        | 5VT                         | Default: PB14 Alternate: SPI1_MISO, USART2_RTS, TIMER0_CH1_ON, TIMER11_CH0 <sup>(3)</sup>                              |
| PB15     | 54   | I/O                        | 5VT                         | Default: PB15 Alternate: SPI1_MOSI, TIMER0_CH2_ON, I2S1_SD, TIMER11_CH1 <sup>(3)</sup>                                 |
| PD8      | 55   | I/O                        | 5VT                         | Default: PD8 Alternate: EXMC_D13 Remap: USART2_TX, ENET_MII_RX_DV, ENET_RMII_CRS_DV                                    |
| PD9      | 56   | I/O                        | 5VT                         | Default: PD9 Alternate: EXMC_D14 Remap: USART2_RX, ENET_MII_RXD0, ENET_RMII_RXD0                                       |
| PD10     | 57   | I/O                        | 5VT                         | Default: PD10 Alternate: EXMC_D15 Remap: USART2_CK, ENET_MII_RXD1, ENET_RMII_RXD1                                      |
| PD11     | 58   | I/O                        | 5VT                         | Default: PD11 Alternate: EXMC_A16 Remap: USART2_CTS, ENET_MII_RXD2   |
| PD12     | 59   | I/O                        | 5VT                         | Default: PD12 Alternate: EXMC_A17 Remap: TIMER3_CH0, USART2_RTS, ENET_MII_RXD3   |
| PD13     | 60   | I/O                        | 5VT                         | Default: PD13 Alternate: EXMC_A18 Remap: TIMER3_CH1  |
| PD14     | 61   | I/O                        | 5VT                         | Default: PD14 Alternate: EXMC_D0 Remap: TIMER3_CH2   |
| PD15     | 62   | I/O                        | 5VT                         | Default: PD15 Alternate: EXMC_D1 Remap: TIMER3_CH3, CTC_SYNC   |
| PC6      | 63   | I/O                        | 5VT                         | Default: PC6   |



|                   |      |                            |                             | GD021 007 AX Datastice   |
|-------------------|------|----------------------------|-----------------------------|--|
| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |
|                   |      |                            |                             | Alternate: I2S1_MCK, TIMER7_CH0 <sup>(4)</sup>   |
|                   |      |                            |                             | Remap: TIMER2_CH0  |
| PC7               | 64   | I/O                        | 5VT                         | Default: PC7 Alternate: I2S2_MCK, TIMER7_CH1 <sup>(4)</sup> Remap: TIMER2_CH1            |
| PC8               | 65   | I/O                        | 5VT                         | Default: PC8 Alternate: TIMER7_CH2 <sup>(4)</sup> Remap: TIMER2_CH2                      |
| PC9               | 66   | I/O                        | 5VT                         | Default: PC9 Alternate: TIMER7_CH3 <sup>(4)</sup> Remap: TIMER2_CH3                      |
| PA8               | 67   | I/O                        | 5VT                         | Default: PA8 Alternate: USART0_CK, TIMER0_CH0, CK_OUT0, USBFS_SOF, CTC_SYNC              |
| PA9               | 68   | I/O                        | 5VT                         | Default: PA9 Alternate: USART0_TX, TIMER0_CH1, USBFS_VBUS                                |
| PA10              | 69   | I/O                        | 5VT                         | Default: PA10 Alternate: USART0_RX, TIMER0_CH2, USBFS_ID                                 |
| PA11              | 70   | I/O                        | 5VT                         | Default: PA11 Alternate: USART0_CTS, CAN0_RX, USBFS_DM, TIMER0_CH3                       |
| PA12              | 71   | I/O                        | 5VT                         | Default: PA12 Alternate: USART0_RTS, USBFS_DP, CAN0_TX, TIMER0_ETI                       |
| PA13              | 72   | I/O                        | 5VT                         | Default: JTMS, SWDIO<br>Remap: PA13  |
| NC                | 73   | -                          | -                           | -  |
| V <sub>SS_2</sub> | 74   | Р                          |                             | Default: V <sub>SS_2</sub>   |
| $V_{DD_2}$        | 75   | Р                          |                             | Default: V <sub>DD_2</sub>   |
| PA14              | 76   | I/O                        | 5VT                         | Default: JTCK, SWCLK<br>Remap: PA14  |
| PA15              | 77   | I/O                        | 5VT                         | Default: JTDI Alternate: SPI2_NSS, I2S2_WS Remap: TIMER1_CH0, TIMER1_ETI, PA15, SPI0_NSS |
| PC10              | 78   | I/O                        | 5VT                         | Default: PC10 Alternate: UART3_TX Remap: USART2_TX, SPI2_SCK, I2S2_CK                    |
| PC11              | 79   | I/O                        | 5VT                         | Default: PC11 Alternate: UART3_RX Remap: USART2_RX, SPI2_MISO                            |
| PC12              | 80   | I/O                        | 5VT                         | Default: PC12  |



| Pin Name | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description                       |
|----------|------|----------------------------|-----------------------------|---|
|          |      |                            |                             | Alternate: UART4_TX                         |
|          |      |                            |                             | Remap: USART2_CK, SPI2_MOSI, I2S2_SD        |
|          |      | I/O                        | 5VT                         | Default: PD0                                |
| PD0      | 81   |                            |                             | Alternate: EXMC_D2                          |
|          |      |                            |                             | Remap: CAN0_RX, OSCIN                       |
|          |      | I/O                        | 5VT                         | Default: PD1                                |
| PD1      | 82   |                            |                             | Alternate: EXMC_D3                          |
|          |      |                            |                             | Remap: CANO_TX, OSCOUT                      |
| PD2      | 83   | I/O                        | 5VT                         | Default: PD2                                |
|          |      |                            |                             | Alternate: TIMER2_ETI, UART4_RX             |
| DDO      | 0.4  | 1/0                        | 5VT                         | Default: PD3                                |
| PD3      | 84   | I/O                        |                             | Alternate: EXMC_CLK                         |
|          |      |                            |                             | Remap: USART1_CTS                           |
| DD 4     | 0.5  | I/O                        | 5VT                         | Default: PD4                                |
| PD4      | 85   |                            |                             | Alternate: EXMC_NOE                         |
|          |      |                            |                             | Remap: USART1_RTS                           |
| 55.5     |      | I/O                        | 5VT                         | Default: PD5                                |
| PD5      | 86   |                            |                             | Alternate: EXMC_NWE                         |
|          |      |                            |                             | Remap: USART1_TX                            |
|          | 87   | I/O                        | 5VT                         | Default: PD6                                |
| PD6      |      |                            |                             | Alternate: EXMC_NWAIT                       |
|          |      |                            |                             | Remap: USART1_RX                            |
|          | 88   | I/O                        | 5VT                         | Default: PD7                                |
| PD7      |      |                            |                             | Alternate: EXMC_NE0, EXMC_NCE1              |
|          |      |                            |                             | Remap: USART1_CK                            |
|          | 89   | I/O                        | 5VT                         | Default: JTDO                               |
| PB3      |      |                            |                             | Alternate:SPI2_SCK, I2S2_CK                 |
|          |      |                            |                             | Remap: PB3, TRACESWO, TIMER1_CH1,           |
| -        |      |                            |                             | SPIO_SCK                                    |
| DD 4     | 90   | I/O                        | 5VT                         | Default: NJTRST                             |
| PB4      |      |                            |                             | Alternate: SPI2_MISO                        |
| -        |      | I/O                        |                             | Remap: TIMER2_CH0, PB4, SPI0_MISO           |
|          |      |                            |                             | Default: PB5                                |
| PB5      | 91   |                            |                             | Alternate: I2C0_SMBA, SPI2_MOSI, I2S2_SD,   |
|          |      |                            |                             | ENET_MII_PPS_OUT, ENET_RMII_PPS_OUT         |
|          |      |                            |                             | Remap: TIMER2_CH1, SPI0_MOSI, CAN1_RX       |
| PB6      | 92   | I/O                        | 5VT                         | Default: PB6                                |
|          |      |                            |                             | Alternate: I2C0_SCL, TIMER3_CH0             |
|          |      |                            |                             | Remap: USARTO_TX, CAN1_TX, SPI0_IO2         |
| DD7      | 93   | I/O                        | 5VT                         | Default: PB7                                |
| PB7      |      |                            |                             | Alternate: I2C0_SDA , TIMER3_CH1, EXMC_NADV |
|          |      |                            |                             | Remap: USARTO_RX, SPIO_IO3                  |
| BOOT0    | 94   | l                          |                             | Default: BOOT0                              |





| Pin Name          | Pins       | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup>      | Functions description   |
|-------------------|------------|----------------------------|----------------------------------|---|
|                   |            |                            |                                  | Default: PB8 Alternate: TIMER3_CH2, TIMER9_CH0 <sup>(3)</sup> , |
| PB8               | 95         | I/O                        | 5VT                              | ENET_MII_TXD3   |
|                   |            |                            | Remap: I2C0_SCL, CAN0_RX         |   |
|                   |            |                            |                                  | Default: PB9  |
| PB9               | 96         | I/O                        | 5VT                              | Alternate: TIMER3_CH3, TIMER10_CH0 <sup>(3)</sup>               |
|                   |            |                            |                                  | Remap: I2C0_SDA, CAN0_TX  |
| PE0               | PE0 97 I/O | 5VT                        | Default: PE0                     |   |
| 1 20              |            |                            | Alternate: TIMER3_ETI, EXMC_NBL0 |   |
| PE1               | 98         | I/O                        | 5VT                              | Default: PE1  |
|                   |            |                            |                                  | Alternate: EXMC_NBL1  |
| V <sub>SS_3</sub> | 99         | Р                          |                                  | Default: V <sub>SS_3</sub>                                      |
| V <sub>DD_3</sub> | 100        | Р                          |                                  | Default: V <sub>DD_3</sub>                                      |

#### Notes:

(1) Type: I = input, O = output, P = power.

(2)I/O Level: 5VT = 5 V tolerant.

(3) Functions are available in GD32F307VG devices.

(4)Functions are available in GD32F307VE/G devices.



## 2.6.3. GD32F307Rx LQFP64 pin definitions

Table 2-5. GD32F307Rx LQFP64 pin definitions

| Pin Name                | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |
|-------------------------|------|----------------------------|-----------------------------|---|
| $V_{BAT}$               | 1    | Р                          |                             | Default: V <sub>BAT</sub>   |
| PC13-<br>TAMPER-<br>RTC | 2    | I/O                        |                             | Default: PC13<br>Alternate: TAMPER-RTC  |
| PC14-<br>OSC32IN        | 3    | I/O                        |                             | Default: PC14<br>Alternate: OSC32IN   |
| PC15-<br>OSC32OUT       | 4    | I/O                        |                             | Default: PC15<br>Alternate: OSC32OUT  |
| OSCIN                   | 5    | I                          |                             | Default: OSCIN<br>Remap: PD0 <sup>(5)</sup>   |
| OSCOUT                  | 6    | 0                          |                             | Default: OSCOUT<br>Remap: PD1 <sup>(5)</sup>  |
| NRST                    | 7    | I/O                        |                             | Default: NRST   |
| PC0                     | 8    | I/O                        |                             | Default: PC0<br>Alternate: ADC01_IN10   |
| PC1                     | 9    | I/O                        |                             | Default: PC1 Alternate: ADC01_IN11, ENET_MDC  |
| PC2                     | 10   | I/O                        |                             | Default: PC2 Alternate: ADC01_IN12, ENET_MII_TXD2   |
| PC3                     | 11   | I/O                        |                             | Default: PC3 Alternate: ADC01_IN13, ENET_MII_TX_CLK   |
| Vssa                    | 12   | Р                          |                             | Default: V <sub>SSA</sub>   |
| $V_{DDA}$               | 13   | Р                          |                             | Default: V <sub>DDA</sub>   |
| PA0-WKUP                | 14   | I/O                        |                             | Default: PA0 Alternate: WKUP, USART1_CTS, ADC01_IN0, TIMER1_CH0, TIMER1_ETI, TIMER4_CH0, TIMER7_ETI <sup>(4)</sup> , ENET_MII_CRS |
| PA1                     | 15   | I/O                        |                             | Default: PA1 Alternate: USART1_RTS, ADC01_IN1, TIMER1_CH1, TIMER4_CH1, ENET_MII_RX_CLK, ENET_RMII_REF_CLK                         |
| PA2                     | 16   | I/O                        |                             | Default: PA2 Alternate: USART1_TX, ADC01_IN2, TIMER1_CH2, TIMER4_CH2, TIMER8_CH0 <sup>(3)</sup> , ENET_MDIO,SPI0_IO2              |
| PA3                     | 17   | I/O                        |                             | Default: PA3 Alternate: USART1_RX, ADC01_IN3, TIMER1_CH3, TIMER4_CH3, TIMER8_CH1 <sup>(3)</sup> , ENET_MII_COL,                   |



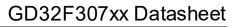
|                   |      |                            |                             | ODOZI OOI AA DAIASIICC  |
|-------------------|------|----------------------------|-----------------------------|---|
| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description   |
|                   |      |                            |                             | SPI0_IO3  |
| V <sub>SS_4</sub> | 18   | Р                          |                             | Default: V <sub>SS_4</sub>  |
| $V_{DD\_4}$       | 19   | Р                          |                             | Default: V <sub>DD 4</sub>  |
| PA4               | 20   | I/O                        |                             | Default: PA4 Alternate: SPI0_NSS, USART1_CK, ADC01_IN4, DAC_OUT0 Remap:SPI2_NSS, I2S2_WS  |
| PA5               | 21   | I/O                        |                             | Default: PA5 Alternate: SPI0_SCK, ADC01_IN5, DAC_OUT1   |
| PA6               | 22   | I/O                        |                             | Default: PA6 Alternate: SPI0_MISO, ADC01_IN6, TIMER2_CH0, TIMER7_BRKIN <sup>(4)</sup> , TIMER12_CH0 <sup>(3)</sup> Remap: TIMER0_BRKIN                                      |
| PA7               | 23   | I/O                        |                             | Default: PA7 Alternate: SPI0_MOSI, ADC01_IN7, TIMER2_CH1, TIMER7_CH0_ON <sup>(4)</sup> , TIMER13_CH0 <sup>(3)</sup> , ENET_MII_RX_DV, ENET_RMII_CRS_DV Remap: TIMER0_CH0_ON |
| PC4               | 24   | I/O                        |                             | Default: PC4 Alternate: ADC01_IN14, ENET_MII_RXD0, ENET_RMII_RXD0   |
| PC5               | 25   | I/O                        |                             | Default: PC5 Alternate: ADC01_IN15, ENET_MII_RXD1, ENET_RMII_RXD1   |
| PB0               | 26   | I/O                        |                             | Default: PB0 Alternate: ADC01_IN8, TIMER2_CH2, TIMER7_CH1_ON <sup>(4)</sup> , ENET_MII_RXD2 Remap: TIMER0_CH1_ON  |
| PB1               | 27   | I/O                        |                             | Default: PB1 Alternate: ADC01_IN9, TIMER2_CH3, TIMER7_CH2_ON <sup>(4)</sup> , ENET_MII_RXD3 Remap: TIMER0_CH2_ON  |
| PB2               | 28   | I/O                        | 5VT                         | Default: PB2, BOOT1   |
| PB10              | 29   | I/O                        | 5VT                         | Default: PB10 Alternate: I2C1_SCL, USART2_TX, ENET_MII_RX_ER Remap: TIMER1_CH2  |
| PB11              | 30   | I/O                        | 5VT                         | Default: PB11 Alternate: I2C1_SDA, USART2_RX, ENET_MII_TX_EN, ENET_RMII_TX_EN Remap: TIMER1_CH3   |
| V <sub>SS_1</sub> | 31   | Р                          |                             | Default: V <sub>SS_1</sub>  |
| V <sub>DD_1</sub> | 32   | Р                          |                             | Default: V <sub>DD_1</sub>  |



|                   |      |                            |                             | 02021 001781 2 attachico   |  |  |  |
|-------------------|------|----------------------------|-----------------------------|--|--|--|--|
| Pin Name          | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |  |  |  |
| PB12              | 33   | I/O                        | 5VT                         | Default: PB12 Alternate: SPI1_NSS, I2C1_SMBA, USART2_CK, TIMER0_BRKIN, I2S1_WS, CAN1_RX, ENET_MII_TXD0, ENET_RMII_TXD0 |  |  |  |
| PB13              | 34   | I/O                        | 5VT                         | Default: PB13 Alternate: SPI1_SCK, USART2_CTS, TIMER0_CH0_ON, I2S1_CK, CAN1_TX, ENET_MII_TXD1, ENET_RMII_TXD1          |  |  |  |
| PB14              | 35   | I/O                        | 5VT                         | Default: PB14 Alternate: SPI1_MISO, USART2_RTS, TIMER0_CH1_ON, TIMER11_CH0 <sup>(3)</sup>                              |  |  |  |
| PB15              | 36   | I/O                        | 5VT                         | Default: PB15 Alternate: SPI1_MOSI, TIMER0_CH2_ON, I2S1_SD, TIMER11_CH1 <sup>(3)</sup>                                 |  |  |  |
| PC6               | 37   | I/O                        | 5VT                         | Default: PC6 Alternate: I2S1_MCK, TIMER7_CH0 <sup>(4)</sup> Remap: TIMER2_CH0  |  |  |  |
| PC7               | 38   | I/O                        | 5VT                         | Default: PC7 Alternate: I2S2_MCK, TIMER7_CH1 <sup>(4)</sup> Remap: TIMER2_CH1  |  |  |  |
| PC8               | 39   | I/O                        | 5VT                         | Default: PC8 Alternate: TIMER7_CH2 <sup>(4)</sup> Remap: TIMER2_CH2  |  |  |  |
| PC9               | 40   | I/O                        | 5VT                         | Default: PC9 Alternate: TIMER7_CH3 <sup>(4)</sup> Remap: TIMER2_CH3  |  |  |  |
| PA8               | 41   | I/O                        | 5VT                         | Default: PA8 Alternate: USART0_CK, TIMER0_CH0, CK_OUT0, USBFS_SOF, CTC_SYNC  |  |  |  |
| PA9               | 42   | I/O                        | 5VT                         | Default: PA9 Alternate: USART0_TX, TIMER0_CH1, USBFS_VBUS  |  |  |  |
| PA10              | 43   | I/O                        | 5VT                         | Default: PA10 Alternate: USART0_RX, TIMER0_CH2, USBFS_ID   |  |  |  |
| PA11              | 44   | I/O                        | 5VT                         | Default: PA11 Alternate: USART0_CTS, CAN0_RX, USBFS_DM, TIMER0_CH3   |  |  |  |
| PA12              | 45   | I/O                        | 5VT                         | Default: PA12 Alternate: USART0_RTS, USBFS_DP, CAN0_TX, TIMER0_ETI   |  |  |  |
| PA13              | 46   | I/O                        | 5VT                         | Default: JTMS, SWDIO<br>Remap: PA13  |  |  |  |
| V <sub>SS_2</sub> | 47   | Р                          |                             | Default: V <sub>SS_2</sub>   |  |  |  |



|            |      |                            |                             | ODOZI OOI XX Datasrice   |
|------------|------|----------------------------|-----------------------------|--|
| Pin Name   | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description  |
| $V_{DD_2}$ | 48   | Р                          |                             | Default: V <sub>DD 2</sub>   |
|            |      |                            |                             | Default: JTCK, SWCLK   |
| PA14       | 49   | I/O                        | 5VT                         | Remap: PA14  |
| PA15       | 50   | I/O                        | 5VT                         | Default: JTDI Alternate: SPI2_NSS, I2S2_WS Remap: TIMER1_CH0, TIMER1_ETI, PA15, SPI0_NSS   |
| PC10       | 51   | I/O                        | 5VT                         | Default: PC10 Alternate: UART3_TX Remap: USART2_TX, SPI2_SCK, I2S2_CK  |
| PC11       | 52   | I/O                        | 5VT                         | Default: PC11 Alternate: UART3_RX Remap: USART2_RX, SPI2_MISO  |
| PC12       | 53   | I/O                        | 5VT                         | Default: PC12<br>Alternate: UART4_TX<br>Remap: USART2_CK, SPI2_MOSI, I2S2_SD   |
| PD2        | 54   | I/O                        | 5VT                         | Default: PD2<br>Alternate: TIMER2_ETI, UART4_RX  |
| PB3        | 55   | I/O                        | 5VT                         | Default: JTDO Alternate:SPI2_SCK, I2S2_CK Remap: PB3, TRACESWO, TIMER1_CH1, SPI0_SCK   |
| PB4        | 56   | I/O                        | 5VT                         | Default: NJTRST Alternate: SPI2_MISO Remap: TIMER2_CH0, PB4, SPI0_MISO   |
| PB5        | 57   | I/O                        |                             | Default: PB5 Alternate: I2C0_SMBA, SPI2_MOSI, I2S2_SD, ENET_MII_PPS_OUT, ENET_RMII_PPS_OUT Remap: TIMER2_CH1, SPI0_MOSI, CAN1_RX |
| PB6        | 58   | I/O                        | 5VT                         | Default: PB6 Alternate: I2C0_SCL, TIMER3_CH0 Remap: USART0_TX, CAN1_TX, SPI0_IO2   |
| PB7        | 59   | I/O                        | 5VT                         | Default: PB7 Alternate: I2C0_SDA , TIMER3_CH1 Remap: USART0_RX, SPI0_IO3   |
| воото      | 60   | I                          |                             | Default: BOOT0   |
| PB8        | 61   | I/O                        | 5VT                         | Default: PB8 Alternate: TIMER3_CH2, TIMER9_CH0 <sup>(3)</sup> , ENET_MII_TXD3 Remap: I2C0_SCL, CAN0_RX                           |
| PB9        | 62   | I/O                        | 5VT                         | Default: PB9 Alternate: TIMER3_CH3, TIMER10_CH0 <sup>(3)</sup> Remap: I2C0_SDA, CAN0_TX  |





| Pin Name    | Pins | Pin<br>Type <sup>(1)</sup> | I/O<br>Level <sup>(2)</sup> | Functions description      |
|-------------|------|----------------------------|-----------------------------|----------------------------|
| $V_{SS\_3}$ | 63   | Р                          |                             | Default: V <sub>SS_3</sub> |
| $V_{DD_3}$  | 64   | Р                          |                             | Default: V <sub>DD_3</sub> |

#### Notes:

(1) Type: I = input, O = output, P = power.

(2)I/O Level: 5VT = 5 V tolerant.

(3) Functions are available in GD32F307RG devices.

(4)Functions are available in GD32F307RE/G devices.

(5)PD0/PD1 cannot be used for EXTI in this package.



## 3. Functional description

#### 3.1. Arm<sup>®</sup> Cortex<sup>®</sup>-M4 core

The Arm® Cortex®-M4 processor is a high performance embedded processor with DSP instructions which allow efficient signal processing and complex algorithm execution. It brings an efficient, easy-to-use blend of control and signal processing capabilities to meet the digital signal control markets demand. The processor is highly configurable enabling a wide range of implementations from those requiring floating point operations, memory protection and powerful trace technology to cost sensitive devices requiring minimal area, while delivering outstanding computational performance and an advanced system response to interrupts.

32-bit Arm® Cortex®-M4 processor core

- Up to 120 MHz operation frequency
- Single-cycle multiplication and hardware divider
- Integrated DSP instructions
- Integrated Nested Vectored Interrupt Controller (NVIC)
- 24-bit SysTick timer

The Cortex®-M4 processor is based on the Armv7-M architecture and supports both Thumb and Thumb-2 instruction sets. Some system peripherals listed below are also provided by Cortex®-M4:

- Internal Bus Matrix connected with ICode bus, DCode bus, System bus, Private Peripheral Bus (PPB) and debug accesses (AHB-AP)
- Nested Vectored Interrupt Controller (NVIC)
- Flash Patch and Breakpoint (FPB)
- Data Watchpoint and Trace (DWT)
- Instrument Trace Macrocell (ITM)
- Memory Protection Unit (MPU)
- Serial Wire JTAG Debug Port (SWJ-DP)
- Trace Port Interface Unit (TPIU)
- Floating Point Unit (FPU)

# 3.2. On-chip memory

- Up to 1024 Kbytes of Flash memory, including code Flash and data Flash
- 96 KB of SRAM

The Arm® Cortex®-M4 processor is structured in Harvard architecture which can use separate buses to fetch instructions and load/store data. 1024 Kbytes of inner flash at most, which includes code Flash that available for storing programs and data, and accessed (R/W) at CPU clock speed with zero wait states. An extra data Flash is also included for storing data mainly. *Table 2-2. GD32F307xx memory map* shows the memory of the GD32F307xx series of



devices, including Flash, SRAM, peripheral, and other pre-defined regions.

#### 3.3. Clock, reset and supply management

- Internal 8 MHz factory-trimmed RC and external 4 to 32 MHz crystal oscillator
- Internal 48 MHz RC oscillator
- Internal 40 KHz RC calibrated oscillator and external 32.768 KHz crystal oscillator
- 2.6 to 3.6 V application supply and I/Os
- Supply Supervisor: POR (Power On Reset), PDR (Power Down Reset), and low voltage detector (LVD)

The Clock Control Unit (CCU) provides a range of oscillator and clock functions. These include internal RC oscillator and external crystal oscillator, high speed and low speed two types. Several prescalers allow the frequency configuration of the AHB and two APB domains. The maximum frequency of the two AHB domains are 120 MHz The maximum frequency of the two APB domains including APB1 is 60 MHz and APB2 is 120 MHz See <u>Figure 2-5 GD32F307xx clock tree</u> for details on the clock tree.

The Reset Control Unit (RCU) controls three kinds of reset: system reset resets the processor core and peripheral IP components. Power-on reset (POR) and power-down reset (PDR) are always active, and ensures proper operation starting from/down to 2.6 V. The device remains in reset mode when  $V_{DD}$  is below a specified threshold. The embedded low voltage detector (LVD) monitors the power supply, compares it to the voltage threshold and generates an interrupt as a warning message for leading the MCU into security.

#### Power supply schemes:

- V<sub>DD</sub> range: 2.6 to 3.6 V, external power supply for I/Os and the internal regulator. Provided externally through V<sub>DD</sub> pins.
- V<sub>SSA</sub>, V<sub>DDA</sub> range: 2.6 to 3.6 V, external analog power supplies for ADC, reset blocks, RCs and PLL. V<sub>DDA</sub> and V<sub>SSA</sub> must be connected to V<sub>DD</sub> and V<sub>SS</sub>, respectively.
- V<sub>BAT</sub> range: 1.8 to 3.6 V, power supply for RTC, external clock 32 KHz oscillator and backup registers (through power switch) when V<sub>DD</sub> is not present.

#### 3.4. Boot modes

At startup, boot pins are used to select one of three boot options:

- Boot from main flash memory (default)
- Boot from system memory
- Boot from on-chip SRAM

The boot loader is located in the internal boot ROM memory (system memory). It is used to reprogram the Flash memory by using USART0 (PA9 and PA10), USART1 (PD5 and PD6) and USBFS (PA9, PA11 and PA12) is also available for boot functions. It also can be used to transfer and update the Flash memory code, the data and the vector table sections. In default



condition, boot from bank0 of Flash memory is selected. It also supports to boot from bank1 of Flash memory by setting a bit in option bytes.

### 3.5. Power saving modes

The MCU supports three kinds of power saving modes to achieve even lower power consumption. They are sleep mode, deep-sleep mode and standby mode. These operating modes reduce the power consumption and allow the application to achieve the best balance between the CPU operating time, speed and power consumption.

#### ■ Sleep mode

In sleep mode, only the clock of CPU core is off. All peripherals continue to operate and any interrupt/event can wake up the system.

#### ■ **Deep-sleep** mode

In deep-sleep mode, all clocks in the 1.2V domain are off, and all of the high speed crystal oscillator (IRC8M, HXTAL) and PLL are disabled. Only the contents of SRAM and registers are retained. Any interrupt or wakeup event from EXTI lines can wake up the system from the deep-sleep mode including the 16 external lines, the RTC alarm, the LVD output, the USB wakeup and ENET wakeup. When exiting the deep-sleep mode, the IRC8M is selected as the system clock.

#### Standby mode

In standby mode, the whole 1.2V domain is power off, the LDO is shut down, and all of IRC8M, HXTAL and PLL are disabled. The contents of SRAM and registers (except backup registers) are lost. There are four wakeup sources for the standby mode, including the external reset from NRST pin, the RTC, the FWDG reset, and the rising edge on WKUP pin.

# 3.6. Analog to digital converter (ADC)

- 12-bit SAR ADC's conversion rate is up to 2.6 MSPS
- 12-bit, 10-bit, 8-bit or 6-bit configurable resolution
- Hardware oversampling ratio adjustable from 2 to 256x improves resolution to 16-bit
- Input voltage range: V<sub>SSA</sub> to V<sub>DDA</sub> (2.6 to 3.6 V)
- Temperature sensor

Up to two 12-bit 2.6 MSPS multi-channel ADCs are integrated in the device. It has a total of 18 multiplexed channels: 16 external channels, 1 channel for internal temperature sensor (V<sub>SENSE</sub>), and 1 channel for internal reference voltage (V<sub>REFINT</sub>). The input voltage range is between 2.6 V and 3.6 V. An on-chip hardware oversampling scheme improves performance while off-loading the related computational burden from the CPU. An analog watchdog block can be used to detect the channels, which are required to remain within a specific threshold window. A configurable channel management block can be used to perform conversions in single, continuous, scan or discontinuous mode to support more advanced use.



The ADC can be triggered from the events generated by the general level 0 timers (TIMERx) and the advanced timers (TIMER0 and TIMER7) with internal connection. The temperature sensor can be used to generate a voltage that varies linearly with temperature. It is internally connected to the ADC\_IN16 input channel which is used to convert the sensor output voltage in a digital value.

## 3.7. Digital to analog converter (DAC)

- Two 12-bit DACs with independent output channels
- 8-bit or 12-bit mode in conjunction with the DMA controller

The two 12-bit buffered DACs are used to generate variable analog outputs. The DAC channels can be triggered by the timer or EXTI with DMA support. In dual DAC channel operation, conversions could be done independently or simultaneously. The maximum output value of the DAC is  $V_{\text{REF+}}$ .

#### 3.8. DMA

- 7 channel DMA0 controller and 5 channel DMA1 controller
- Peripherals supported: Timers, ADC, SPIs, I2Cs, USARTs, DAC, I2S

The flexible general-purpose DMA controllers provide a hardware method of transferring data between peripherals and/or memory without intervention from the CPU, thereby freeing up bandwidth for other system functions. Three types of access method are supported: peripheral to memory, memory to peripheral, memory to memory

Each channel is connected to fixed hardware DMA requests. The priorities of DMA channel requests are determined by software configuration and hardware channel number. Transfer size of source and destination are independent and configurable.

# 3.9. General-purpose inputs/outputs (GPIOs)

- Up to 112 fast GPIOs, all mappable on 16 external interrupt lines
- Analog input/output configurable
- Alternate function input/output configurable

There are up to 112 general purpose I/O pins (GPIO) in GD32F307xx, named PA0  $\sim$  PA15 and PB0  $\sim$  PB15, PC0  $\sim$  PC15, PD0  $\sim$  PD15, PE0  $\sim$  PE15, PF0-PF15, PG0-PG15 to implement logic input/output functions. Each of the GPIO ports has related control and configuration registers to satisfy the requirements of specific applications. The external interrupts on the GPIO pins of the device have related control and configuration registers in the Interrupt/event controller (EXTI). The GPIO ports are pin-shared with other alternative functions (AFs) to obtain maximum flexibility on the package pins. Each of the GPIO pins can be configured by software as output (push-pull or open-drain), as input (with or without pull-



up or pull-down) or as peripheral alternate function. Most of the GPIO pins are shared with digital or analog alternate functions. All GPIOs are high-current capable except for analog inputs.

### 3.10. Timers and PWM generation

- Two 16-bit advanced timer (TIMER0 & TIMER7), ten 16-bit general timers (TIMER1 ~ TIMER4, TIMER8 ~ TIMER13), and two 16-bit basic timer (TIMER5 & TIMER6)
- Up to 4 independent channels of PWM, output compare or input capture for each general timer and external trigger input
- 16-bit, motor control PWM advanced timer with programmable dead-time generation for output match
- Encoder interface controller with two inputs using quadrature decoder
- 24-bit SysTick timer down counter
- 2 watchdog timers (Free watchdog timer and window watchdog timer)

The advanced timer (TIMER0 & TIMER7) can be used as a three-phase PWM multiplexed on 6 channels. It has complementary PWM outputs with programmable dead-time generation. It can also be used as a complete general timer. The 4 independent channels can be used for input capture, output compare, PWM generation (edge-aligned or center-aligned counting modes) and single pulse mode output. If configured as a general 16-bit timer, it has the same functions as the TIMERx timer. It can be synchronized with external signals or to interconnect with other general timers together which have the same architecture and features.

The general timer, can be used for a variety of purposes including general time, input signal pulse width measurement or output waveform generation such as a single pulse generation or PWM output, up to 4 independent channels for input capture/output compare. TIMER1  $\sim$  TIMER4 is based on a 16-bit auto-reload up/downcounter and a 16-bit prescaler. TIMER8  $\sim$  TIMER13 is based on a 16-bit auto-reload upcounter and a 16-bit prescaler. The general timer also supports an encoder interface with two inputs using quadrature decoder.

The basic timer, known as TIMER5 & TIMER6, are mainly used for DAC trigger generation. They can also be used as a simple 16-bit time base.

The GD32F307xx have two watchdog peripherals, free watchdog timer and window watchdog timer. They offer a combination of high safety level, flexibility of use and timing accuracy.

The free watchdog timer includes a 12-bit down-counting counter and an 8-bit prescaler, It is clocked from an independent 40 KHz internal RC and as it operates independently of the main clock, it can operate in deep-sleep and standby modes. It can be used either as a watchdog to reset the device when a problem occurs, or as a free-running timer for application timeout management.

The window watchdog timer is based on a 7-bit down counter that can be set as free-running. It can be used as a watchdog to reset the device when a problem occurs. It is clocked from the main clock. It has an early wakeup interrupt capability and the counter can be frozen in



debug mode.

The SysTick timer is dedicated for OS, but could also be used as a standard down counter.

The features are shown below:

- A 24-bit down counter
- Auto reload capability
- Maskable system interrupt generation when the counter reaches 0
- Programmable clock source

### 3.11. Real time clock (RTC)

- 32-bit up-counter with a programmable 20-bit prescaler
- Alarm function
- Interrupt and wakeup event

The real time clock is an independent timer which provides a set of continuously running counters which can be used with suitable software to provide a clock calendar function, and provides an alarm interrupt and an expected interrupt. The RTC features a 32-bit programmable counterfor long-term measurement using the compare register to generate an alarm. A 20-bit prescaler is used for the time base clock and is by default configured to generate a time base of 1 second from a clock at 32.768 KHz from external crystal oscillator.

## 3.12. Inter-integrated circuit (I2C)

- Up to two I2C bus interfaces can support both master and slave mode with a frequency up to 1 MHz (Fast mode plus)
- Provide arbitration function, optional PEC (packet error checking) generation and checking
- Supports 7-bit and 10-bit addressing mode and general call addressing mode

The I2C interface is an internal circuit allowing communication with an external I2C interface which is an industry standard two line serial interface used for connection to external hardware. These two serial lines are known as a serial data line (SDA) and a serial clock line (SCL). The I2C module provides several data transfer rates of up to 100 KHz in standard mode, up to 400 KHz in fast mode and up to 1 MHz in the fast mode plus. The I2C module also has an arbitration detect function to prevent the situation where more than one master attempts to transmit data to the I2C bus at the same time. A CRC-8 calculator is also provided in I2C interface to perform packet error checking for I2C data.

# 3.13. Serial peripheral interface (SPI)

- Up to three SPI interfaces with a frequency of up to 30 MHz
- Support both master and slave mode



- Hardware CRC calculation and transmit automatic CRC error checking
- Quad-SPI configuration available in master mode (only in SPI0)

The SPI interface uses 4 pins, among which are the serial data input and output lines (MISO & MOSI), the clock line (SCK) and the slave select line (NSS). Both SPIs can be served by the DMA controller. The SPI interface may be used for a variety of purposes, including simplex synchronous transfers on two lines with a possible bidirectional data line or reliable communication using CRC checking. Quad-SPI master mode is also supported in SPIO.

# 3.14. Universal synchronous asynchronous receiver transmitter (USART)

- Up to three USARTs and two UARTs with operating frequency up to 7.5M Bits/s
- Supports both asynchronous and clocked synchronous serial communication modes
- IrDA SIR encoder and decoder support
- LIN break generation and detection
- USARTs support ISO 7816-3 compliant smart card interface

The USART (USART0, USART1 and USART2) and UART (UART3 & UART4) are used to translate data between parallel and serial interfaces, provides a flexible full duplex data exchange using synchronous or asynchronous transfer. It is also commonly used for RS-232 standard communication. The USART/UART includes a programmable baud rate generator which is capable of dividing the system clock to produce a dedicated clock for the USART transmitter and receiver. The USART/UART also supports DMA function for high speed data communication except UART4.

# 3.15. Inter-IC sound (I2S)

- Two I2S bus Interfaces with sampling frequency from 8 KHz to 192 KHz
- Support either master or slave mode

The Inter-IC sound (I2S) bus provides a standard communication interface for digital audio applications by 3-wire serial lines. GD32F307xx contain two I2S-bus interfaces that can be operated with 16/32 bit resolution in master or slave mode, pin multiplexed with SPI1 and SPI2. The audio sampling frequency from 8 KHz to 192 KHz is supported.

# 3.16. Universal serial bus full-speed interface (USBFS)

- One USB device/host/full-speed Interface with frequency up to 12 Mbit/s
- Internal 48 MHz oscillator (IRC48M) support crystal-less operation
- Internal main PLL for USBCLK compliantly
- Internal USBFS PHY support



The Universal Serial Bus (USB) is a 4-wire bus with 4 bidirectional endpoints. The device controller enables 12 Mbit/s data exchange with integrated transceivers. Transaction formatting is performed by the hardware, including CRC generation and checking. It supports both host and device modes, as well as OTG mode with Host Negotiation Protocol (HNP) and Session Request Protocol (SRP). The controller contains a full-speed USB PHY internal. For full-speed or low-speed operation, no more external PHY chip is needed. It supports all the four types of transfer (control, bulk, Interrupt and isochronous) defined in USB 2.0 protocol. The required precise 48 MHz clock which can be generated from the internal main PLL (the clock source must use an HXTAL crystal oscillator) or by the internal 48 MHz oscillator (IRC48M) in automatic trimming mode that allows crystal-less operation.

#### 3.17. Controller area network (CAN)

- Two CAN2.0B interface with communication frequency up to 1 Mbit/s
- Internal main PLL for CAN CLK compliantly

Controller area network (CAN) is a method for enabling serial communication in field bus. The CAN protocol has been used extensively in industrial automation and automotive applications. It can receive and transmit standard frames with 11-bit identifiers as well as extended frames with 29-bit identifiers. Each CAN has three mailboxes for transmission and two FIFOs of three message deep for reception. It also provides 28 scalable/configurable identifier filter banks for selecting the incoming messages needed and discarding the others.

## 3.18. Ethernet (ENET)

- IEEE 802.3 compliant media access controller (MAC) for Ethernet LAN
- 10/100 Mbit/s rates with dedicated DMA controller and SRAM
- Support hardware precision time protocol (PTP) with conformity to IEEE 1588

The Ethernet media access controller (MAC) conforms to IEEE 802.3 specifications and fully supports IEEE 1588 standards. The embedded MAC provides the interface to the required external network physical interface (PHY) for LAN bus connection via an internal media independent interface (MII) or a reduced media independent interface (RMII). The number of MII signals provided up to 16 with 25 MHz output and RMII up to 7 with 50 MHz output. The function of 32-bit CRC checking is also available.

# 3.19. External memory controller (EXMC)

- Supported external memory: SRAM, PSRAM, ROM and NOR-Flash, NAND Flash and PC card
- Provide ECC calculating hardware module for NAND Flash memory block
- Up to 16-bit data bus
- Support to interface with Motorola 6800 and Intel 8080 type LCD directly



External memory controller (EXMC) is an abbreviation of external memory controller. It is divided in to several sub-banks for external device support, each sub-bank has its own chip selection signal but at one time, only one bank can be accessed. The EXMC support code execution from external memory except NAND Flash and PC card. The EXMC also can be configured to interface with the most common LCD module of Motorola 6800 and Intel 8080 series and reduce the system cost and complexity.

## 3.20. Debug mode

■ Serial wire JTAG debug port (SWJ-DP)

The Arm® SWJ-DP Interface is embedded and is a combined JTAG and serial wire debug port that enables either a serial wire debug or a JTAG probe to be connected to the target.

## 3.21. Package and operation temperature

- LQFP144 (GD32F307Zx), LQFP100 (GD32F307Vx) and LQFP64 (GD32F307Rx)
- Operation temperature range: -40°C to +85°C (industrial level)



### 4. Electrical characteristics

## 4.1. Absolute maximum ratings

The maximum ratings are the limits to which the device can be subjected without permanently damaging the device. Note that the device is not guaranteed to operate properly at the maximum ratings. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

Table 4-1. Absolute maximum ratings(1)(4)

| Symbol                            | Parameter   | Min                    | Max                    | Unit |
|-----------------------------------|---|------------------------|------------------------|------|
| V <sub>DD</sub>                   | External voltage range <sup>(2)</sup>                 | V <sub>SS</sub> - 0.3  | V <sub>SS</sub> + 3.6  | V    |
| $V_{DDA}$                         | External analog supply voltage                        | V <sub>SSA</sub> - 0.3 | V <sub>SSA</sub> + 3.6 | V    |
| V <sub>BAT</sub>                  | External battery supply voltage                       | V <sub>SS</sub> - 0.3  | V <sub>SS</sub> + 3.6  | V    |
| Vari                              | Input voltage on 5V tolerant pin <sup>(3)</sup>       | V <sub>SS</sub> - 0.3  | V <sub>DD</sub> + 3.6  | V    |
| V <sub>IN</sub>                   | Input voltage on other I/O                            | V <sub>SS</sub> - 0.3  | 3.6                    | V    |
| $ \Delta V_{DDx} $                | Variations between different VDD power pins           |                        | 50                     | mV   |
| V <sub>SSX</sub> -V <sub>SS</sub> | Variations between different ground pins              |                        | 50                     | mV   |
| I <sub>IO</sub>                   | Maximum current for GPIO pins                         |                        | ±25                    | mA   |
| T <sub>A</sub>                    | Operating temperature range                           | -40                    | +85                    | °C   |
|                                   | Power dissipation at T <sub>A</sub> = 85°C of LQFP144 | _                      | 820                    |      |
| P <sub>D</sub>                    | Power dissipation at T <sub>A</sub> = 85°C of LQFP100 | _                      | 848                    | mW   |
|                                   | Power dissipation at T <sub>A</sub> = 85°C of LQFP64  |                        | 647                    |      |
| T <sub>STG</sub>                  | Storage temperature range                             | -65                    | +150                   | °C   |
| TJ                                | Maximum junction temperature                          | _                      | 125                    | °C   |

<sup>(1)</sup> Guaranteed by design, not tested in production.

## 4.2. Operating conditions characteristics

Table 4-2. DC operating conditions

| Symbol           | Parameter              | Conditions              | Min <sup>(1)</sup> | Тур | Max <sup>(1)</sup> | Unit |
|------------------|------------------------|-------------------------|--------------------|-----|--------------------|------|
| V <sub>DD</sub>  | Supply voltage         | _                       | 2.6                | 3.3 | 3.6                | V    |
| $V_{DDA}$        | Analog supply voltage  | Same as V <sub>DD</sub> | 2.6                | 3.3 | 3.6                | V    |
| V <sub>BAT</sub> | Battery supply voltage | _                       | 1.8 <sup>(2)</sup> | _   | 3.6                | V    |

<sup>(1)</sup> Based on characterization, not tested in production.

<sup>(2)</sup> All main power and ground pins should be connected to an external power source within the allowable range.

<sup>(3)</sup>  $V_{IN}$  maximum value cannot exceed 5.5 V.

<sup>(4)</sup> It is recommended that  $V_{DD}$  and  $V_{DDA}$  are powered by the same source. The maximum difference between  $V_{DD}$  and  $V_{DDA}$  does not exceed 300 mV during power-up and operation.

<sup>(2)</sup> In the application which V<sub>BAT</sub> supply the backup domains, if the V<sub>BAT</sub> voltage drops below the minimum value, when V<sub>DD</sub> is powered on again, it is necessary to refresh the registers of backup domains and enable LXTAL again.



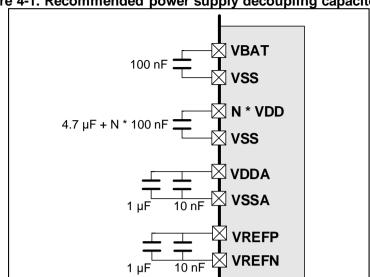


Figure 4-1. Recommended power supply decoupling capacitors (1)(2)

- (1) The VREFP and VREFN pins are only available on no less than 100-pin packages, or else the VREFP and VREFN pins are not available and internally connected to VDDA and VSSA pins.
- (2) All decoupling capacitors need to be as close as possible to the pins on the PCB board.

Table 4-3. Clock frequency(1)

| Symbol            | Parameter            | Conditions | Min | Max | Unit |
|-------------------|----------------------|------------|-----|-----|------|
| fHCLK             | AHB clock frequency  |            |     | 120 | MHz  |
| f <sub>APB1</sub> | APB1 clock frequency | _          | _   | 60  | MHz  |
| f <sub>APB2</sub> | APB2 clock frequency | _          | _   | 120 | MHz  |

<sup>(1)</sup> Guaranteed by design, not tested in production.

Table 4-4. Operating conditions at Power up/ Power down(1)

| Symbol | Parameter                      | Conditions | Min | Max | Unit  |
|--------|--------------------------------|------------|-----|-----|-------|
|        | V <sub>DD</sub> rise time rate |            | 0   | 8   | us/ V |
| t∨DD   | V <sub>DD</sub> fall time rate | _          | 20  | 8   | μ5/ ν |

<sup>(1)</sup> Guaranteed by design, not tested in production.

Table 4-5. Start-up timings of Operating conditions<sup>(1)(2)(3)</sup>

| Symbol                | Parameter     | Conditions              | Тур | Unit |
|-----------------------|---------------|-------------------------|-----|------|
| t <sub>start-up</sub> | Chaut up time | Clock source from HXTAL | 154 |      |
|                       | Start-up time | Clock source from IRC8M | 154 | ms   |

- (1) Based on characterization, not tested in production.
- (2) After power-up, the start-up time is the time between the rising edge of NRST high and the main function.
- (3) PLL is off.

Table 4-6. Power saving mode wakeup timings characteristics(1)(2)

| Symbol               | Symbol Parameter                                    |     | Unit |
|----------------------|---|-----|------|
| t <sub>Sleep</sub>   | Wakeup from Sleep mode                              | 3.4 |      |
| 4-                   | Wakeup from Deep-sleep mode (LDO On)                | 5.8 | μs   |
| tDeep-sleep          | Wakeup from Deep-sleep mode (LDO in low power mode) | 5.8 |      |
| t <sub>Standby</sub> | Wakeup from Standby mode                            | 154 | ms   |

<sup>(1)</sup> Based on characterization, not tested in production.

<sup>(2)</sup> The wakeup time is measured from the wakeup event to the point at which the application code reads the first



instruction under the below conditions:  $V_{DD} = V_{DDA} = 3.3 \text{ V}$ , IRC8M = System clock = 8 MHz.

# 4.3. Power consumption

The power measurements specified in the tables represent that code with data executing from on-chip Flash with the following specifications.

Table 4-7. Power consumption characteristics (2)(3)(4)(5)(6)

| Symbol    | Parameter                    | Conditions  | Min | Typ <sup>(1)</sup> | Max | Unit |
|-----------|------------------------------|---|-----|--------------------|-----|------|
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 120 MHz, All peripherals enabled  | —   | 45.1               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 120 MHz, All peripherals disabled |     | 25.5               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ System clock = 108 MHz, All peripherals enabled     | _   | 40.7               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 108 MHz, All peripherals disabled | _   | 23.2               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 96 MHz, All peripherals enabled   | _   | 36.4               | _   | mA   |
| les des . | Supply current<br>(Run mode) | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 96 MHz, All peripherals disabled  | _   | 20.8               | _   | mA   |
| IDD+IDDA  |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 72 MHz, All peripherals enabled   | _   | 27.9               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 72 MHz, All peripherals disabled  | _   | 16.1               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 48 MHz, All peripherals enabled   | _   | 19.3               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 48 MHz, All peripherals disabled  | _   | 11.4               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$<br>System clock = 36 MHz, All peripherals enabled   | _   | 15.0               | _   | mA   |
|           |                              | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ System clock = 36 MHz, All peripherals disabled     | _   | 9.1                | _   | mA   |



| Symbol     | Parameter      | Conditions  | Min | Typ <sup>(1)</sup> | Max | Unit |
|------------|----------------|---|-----|--------------------|-----|------|
| - <b>J</b> |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     | - 71-              |     |      |
|            |                | System clock = 24 MHz, All peripherals                      | _   | 10.6               |     | mA   |
|            |                | enabled   |     | 10.0               |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|            |                | System clock = 24 MHz, All peripherals                      | _   | 6.7                |     | mA   |
|            |                | disabled  |     | 0.7                |     | 110  |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|            |                | System clock = 16 MHz, All peripherals                      | _   | 7.8                |     | mA   |
|            |                | enabled   |     | 7.0                |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|            |                | System clock = 16 MHz, All peripherals                      | _   | 5.2                |     | mA   |
|            |                | disabled  |     | 0.2                |     | 110  |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|            |                | System clock = 8 MHz, All peripherals                       | _   | 4.9                | _   | mA   |
|            |                | enabled   |     |                    |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|            |                | System clock = 8 MHz, All peripherals                       | _   | 3.6                |     | mA   |
|            |                | disabled  |     | 0.0                |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 4 \text{ MHz,}$  |     |                    |     |      |
|            |                | System clock = 4 MHz, All peripherals                       | _   | 1.4                | _   | mA   |
|            |                | enabled   |     |                    |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 4 \text{ MHz,}$  |     |                    |     |      |
|            |                | System clock = 4 MHz, All peripherals                       | _   | 0.9                | _   | mA   |
|            |                | disabled  |     |                    |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 2 \text{ MHz,}$  |     |                    |     |      |
|            |                | System clock = 2 MHz, All peripherals                       | _   | 0.8                | _   | mA   |
|            |                | enabled   |     |                    |     |      |
|            |                | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 2 \text{ MHz,}$  |     |                    |     |      |
|            |                | System Clock = 2 MHz, All peripherals                       | _   | 0.6                | _   | mA   |
|            |                | disabled  |     |                    |     |      |
|            |                | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|            |                | System Clock = 120 MHz, CPU clock off,                      | _   | 31.4               | _   | mA   |
|            |                | All peripherals enabled                                     |     |                    |     |      |
|            |                | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|            |                | System Clock = 120 MHz, CPU clock off,                      | _   | 10.5               |     | mA   |
|            | Supply current | All peripherals disabled                                    |     |                    |     |      |
|            | (Sleep mode)   | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|            |                | System Clock = 108 MHz, CPU clock off,                      | _   | 28.4               | _   | mA   |
|            |                | All peripherals enabled                                     |     |                    |     |      |
|            |                | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|            |                | System Clock = 108 MHz, CPU clock off,                      | _   | 9.6                | _   | mA   |
|            |                | All peripherals disabled                                    |     |                    |     |      |
|            | 1              | • • •   |     |                    | 1   |      |



| Symbol | Parameter | Conditions  | Min | Typ <sup>(1)</sup> | Max | Unit |
|--------|-----------|---|-----|--------------------|-----|------|
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     | 71                 |     |      |
|        |           | System Clock = 96 MHz, CPU clock off, All                   | _   | 25.5               |     | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 96 MHz, CPU clock off, All                   | _   | 8.8                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |
|        |           | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|        |           | System Clock = 72 MHz, CPU clock off, All                   | _   | 19.7               |     | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 72 MHz, CPU clock off, All                   | _   | 7.1                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |
|        |           | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|        |           | System Clock = 48 MHz, CPU clock off, All                   | _   | 13.8               | _   | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|        |           | System Clock = 48 MHz, CPU clock off, All                   | _   | 5.4                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |
|        |           | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|        |           | System Clock = 36 MHz, CPU clock off, All                   | _   | 10.8               | _   | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 25 MHz, |     |                    |     |      |
|        |           | System Clock = 36 MHz, CPU clock off, All                   | _   | 4.5                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 24 MHz, CPU clock off, All                   | _   | 7.9                | _   | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 24 MHz, CPU clock off, All                   | _   | 3.7                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 16 MHz, CPU clock off, All                   | _   | 5.9                | _   | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 16 MHz, CPU clock off, All                   | _   | 3.2                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 8 MHz, CPU clock off, All                    | _   | 4.0                | _   | mA   |
|        |           | peripherals enabled   |     |                    |     |      |
|        |           | $V_{DD} = V_{DDA} = 3.3 \text{ V, HXTAL} = 25 \text{ MHz,}$ |     |                    |     |      |
|        |           | System Clock = 8 MHz, CPU clock off, All                    | _   | 2.6                | _   | mA   |
|        |           | peripherals disabled  |     |                    |     |      |



|        | OD321                         |  |     |                    |      |      |
|--------|-------------------------------|--|-----|--------------------|------|------|
| Symbol | Parameter                     | Conditions   | Min | Typ <sup>(1)</sup> | Max  | Unit |
|        |                               | $V_{DD} = V_{DDA} = 3.3 \text{ V}, \text{ HXTAL} = 4 \text{ MHz},$<br>System Clock = 4 MHz, CPU clock off, All                 | _   | 1.0                | _    | mA   |
|        |                               | peripherals enabled  V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 4 MHz,  System Clock = 4 MHz, CPU clock off, All      | _   | 0.5                | _    | mA   |
|        |                               | peripherals disabled  VDD = VDDA = 3.3 V, HXTAL = 2 MHz,  System Clock = 2 MHz, CPU clock off, All peripherals enabled         | _   | 0.6                | _    | mA   |
|        |                               | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V, HXTAL = 2 MHz,<br>System Clock = 2 MHz, CPU clock off, All<br>peripherals disabled | _   | 0.3                |      | mA   |
|        |                               | $V_{DD} = V_{DDA} = 3.3 \text{ V}$ , LDO in normal power and normal driver mode, IRC40K off, RTC off, All GPIOs analog mode    | _   | 137.8              | 1100 | μΑ   |
|        | Supply current                | $V_{DD} = V_{DDA} = 3.3 \text{ V}$ , LDO in normal power and low driver mode, IRC40K off, RTC off, All GPIOs analog mode       | _   | 109.1              | _    | μΑ   |
|        | (Deep-Sleep<br>mode)          | $V_{DD} = V_{DDA} = 3.3 \text{ V}$ , LDO in low power and normal driver mode, IRC40K off, RTC off, All GPIOs analog mode       | _   | 124.2              |      | μΑ   |
|        |                               | $V_{DD} = V_{DDA} = 3.3 \text{ V}$ , LDO in low power and low driver mode, IRC40K off, RTC off, All GPIOs analog mode          | _   | 94.9               | ı    | μΑ   |
|        |                               | $V_{DD} = V_{DDA} = 3.3 \text{ V, LXTAL off, IRC40K on,}$ RTC on   |     | 5.2                |      | μΑ   |
|        | Supply current (Standby mode) | $V_{DD} = V_{DDA} = 3.3 \text{ V, LXTAL off, IRC40K on,}$ RTC off  |     | 4.9                |      | μΑ   |
|        |                               | $V_{DD} = V_{DDA} = 3.3 \text{ V, LXTAL off, IRC40K off,}$ RTC off   |     | 4.3                | 22   | μΑ   |
|        |                               | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT}$ = 3.6 V, LXTAL on with external crystal, RTC on, LXTAL High driving                     | _   | 1.7                | 1    | μΑ   |
|        | Battery supply                | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT}$ = 3.3 V, LXTAL on with external crystal, RTC on, LXTAL High driving                     | _   | 1.5                | 1    | μΑ   |
| Іват   | current (Backup<br>mode)      | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 2.6$ V, LXTAL on with external crystal, RTC on, LXTAL High driving                     | _   | 1.3                | _    | μΑ   |
|        |                               | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 1.8$ V, LXTAL on with external crystal, RTC on, LXTAL High driving                     | _   | 1.2                | _    | μΑ   |



|        |           | 0D021 007 AX Datasii  |     |                    |     | 1100 |
|--------|-----------|---|-----|--------------------|-----|------|
| Symbol | Parameter | Conditions  | Min | Typ <sup>(1)</sup> | Max | Unit |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 3.6 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | _   | 1.4                | _   | μΑ   |
|        |           | Medium High driving   |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 3.3 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | —   | 1.2                | _   | μΑ   |
|        |           | Medium High driving   |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 2.6$ V, LXTAL on                      |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | —   | 1.1                | _   | μΑ   |
|        |           | Medium High driving   |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 1.8 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | _   | 1.0                | _   | μΑ   |
|        |           | Medium High driving   |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 3.6 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | —   | 1.1                | _   | μΑ   |
|        |           | Medium Low driving  |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 3.3 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | —   | 0.9                | _   | μΑ   |
|        |           | Medium Low driving  |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 2.6 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | —   | 8.0                | _   | μΑ   |
|        |           | Medium Low driving  |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 1.8 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL  | —   | 0.7                | _   | μΑ   |
|        |           | Medium Low driving  |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 3.6 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL Low                                      | _   | 1.0                | _   | μΑ   |
|        |           | driving   |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 3.3 \text{ V}$ , LXTAL on             |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL Low                                      | _   | 0.9                | _   | μΑ   |
|        |           | driving   |     |                    |     |      |
|        |           | $V_{DD}$ off, $V_{DDA}$ off, $V_{BAT} = 2.6$ V, LXTAL on                      |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL Low                                      | —   | 0.7                | _   | μΑ   |
|        |           | driving   |     |                    |     |      |
|        |           | V <sub>DD</sub> off, V <sub>DDA</sub> off, V <sub>BAT</sub> = 1.8 V, LXTAL on |     |                    |     |      |
|        |           | with external crystal, RTC on, LXTAL Low                                      | —   | 0.6                | _   | μΑ   |
|        |           | driving   |     |                    |     |      |
|        |           |   |     |                    |     |      |

- (1) Based on characterization, not tested in production.
- (2) Unless otherwise specified, all values given for  $T_A$  = 25  $\,^{\circ}C$  and test result is mean value.
- (3) When System Clock is less than 4 MHz, an external source is used, and the HXTAL bypass function is needed, no PLL.
- (4) When System Clock is greater than 8 MHz, a crystal 8 MHz is used, and the HXTAL bypass function is closed, using PLL.
- (5) When analog peripheral blocks such as ADCs, DACs, HXTAL, LXTAL, IRC8M, or IRC40K are ON, an additional power consumption should be considered.
- (6) All GPIOs are configured as analog mode except standby mode.



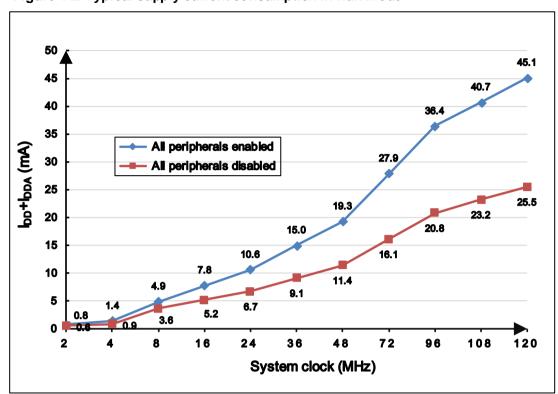


Figure 4-2. Typical supply current consumption in Run mode



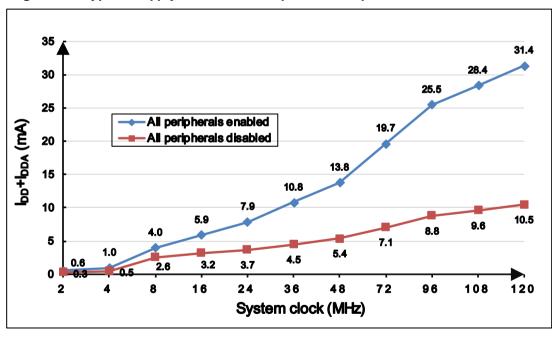
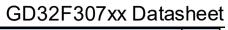


Table 4-8. Peripheral current consumption characteristics<sup>(1)</sup>

|      | Peripherials <sup>(4)</sup> | Typical consumption at $T_A = 25$ °C (TYP) | Unit |
|------|-----------------------------|--|------|
| 4004 | DAC <sup>(2)</sup>          | 0.81                                       | A    |
| APB1 | PMU                         | 1.41                                       | mA   |





|          |                             | Typical consumption at T <sub>A</sub> = 25 °C |    |
|----------|-----------------------------|---|----|
|          | Peripherials <sup>(4)</sup> | (TYP)   | Un |
|          | BKP                         | 1.93  |    |
|          | CAN1                        | 1.39  |    |
|          | CAN0                        | 1.41  |    |
|          | I2C1                        | 1.23  |    |
|          | I2C0                        | 1.21  |    |
|          | UART4                       | 1.24  |    |
|          | UART3                       | 1.25  |    |
|          | USART2                      | 1.23  |    |
|          | USART1                      | 1.24  |    |
|          | SPI2                        | 1.17  |    |
|          | SPI1                        | 1.23  |    |
|          | WWDGT                       | 1.13  |    |
|          | TIMER13                     | 1.47  |    |
|          | TIMER12                     | 1.44  |    |
|          | TIMER11                     | 1.47  |    |
|          | TIMER6                      | 1.14  |    |
|          | TIMER5                      | 1.12  |    |
|          | TIMER4                      | 1.52  |    |
|          | TIMER3                      | 2.25  |    |
|          | TIMER2                      | 2.23  |    |
|          | TIMER1                      | 2.25  |    |
| ADDAPB1  | СТС                         | 1.13  |    |
|          | TIMER10                     | 2.25  |    |
|          | TIMER9                      | 2.23  |    |
|          | TIMER8                      | 2.24  |    |
|          | USART0                      | 2.15  |    |
|          |                             | 2.66  |    |
|          | TIMER7<br>SPI0              | 1.87  |    |
|          | TIMER0                      | 2.63  |    |
|          | ADC1 <sup>(3)</sup>         | 0.80  |    |
| APB2     |                             | 0.80  |    |
|          | ADC0 <sup>(3)</sup>         | 1.99  |    |
|          | GPIOG                       |   |    |
|          | GPIOF                       | 2.00  |    |
| <u> </u> | GPIOE                       | 1.99  |    |
| _        | GPIOD                       | 2.00  |    |
| <u> </u> | GPIOC                       | 2.00  |    |
| <u> </u> | GPIOB                       | 2.00  |    |
|          | GPIOA                       | 1.29  |    |
| АНВ      | ENET                        | 5.04  |    |
|          | USBFS                       | 3.58  |    |



| Peripherials <sup>(4)</sup> | Typical consumption at $T_A = 25$ °C (TYP) | Unit |
|-----------------------------|--|------|
| EXMC                        | 2.59                                       |      |
| CRC                         | 1.81                                       |      |
| DMA1                        | 1.48                                       |      |
| DMA0                        | 1.61                                       |      |

- (1) Based on characterization, not tested in production.
- (2) DEN0 and DEN1 bits in the DAC CTL register are set to 1, and the converted value set to 0x800.
- (3) System clock = f<sub>HCLK</sub> = 120 Mhz, f<sub>APB1</sub> = f<sub>HCLK</sub>/2, f<sub>APB2</sub> = f<sub>HCLK</sub>, f<sub>ADCCLK</sub> = f<sub>APB2</sub>/2, ADON bit is set to 1.
- (4) If there is no other description, then HXTAL = 25 MHz, system clock = f<sub>HCLK</sub> = 120 MHz, f<sub>APB1</sub> = f<sub>HCLK</sub>/2, f<sub>APB2</sub> = f<sub>HCLK</sub>.

#### 4.4. EMC characteristics

EMS (electromagnetic susceptibility) includes ESD (Electrostatic discharge, positive and negative) and FTB (Burst of Fast Transient voltage, positive and negative) testing result is given in *Table 4-9. EMS characteristics*, based on the EMS levels and classes compliant with IEC 61000 series standard.

Table 4-9. EMS characteristics(1)

| Symbol           | Parameter   | Conditions   | Level/Class |
|------------------|---|--|-------------|
|                  | Voltage emplied to all device pine to                                 | V <sub>DD</sub> = 3.3 V, T <sub>A</sub> = 25 °C      |             |
| V <sub>ESD</sub> | Voltage applied to all device pins to induce a functional disturbance | LQFP144, f <sub>HCLK</sub> = 120 MHz                 | 3A          |
|                  | induce a functional disturbance                                       | conforms to IEC 61000-4-2                            |             |
|                  | Fast transient voltage burst applied to                               | $V_{DD} = 3.3 \text{ V, } T_A = 25 ^{\circ}\text{C}$ |             |
| $V_{FTB}$        | induce a functional disturbance through                               | LQFP144, f <sub>HCLK</sub> = 120 MHz                 | 4A          |
|                  | 100 pF on VDD and VSS pins  | conforms to IEC 61000-4-4                            |             |

<sup>(1)</sup> Based on characterization, not tested in production.

EMI (Electromagnetic Interference) emission test result is given in the <u>Table 4-10. EMI</u> <u>characteristics</u><sup>(1)</sup>, The electromagnetic field emitted by the device are monitored while an application, executing EEMBC code, is running. The test is compliant with SAE J1752-3:2017 standard which specifies the test board and the pin loading.

Table 4-10. EMI characteristics<sup>(1)</sup>

| Symbol           | Parameter  | Conditions  | Tested frequency band | Max vs.<br>[f <sub>HXTAL</sub> /f <sub>HCLK</sub> ]<br>8/120 MHz | Unit |
|------------------|--|---|-----------------------|--|------|
|                  |  | $V_{DD} = 3.6 \text{ V}, T_A = +23 ^{\circ}\text{C},$ | 0.15 MHz to 30 MHz    | 5.77   |      |
| S <sub>EMI</sub> | S <sub>FMI</sub> Peak level LQFP144, f <sub>HCLK</sub> = 120 | 30 MHz to 130 MHz                                     | 8.76                  | dΒμV   |      |
|                  |  | MHz, conforms to SAE                                  | 130 MHz to 1 GHz      | 7.88   | ·    |
|                  |  | J1752-3:2017  | 130 MHZ to 1 GHZ      | 7.00   |      |

<sup>(1)</sup> Based on characterization, not tested in production.



# 4.5. Power supply supervisor characteristics

Table 4-11. Power supply supervisor characteristics

| Symbol                              | Parameter                | Conditions                    | Min | Тур  | Max | Unit  |
|-------------------------------------|--------------------------|-------------------------------|-----|------|-----|-------|
|                                     |                          | LVDT<2:0> = 000(rising edge)  | _   | 2.15 | _   |       |
|                                     |                          | LVDT<2:0> = 000(falling edge) | _   | 2.04 | _   |       |
|                                     |                          | LVDT<2:0> = 001(rising edge)  | _   | 2.29 | _   |       |
|                                     |                          | LVDT<2:0> = 001(falling edge) | _   | 2.19 | _   |       |
|                                     |                          | LVDT<2:0> = 010(rising edge)  | _   | 2.43 | _   |       |
|                                     |                          | LVDT<2:0> = 010(falling edge) | _   | 2.33 | _   |       |
|                                     | Detector level selection | LVDT<2:0> = 011(rising edge)  |     | 2.57 | _   |       |
| ) (1)                               |                          | LVDT<2:0> = 011(falling edge) |     | 2.47 | _   | ,,    |
| VLVD <sup>(1)</sup>                 |                          | LVDT<2:0> = 100(rising edge)  | _   | 2.71 | _   | V     |
|                                     |                          | LVDT<2:0> = 100(falling edge) | _   | 2.6  | _   |       |
|                                     |                          | LVDT<2:0> = 101(rising edge)  | _   | 2.85 | _   |       |
|                                     |                          | LVDT<2:0> = 101(falling edge) | _   | 2.74 | _   |       |
|                                     |                          | LVDT<2:0> = 110(rising edge)  | _   | 2.99 | _   |       |
|                                     |                          | LVDT<2:0> = 110(falling edge) | _   | 2.89 | _   |       |
|                                     |                          | LVDT<2:0> = 111(rising edge)  | _   | 3.13 | _   |       |
|                                     |                          | LVDT<2:0> = 111(falling edge) | _   | 3.03 | _   |       |
| V <sub>LVDhyst</sub> <sup>(2)</sup> | LVD hystersis            | _                             |     | 100  | _   | mV    |
| V <sub>POR</sub> <sup>(1)</sup>     | Power on reset threshold |                               |     | 2.34 | _   | V     |
| V <sub>PDR</sub> <sup>(1)</sup>     | Power down reset         |                               | _   | 1.82 |     | V     |
|                                     | threshold                | _                             |     | 600  |     | ma\ / |
| V <sub>PDRhyst</sub> <sup>(2)</sup> | PDR hysteresis           |                               |     | 600  |     | mV    |
| t <sub>RSTTEMPO</sub> (2)           | Reset temporization      |                               | _   | 2    | _   | ms    |

<sup>(1)</sup> Based on characterization, not tested in production.

# 4.6. Electrical sensitivity

The device is strained in order to determine its performance in terms of electrical sensitivity. Electrostatic discharges (ESD) are applied directly to the pins of the sample. Static latch-up

<sup>(2)</sup> Guaranteed by design, not tested in production.



(LU) test is based on the two measurement methods.

Table 4-12. ESD characteristics(1)

| Symbol                | Parameter                     | Conditions             | Min | Тур | Max  | Unit |      |   |
|-----------------------|-------------------------------|------------------------|-----|-----|------|------|------|---|
| V                     | Electrostatic discharge       | T <sub>A</sub> =25 °C; |     |     |      |      | 4000 | W |
| VESD(HBM)             | voltage (human body model)    | JS-001-2017            |     |     | 4000 | V    |      |   |
| V                     | Electrostatic discharge       | T <sub>A</sub> =25 °C; |     |     | 750  | \ /  |      |   |
| V <sub>ESD(CDM)</sub> | voltage (charge device model) | JS-002-2018            |     |     | 750  | V    |      |   |

<sup>(1)</sup> Based on characterization, not tested in production.

Table 4-13. Static latch-up characteristics(1)

| Symbol | Parameter                        | Conditions                    | Min | Тур | Max  | Unit |
|--------|----------------------------------|-------------------------------|-----|-----|------|------|
|        | I-test                           | T 05 00 U50D70                |     |     | ±200 | mA   |
| LU     | V <sub>supply</sub> over voltage | T <sub>A</sub> =25 °C; JESD78 |     |     | 5.4  | ٧    |

<sup>(1)</sup> Based on characterization, not tested in production.

#### 4.7. External clock characteristics

Table 4-14. High speed external clock (HXTAL) generated from a crystal/ceramic characteristics

| Symbol                                 | Parameter  | Conditions   | Min | Тур  | Max | Unit |
|--|--|--|-----|------|-----|------|
| f <sub>HXTAL</sub> (1)                 | Crystal or ceramic frequency                     | $2.6 \text{ V} \le \text{V}_{DD} \le 3.6 \text{ V}$              | 4   | 8    | 32  | MHz  |
| R <sub>F</sub> <sup>(2)</sup>          | Feedback resistor                                | $V_{DD} = 3.3 \text{ V}$   | _   | 400  | _   | kΩ   |
| C <sub>HXTAL</sub> <sup>(2) (3)</sup>  | Recommended load capacitance on OSCIN and OSCOUT | Ι  |     | 20   | 30  | pF   |
| Ducy <sub>(HXTAL)</sub> <sup>(2)</sup> | Crystal or ceramic duty cycle                    | _  | 30  | 50   | 70  | %    |
| g <sub>m</sub> <sup>(2)</sup>          | Oscillator transconductance                      | Startup  |     | 25   |     | mA/V |
| IDDHXTAL <sup>(1)</sup>                | Crystal or ceramic operating current             | $V_{DD}$ = 3.3 V, $f_{HCLK}$ = $f_{IRC8M}$ = 8 MHz $T_A$ = 25 °C | ı   | 1.25 |     | mA   |
| tsuhxtal <sup>(1)</sup>                | Crystal or ceramic startup time                  | $V_{DD}$ = 3.3 V, $f_{HCLK}$ = $f_{IRC8M}$ = 8 MHz $T_A$ = 25 °C | _   | 1.8  | _   | ms   |

<sup>(1)</sup> Based on characterization, not tested in production.

Table 4-15. High speed external clock characteristics (HXTAL in bypass mode)

| Symbol                                | Parameter                                     | Conditions                      | Min                 | Тур | Max      | Unit |
|---------------------------------------|---|---------------------------------|---------------------|-----|----------|------|
| f <sub>HXTAL_ext</sub> <sup>(1)</sup> | External clock source or oscillator frequency | 2.6 V ≤ V <sub>DD</sub> ≤ 3.6 V | 1                   | l   | 50       | MHz  |
| V <sub>HXTALH</sub> <sup>(2)</sup>    | OSCIN input pin high level                    | V <sub>DD</sub> = 3.3 V         | 0.7 V <sub>DD</sub> | _   | $V_{DD}$ | V    |

<sup>(2)</sup> Guaranteed by design, not tested in production.

<sup>(3)</sup> C<sub>HXTAL1</sub> = C<sub>HXTAL2</sub> = 2\*(C<sub>LOAD</sub> - C<sub>S</sub>), For C<sub>HXTAL1</sub> and C<sub>HXTAL2</sub>, it is recommended matching capacitance on OSCIN and OSCOUT. For C<sub>LOAD</sub>, it is crystal/ceramic load capacitance, provided by the crystal or ceramic manufacturer. For C<sub>S</sub>, it is PCB and MCU pin stray capacitance.

| Symbol                             | Parameter                            | Conditions | Min      | Тур | Max                 | Unit |
|------------------------------------|--------------------------------------|------------|----------|-----|---------------------|------|
|                                    | voltage                              |            |          |     |                     |      |
| V <sub>HXTALL</sub> <sup>(2)</sup> | OSCIN input pin low level<br>voltage |            | $V_{SS}$ | _   | 0.3 V <sub>DD</sub> | ٧    |
| t <sub>H/L(HXTAL)</sub> (2)        | OSCIN high or low time               | _          | 5        | _   | _                   | ns   |
| t <sub>R/F(HXTAL)</sub> (2)        | OSCIN rise or fall time              | _          | _        | 1   | 10                  | ns   |
| C <sub>IN</sub> <sup>(2)</sup>     | OSCIN input capacitance              |            | _        | 5   | _                   | pF   |
| Ducy <sub>(HXTAL)</sub> (2)        | Duty cycle                           |            | 40       |     | 60                  | %    |

- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.

Table 4-16. Low speed external clock (LXTAL) generated from a crystal/ceramic characteristics

| Symbol                                 | Parameter  | Conditions                     | Min | Тур    | Max | Unit |
|--|--|--------------------------------|-----|--------|-----|------|
| f <sub>LXTAL</sub> (1)                 | Crystal or ceramic frequency                             | V <sub>DD</sub> = 3.3 V        | _   | 32.768 |     | kHz  |
| C <sub>LXTAL</sub> <sup>(2)(3)</sup>   | Recommended matching capacitance on OSC32IN and OSC32OUT | _                              | l   | 10     |     | pF   |
| Ducy <sub>(LXTAL)</sub> <sup>(2)</sup> | Crystal or ceramic duty cycle                            | _                              | 30  | _      | 70  | %    |
|  | Oscillator transconductance                              | Lower driving capability       |     | 4      |     |      |
| (2)                                    |  | Medium low driving capability  | 1   | 6      | 1   |      |
| gm <sup>(2)</sup>                      |  | Medium high driving capability | ı   | 12     |     | μΑ/V |
|  |  | Higher driving capability      | _   | 18     |     |      |
|  |  | LXTALDRI[1:0] = 00             | _   | 0.7    |     |      |
| I <sub>DDLXTAL</sub> <sup>(1)</sup>    | Crystal or ceramic operating                             | LXTALDRI[1:0] = 01             |     | 0.8    |     |      |
| IDDLXTAL'''                            | current  | LXTALDRI[1:0] = 10             |     | 1.0    |     | μA   |
|  |  | LXTALDRI[1:0] = 11             | _   | 1.3    |     |      |
| t <sub>SULXTAL</sub> (1)(4)            | Crystal or ceramic startup time                          | _                              | _   | 1.8    |     | s    |

- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.
- (3)  $C_{LXTAL1} = C_{LXTAL2} = 2*(C_{LOAD} C_S)$ , For  $C_{LXTAL1}$  and  $C_{LXTAL2}$ , it is recommended matching capacitance on OSC32IN and OSC32OUT. For  $C_{LOAD}$ , it is crystal/ceramic load capacitance, provided by the crystal or ceramic manufacturer. For  $C_S$ , it is PCB and MCU pin stray capacitance.
- (4) t<sub>SULXTAL</sub> is the startup time measured from the moment it is enabled (by software) to the 32.768 kHz oscillator stabilization flags is SET. This value varies significantly with the crystal manufacturer.



Table 4-17. Low speed external user clock characteristics (LXTAL in bypass mode)

| Symbol                             | Parameter                    | Conditions              | Min                 | Тур    | Max                 | Unit |
|------------------------------------|------------------------------|-------------------------|---------------------|--------|---------------------|------|
| f., (1)                            | External clock source or     | V <sub>DD</sub> = 3.3 V |                     | 32.768 | 1000                | kHz  |
| f <sub>LXTAL_ext</sub> (1)         | oscillator frequency         | VDD - 3.3 V             |                     | 32.700 | 1000                | KIIZ |
| V <sub>LXTALH</sub> <sup>(2)</sup> | OSC32IN input pin high level |                         | 0.7 V <sub>DD</sub> |        | $V_{DD}$            |      |
| VLX IALH \ /                       | voltage                      | _   0.7 V               |                     |        | VUD                 | V    |
| V <sub>LXTALL</sub> <sup>(2)</sup> | OSC32IN input pin low level  |                         | Vss                 |        | 0.3 V <sub>DD</sub> | -    |
| VLXIALL\ /                         | voltage                      | _                       | VSS                 |        | 0.3 VDD             |      |
| t <sub>H/L(LXTAL)</sub> (2)        | OSC32IN high or low time     |                         | 450                 | -      | _                   |      |
| t <sub>R/F(LXTAL)</sub> (2)        | OSC32IN rise or fall time    |                         |                     |        | 50                  | ns   |
| C <sub>IN</sub> <sup>(2)</sup>     | OSC32IN input capacitance    | _                       | _                   | 5      | _                   | рF   |
| Ducy <sub>(LXTAL)</sub> (2)        | Duty cycle                   |                         | 30                  | 50     | 70                  | %    |

<sup>(1)</sup> Based on characterization, not tested in production.

### 4.8. Internal clock characteristics

Table 4-18. High speed internal clock (IRC8M) characteristics

| Symbol                               | Parameter  | Conditions  | Min  | Тур                         | Max  | Unit |
|--------------------------------------|--|---|------|-----------------------------|------|------|
| firc8M                               | High Speed Internal<br>Oscillator (IRC8M)<br>frequency                 | $V_{DD} = V_{DDA} = 3.3 \text{ V}$  | _    | 8                           |      | MHz  |
| ACC <sub>IRC8M</sub>                 | IRC8M oscillator   | $V_{DD} = V_{DDA} = 3.3 \text{ V},$ $T_A = -40 \text{ °C } \sim +85 \text{ °C}^{(1)}$ | _    | -0.51to-0.08 <sup>(1)</sup> |      | %    |
|                                      | Frequency accuracy, Factory-trimmed                                    | $V_{DD} = V_{DDA} = 3.3 \text{ V}, T_A =$ $25 ^{\circ}\text{C}$                       | -1.0 | _                           | +1.0 | %    |
|                                      | IRC8M oscillator Frequency accuracy, User trimming step <sup>(1)</sup> | _   | _    | 0.5                         |      | %    |
| Ducy <sub>IRC8M</sub> <sup>(2)</sup> | IRC8M oscillator duty cycle  | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V  | 45   | 50                          | 55   | %    |
| I <sub>DDAIRC8M</sub> <sup>(1)</sup> | IRC8M oscillator operating current                                     | $V_{DD} = V_{DDA} = 3.3 \text{ V},$ $f_{HCLK} = f_{HXTAL\_PLL} = 120$ $MHz$           |      | 66                          |      | μΑ   |
| tsuirc8M <sup>(1)</sup>              | IRC8M oscillator startup time  | $V_{DD} = V_{DDA} = 3.3 \text{ V},$ $f_{HCLK} = f_{HXTAL\_PLL} = 120$ $MHz$           | _    | 5                           | _    | μs   |

<sup>(1)</sup> Based on characterization, not tested in production.

<sup>(2)</sup> Guaranteed by design, not tested in production.

<sup>(2)</sup> Guaranteed by design, not tested in production.



Table 4-19. Low speed internal clock (IRC40K) characteristics

| Symbol                                | Parameter                           | Conditions   | Min | Тур | Max | Unit |
|---------------------------------------|-------------------------------------|--|-----|-----|-----|------|
| f <sub>IRC40K</sub> <sup>(1)</sup>    | Low Speed Internal oscillator       | $V_{DD} = V_{DDA} = 3.3 \text{ V},$                        |     | 40  |     | kHz  |
| TRC40K* /                             | (IRC40K) frequency                  | $T_A = -40  ^{\circ}\text{C}  \sim  +85  ^{\circ}\text{C}$ |     | 40  |     | KIIZ |
|                                       | IRC40K oscillator operating current | $V_{DD} = V_{DDA} = 3.3 \text{ V},$                        |     |     |     |      |
| I <sub>DDAIRC40K</sub> <sup>(2)</sup> |                                     | f <sub>HCLK</sub> = f <sub>HXTAL_PLL</sub> = 120 MHz       | _   | 0.4 | _   | μΑ   |
|                                       |                                     | T <sub>A</sub> = 25 °C                                     |     |     |     |      |
|                                       | IDC 401/ acaillatan atautuu         | $V_{DD} = V_{DDA} = 3.3 \text{ V},$                        |     |     |     |      |
| tsuirc40K <sup>(2)</sup>              | IRC40K oscillator startup<br>time   | f <sub>HCLK</sub> = f <sub>HXTAL_PLL</sub> = 120 MHz       | _   | 110 | _   | μs   |
|                                       |                                     | T <sub>A</sub> = 25 °C                                     |     |     |     |      |

- (1) Guaranteed by design, not tested in production.
- (2) Based on characterization, not tested in production.

Table 4-20. High speed internal clock (IRC48M) characteristics

| Symbol                                | Parameter                           | Conditions                                   | Min  | Тур                         | Max  | Unit |
|---------------------------------------|-------------------------------------|--|------|-----------------------------|------|------|
|                                       | High Speed Internal                 |  |      |                             |      |      |
| f <sub>IRC48M</sub>                   | Oscillator (IRC48M)                 | $V_{DD} = 3.3 \text{ V}$                     | _    | 48                          | _    | MHz  |
|                                       | frequency                           |  |      |                             |      |      |
|                                       | IRC48M oscillator                   | $V_{DD} = V_{DDA} = 3.3 \text{ V},$          |      | -1.42to+0.51 <sup>(1)</sup> |      | %    |
|                                       |                                     | $T_A = -40^{\circ}C \sim +85 {\circ}C^{(1)}$ |      | -1.421010.51                |      | 70   |
|                                       | Frequency accuracy, Factory-trimmed | $V_{DD} = V_{DDA} = 3.3 \text{ V},$          | -2.0 |                             | +2.0 | %    |
| ACCIRC48M                             | i actory-triinined                  | T <sub>A</sub> = 25 °C                       | -2.0 | _                           | +2.0 | 70   |
|                                       | IRC48M oscillator                   |  |      |                             |      |      |
|                                       | Frequency accuracy,                 | _  | _    | 0.12                        | _    | %    |
|                                       | User trimming step <sup>(1)</sup>   |  |      |                             |      |      |
| D <sub>IRC48M</sub> <sup>(2)</sup>    | IRC48M oscillator duty              | V <sub>DD</sub> = V <sub>DDA</sub> = 3.3 V   | 45   | 50                          | 55   | %    |
| DIRC48M\'                             | cycle                               | VDD - VDDA - 3.5 V                           | 40   | 50                          | 55   | /0   |
|                                       | IRC48M oscillator                   | $V_{DD} = V_{DDA} = 3.3 \text{ V},$          |      |                             |      |      |
| I <sub>DDAIRC48M</sub> <sup>(1)</sup> |                                     | f <sub>HCLK</sub> = f <sub>HXTAL_PLL</sub> = | _    | 356                         | _    | μΑ   |
|                                       | operating current                   | 120 MHz                                      |      |                             |      |      |
|                                       | IDC49M applicator of artists        | $V_{DD} = V_{DDA} = 3.3 \text{ V},$          |      |                             |      |      |
| t <sub>SUIRC48M</sub> <sup>(1)</sup>  | IRC48M oscillator startup           | f <sub>HCLK</sub> = f <sub>HXTAL_PLL</sub> = | _    | 2.7                         | _    | μs   |
|                                       | time                                | 120 MHz                                      |      |                             |      |      |

- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.



### 4.9. PLL characteristics

Table 4-21. PLL characteristics

| Symbol                                  | Parameter                               | Conditions         | Min      | Тур | Max | Unit |
|---|---|--------------------|----------|-----|-----|------|
| f <sub>PLLIN</sub> <sup>(1)</sup>       | PLL input clock frequency               |                    | 1        | _   | 25  | MHz  |
| f <sub>PLLOUT</sub> <sup>(2)</sup>      | PLL output clock frequency              |                    | 16       | _   | 120 | MHz  |
| f <sub>vco<sup>(2)</sup></sub>          | PLL VCO output clock frequency          | _                  | 32       | _   | 240 | MHz  |
| t <sub>LOCK</sub> (2)                   | PLL lock time                           | _                  |          | _   | 300 | μs   |
| I <sub>DDA</sub> <sup>(1)(3)</sup>      | Current consumption on $V_{\text{DDA}}$ | VCO freq = 240 MHz | 40 MHz — |     | _   | μA   |
| Jitter <sub>PLL</sub> <sup>(1)(4)</sup> | Cycle to cycle Jitter                   | System sleek       | _        | 35  | _   | 20   |
|   | Cycle to cycle Jitter  (peak to peak)   | System clock       |          | 371 | _   | ps   |

- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.
- (3) System clock = IRC8M = 8 MHz, PLL clock source = IRC8M/2 = 4 MHz, f<sub>PLLOUT</sub> = 120 MHz.
- (4) Value given with main PLL running.

Table 4-22. PLL1 characteristics

| Symbol                             | Parameter                                 | arameter Conditions |    | Тур | Max | Unit |
|------------------------------------|---|---------------------|----|-----|-----|------|
| f <sub>PLLIN</sub> <sup>(1)</sup>  | PLL input clock frequency                 | <del>-</del>        | 1  | _   | 25  | MHz  |
| f <sub>PLLOUT</sub> (2)            | PLL output clock frequency                |                     | 16 | _   | 120 | MHz  |
| f <sub>VCO</sub> <sup>(2)</sup>    | PLL VCO output clock frequency            | _                   | 32 | _   | 200 | MHz  |
| t <sub>LOCK</sub> (2)              | PLL lock time                             |                     |    | _   | 300 | μs   |
| I <sub>DDA</sub> <sup>(1)(3)</sup> | Current consumption on VCO freq = 200 MHz |                     |    | 520 |     | μΑ   |
| Jitter <sub>PLL</sub> (1)(4)       | Cycle to cycle Jitter                     | System clock        | _  | 371 | _   | ps   |

- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.
- (3) System clock = IRC8M = 8 MHz, PLL1 clock source = IRC48M = 48 MHz,  $f_{PLLOUT}$  = 120 MHz.
- (4) Value given with main PLL running.

Table 4-23. PLL2 characteristics

| Symbol                             | Parameter                               | Conditions         | Min | Тур | Max | Unit |
|------------------------------------|---|--------------------|-----|-----|-----|------|
| f <sub>PLLIN</sub> <sup>(1)</sup>  | PLL input clock frequency               |                    | 1   | _   | 25  | MHz  |
| f <sub>PLLOUT</sub> <sup>(2)</sup> | PLL output clock frequency              | I                  | 16  | _   | 120 | MHz  |
| fvco <sup>(2)</sup>                | PLL VCO output clock frequency          | _                  |     | _   | 200 | MHz  |
| t <sub>LOCK</sub> (2)              | PLL lock time                           |                    |     | _   | 300 | μs   |
| I <sub>DDA</sub> <sup>(1)(3)</sup> | Current consumption on $V_{\text{DDA}}$ | VCO freq = 200 MHz | _   | 520 | _   | μΑ   |
| Jitter <sub>PLL</sub> (1)(4)       | Cycle to cycle Jitter                   | System clock       | _   | 371 | _   | ps   |



- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.
- (3) System clock = IRC8M = 8 MHz, PLL2 clock source = IRC48M = 48 MHz, f<sub>PLLOUT</sub> = 120 MHz.
- (4) Value given with main PLL running.

# 4.10. Memory characteristics

Table 4-24. Flash memory characteristics(1)

| Symbol                    | Parameter                    | Conditions   | Min | Тур  | Max  | Unit    |
|---------------------------|------------------------------|--|-----|------|------|---------|
|                           | Number of guaranteed         |  |     |      |      | kcycle  |
| PEcyc                     | program /erase cycles before |  | 100 |      | _    | s       |
|                           | failure (Endurance)          | $T_A = -40 ^{\circ}\text{C} \sim +85 ^{\circ}\text{C}$ |     |      |      | 3       |
| <b>.</b>                  | Read time at code flash area |  | _   | 1    | _    | h allta |
| t <sub>READ</sub>         | Read time at data flash area |  |     |      | 4176 | hclks   |
| t <sub>RET</sub>          | Data retention time          |  |     | 20   |      | years   |
| t <sub>PROG</sub>         | Word programming time        | T <sub>A</sub> = -40 °C ~ +85 °C                       |     | 47.5 | 215  | μs      |
| t <sub>ERASE</sub>        | Page erase time              | T <sub>A</sub> = -40 °C ~ +85 °C                       | _   | 45   | 800  | ms      |
| t <sub>MERASE(256K)</sub> | Mass erase time              | T <sub>A</sub> = -40 °C ~ +85 °C                       |     | 2    | 24   | s       |
| t <sub>MERASE(512K)</sub> | Mass erase time              | T <sub>A</sub> = -40 °C ~ +85 °C                       | _   | 4    | 48   | S       |
| t <sub>MERASE(1MB)</sub>  | Mass erase time              | T <sub>A</sub> = -40 °C ~ +85 °C                       | _   | 6    | 72   | s       |

<sup>(1)</sup> Guaranteed by design and/or characterization, not 100% tested in production.

# 4.11. NRST pin characteristics

Table 4-25. NRST pin characteristics

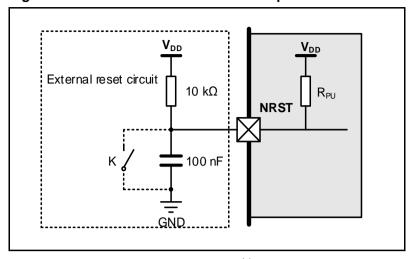
| Symbol                               | Parameter                          | Conditions                         | Min                 | Тур | Max                   | Unit |
|--------------------------------------|------------------------------------|------------------------------------|---------------------|-----|-----------------------|------|
| V <sub>IL(NRST)</sub> <sup>(1)</sup> | NRST Input low level voltage       |                                    | -0.3                |     | 0.3 V <sub>DD</sub>   | .,   |
| V <sub>IH(NRST)</sub> <sup>(1)</sup> | NRST Input high level voltage      | $V_{DD} = V_{DDA} = 2.6 \text{ V}$ | $0.7~V_{DD}$        |     | $V_{DD} + 0.3$        | V    |
| V <sub>hyst</sub> <sup>(1)</sup>     | Schmidt trigger Voltage hysteresis |                                    | _                   | 390 |                       | mV   |
| V <sub>IL(NRST)</sub> <sup>(1)</sup> | NRST Input low level voltage       |                                    | -0.3                |     | 0.3 V <sub>DD</sub>   | V    |
| V <sub>IH(NRST)</sub> <sup>(1)</sup> | NRST Input high level voltage      | $V_{DD} = V_{DDA} = 3.3 \text{ V}$ | 0.7 V <sub>DD</sub> | _   | $V_{DD} + 0.3$        | V    |
| V <sub>hyst</sub> <sup>(1)</sup>     | Schmidt trigger Voltage hysteresis |                                    | _                   | 410 |                       | mV   |
| V <sub>IL(NRST)</sub> <sup>(1)</sup> | NRST Input low level voltage       |                                    | -0.3                | _   | $0.3~V_{DD}$          | V    |
| V <sub>IH(NRST)</sub> <sup>(1)</sup> | NRST Input high level voltage      | $V_{DD} = V_{DDA} = 3.6 \text{ V}$ | 0.7 V <sub>DD</sub> | _   | V <sub>DD</sub> + 0.3 | V    |
| V <sub>hyst</sub> (1)                | Schmidt trigger Voltage hysteresis |                                    | _                   | 430 |                       | mV   |
| R <sub>pu</sub> <sup>(2)</sup>       | Pull-up equivalent resistor        | _                                  |                     | 40  | _                     | kΩ   |

<sup>(1)</sup> Based on characterization, not tested in production.

<sup>(2)</sup> Guaranteed by design, not tested in production.



Figure 4-4. Recommended external NRST pin circuit<sup>(1)</sup>



(1) Unless the voltage on NRST pin go below  $V_{IL(NRST)}$  level, the device would not generate a reliable reset.

## 4.12. GPIO characteristics

Table 4-26. I/O port DC characteristics(1)(3)

| Symbol                         | Paramet                         | er         | Conditions   | Min                 | Тур | Max                 | Unit |
|--------------------------------|---------------------------------|------------|--|---------------------|-----|---------------------|------|
| V                              | Standard IO Low<br>voltage      | -          | 2.6 V ≤ V <sub>DD</sub> = V <sub>DDA</sub> ≤ 3.6 V                   |                     |     | 0.3 V <sub>DD</sub> | V    |
| V <sub>IL</sub>                | 5V-tolerant IO L<br>input volta |            | $2.6 \text{ V} \le \text{V}_{DD} = \text{V}_{DDA} \le 3.6 \text{ V}$ |                     | _   | 0.3 V <sub>DD</sub> | V    |
| V                              | Standard IO Low<br>voltage      | -          | $2.6 \text{ V} \le \text{V}_{DD} = \text{V}_{DDA} \le 3.6 \text{ V}$ | 0.7 V <sub>DD</sub> | _   |                     | V    |
| ViH                            | 5V-tolerant IO L<br>input volta |            | 2.6 V ≤ V <sub>DD</sub> = V <sub>DDA</sub> ≤ 3.6 V                   | 0.7 V <sub>DD</sub> |     |                     | ٧    |
|                                | Low level outpu                 | ıt voltage | V <sub>DD</sub> = 2.6V   | _                   |     | 0.17                |      |
| V <sub>OL</sub>                | for an IO I                     | Pin        | V <sub>DD</sub> = 3.3 V  | _                   | 1   | 0.16                | V    |
|                                | $(I_{IO} = +8 \text{ mA})$      |            | V <sub>DD</sub> = 3.6V   | _                   |     | 0.15                |      |
|                                | Low level outpu                 | ıt voltage | V <sub>DD</sub> = 2.6V   | _                   | _   | 0.49                |      |
| V <sub>OL</sub>                | for an IO Pin                   |            | V <sub>DD</sub> = 3.3 V  | _                   |     | 0.4                 | V    |
|                                | (I <sub>IO</sub> = +20 ı        | mA)        | V <sub>DD</sub> = 3.6V   | _                   | _   | 0.34                |      |
|                                | High level outpu                | ıt voltage | V <sub>DD</sub> = 2.6V   | 2.4                 | 1   |                     |      |
| Voн                            | for an IO I                     | Pin        | V <sub>DD</sub> = 3.3 V  | 3.15                | 1   | 1                   | V    |
|                                | (I <sub>IO</sub> = +8 n         | nA)        | V <sub>DD</sub> = 3.6V   | 3.44                | 1   |                     |      |
|                                | High level outpu                | ıt voltage | V <sub>DD</sub> = 2.6V   | 2.02                | 1   |                     |      |
| Voн                            | for an IO I                     | Pin        | V <sub>DD</sub> = 3.3 V  | 2.8                 |     |                     | V    |
|                                | (I <sub>IO</sub> = +20 ı        | mA)        | V <sub>DD</sub> = 3.6V   | 3.15                |     |                     |      |
| R <sub>PU</sub> <sup>(2)</sup> | Internal pull-up                | All pins   | $V_{IN} = V_{SS}$  | 30                  | 40  | 50                  | kΩ   |
| IXPU\ /                        | resistor                        | PA10       |  | 7.5                 | 10  | 13.5                | L/77 |
| R <sub>PD</sub> <sup>(2)</sup> | Internal pull-                  | All pins   | $V_{IN} = V_{DD}$  | 30                  | 40  | 50                  | kΩ   |
| INPU                           | down resistor                   | PA10       |  | 7.5                 | 10  | 13.5                | L/77 |



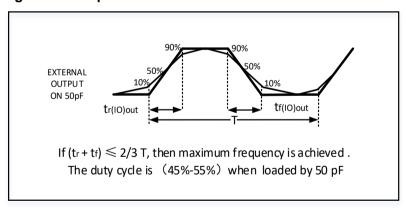
- (1) Based on characterization, not tested in production.
- (2) Guaranteed by design, not tested in production.
- (3) All pins except PC13 / PC14 / PC15. Since PC13 to PC15 are supplied through the Power Switch, which can only be obtained by a small current, the speed of GPIOs PC13 to PC15 should not exceed 2 MHz when they are in output mode (maximum load: 30 pF).

Table 4-27. I/O port AC characteristics(1)(2)

| GPIOx_MDy[1:0] bit value <sup>(3)</sup>   | Parameter                           | Conditions   | Max | Unit |
|---|-------------------------------------|--|-----|------|
| CDION CTL MDV[4:0] 40                     | Massimos                            | $2.6 \le V_{DD} \le 3.6 \text{ V, } C_L = 10 \text{ pF}$ | 15  |      |
| GPIOx_CTL->MDy[1:0]=10  (IO Speed = 2MHz) | Maximum<br>frequency <sup>(4)</sup> | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 30 \text{ pF}$  | 10  | MHz  |
| (IO_Speed = ZMHZ)                         | rrequericy. 7                       | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 50 \text{ pF}$  | 8   |      |
| CDIOV CTI - MDVIA-01 - 04                 | Maximum                             | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 10 \text{ pF}$  | 50  |      |
| GPIOx_CTL->MDy[1:0] = 01                  | Maximum<br>frequency <sup>(4)</sup> | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 30 \text{ pF}$  | 25  | MHz  |
| (IO_Speed = 10MHz)                        | irequency. 9                        | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 50 \text{ pF}$  | 15  |      |
| GPIOx CTL->MDy[1:0]=11                    | Maximum                             | $2.6 \le V_{DD} \le 3.6 \text{ V, } C_L = 10 \text{ pF}$ | 100 |      |
| (IO Speed = 50MHz)                        | frequency <sup>(4)</sup>            | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 30 \text{ pF}$  | 70  | MHz  |
| (10_Speed = 30M112)                       | rrequericy                          | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 50 \text{ pF}$  | 50  |      |
| GPIOx_CTL->MDy[1:0]=11 and                | Mayimum                             | $2.6 \le V_{DD} \le 3.6 \text{ V, } C_L = 10 \text{ pF}$ | 120 |      |
| GPIOx_SPDy=1                              | Maximum<br>frequency <sup>(4)</sup> | $2.6 \le V_{DD} \le 3.6 \text{ V, } C_L = 30 \text{ pF}$ | 100 | MHz  |
| (IO_Speed = MAX)                          | nequency.                           | $2.6 \le V_{DD} \le 3.6 \text{ V}, C_L = 50 \text{ pF}$  | 60  |      |

- (1) Based on characterization, not tested in production.
- (2) Unless otherwise specified, all test results given for  $T_A = 25$  °C.
- (3) The I/O speed is configured using the GPIOx\_CTL -> MDy[1:0] bits. Refer to the GD32F 30x user manual which is selected to set the GPIO port output speed.
- (4) The maximum frequency is defined in Figure 4-5, and maximum frequency cannot exceed 120 MHz.

Figure 4-5. I/O port AC characteristics definition



# 4.13. Temperature sensor characteristics

Table 4-28. Temperature sensor characteristics<sup>(1)</sup>

| Symbol          | Parameter                                      | Min | Тур  | Max | Unit  |
|-----------------|--|-----|------|-----|-------|
| $T_L$           | VSENSE linearity with temperature              | _   | ±1.5 | _   | °C    |
| Avg_Slope       | Average slope                                  | _   | 4.1  | _   | mV/°C |
| V <sub>25</sub> | Voltage at 25 °C                               | _   | 1.45 | _   | V     |
| ts_temp (2)     | ADC sampling time when reading the temperature | _   | 17.1 | _   | μs    |



- (1) Based on characterization, not tested in production.
- (2) Shortest sampling time can be determined in the application by multiple iterations.

## 4.14. ADC characteristics

Table 4-29. ADC characteristics

| Symbol                           | Parameter                        | Conditions                      | Min    | Тур              | Max              | Unit             |
|----------------------------------|----------------------------------|---------------------------------|--------|------------------|------------------|------------------|
| V <sub>DDA</sub> <sup>(1)</sup>  | Operating voltage                | _                               | 2.6    | 3.3              | 3.6              | V                |
| V <sub>IN</sub> <sup>(1)</sup>   | ADC input voltage range          | _                               | 0      |                  | $V_{REFP}$       | V                |
| V <sub>REFP</sub> <sup>(2)</sup> | Positive Reference Voltage       | <del>-</del>                    | 2.6    | _                | $V_{DDA}$        | V                |
| V <sub>REFN</sub> <sup>(2)</sup> | Negative Reference<br>Voltage    | -                               | _      | V <sub>SSA</sub> |                  | V                |
| f <sub>ADC</sub> <sup>(1)</sup>  | ADC clock                        | _                               | 0.1    |                  | 40               | MHz              |
|                                  |                                  | 12-bit                          | 0.007  | _                | 2.86             |                  |
| fs <sup>(1)</sup>                | Camanlin a mata                  | 10-bit                          | 0.008  | _                | 3.33             | MSP              |
| IS( )                            | Sampling rate                    | 8-bit                           | 0.01   | _                | 4                | S                |
|                                  |                                  | 6-bit                           | 0.012  | _                | 5                |                  |
| V <sub>AIN</sub> <sup>(1)</sup>  | Analog input voltage             | 16 external; 2 internal         | 0      | _                | $V_{\text{DDA}}$ | V                |
| R <sub>AIN</sub> <sup>(2)</sup>  | External input impedance         | See <u>Equation 1</u>           | _      | _                | 32.9             | kΩ               |
| R <sub>ADC</sub> <sup>(2)</sup>  | Input sampling switch resistance | _                               | _      |                  | 0.55             | kΩ               |
| C <sub>ADC</sub> <sup>(2)</sup>  | Input sampling capacitance       | No pin/pad capacitance included | _      |                  | 5.5              | pF               |
| t <sub>CAL</sub> <sup>(2)</sup>  | Calibration time                 | $f_{ADC} = 40 \text{ MHz}$      |        | 3.275            |                  | μs               |
| t <sub>s</sub> (2)               | Sampling time                    | f <sub>ADC</sub> = 40 MHz       | 0.0375 | _                | 5.99             | μs               |
|                                  | Tatal                            | 12-bit                          |        | 14               |                  |                  |
| t <sub>CONV</sub> <sup>(2)</sup> | Total conversion                 | 10-bit                          |        | 12               | _                | 1/               |
| (CONV)                           | time(including sampling          | 8-bit                           | _      | 10               | _                | f <sub>ADC</sub> |
|                                  | time)                            | 6-bit                           | _      | 8                | _                |                  |
| t <sub>SU</sub> <sup>(2)</sup>   | Startup time                     |                                 |        | _                | 1                | μS               |

<sup>(1)</sup> Based on characterization, not tested in production.

$$\textit{Equation 1:} \; \mathsf{R}_{\mathsf{AIN}} \; \mathsf{max} \; \mathsf{formula} \; R_{\mathsf{AIN}} < \frac{\mathsf{T_S}}{\mathsf{f}_{\mathsf{ADC}^*}\mathsf{C}_{\mathsf{ADC}^*}\mathsf{ln} \; (2^{\mathsf{N}+2})} - R_{\mathsf{ADC}}$$

The formula above (Equation 1) is used to determine the maximum external impedance allowed for an error below 1/4 of LSB. Here N = 12 (from 12-bit resolution).

Table 4-30. ADC  $R_{AIN max}$  for  $f_{ADC} = 40 MHz$ 

| T <sub>s</sub> (cycles) | t <sub>s</sub> (μs) <sup>(1)</sup> | R <sub>AIN max</sub> (kΩ) |
|-------------------------|------------------------------------|---------------------------|
| 1.5                     | 0.0375                             | 0.15                      |
| 7.5                     | 0.1875                             | 2.96                      |
| 13.5                    | 0.3375                             | 5.77                      |
| 28.5                    | 0.7125                             | 12.8                      |
| 41.5                    | 1.0375                             | 18.9                      |

<sup>(2)</sup> Guaranteed by design, not tested in production.



| T <sub>s</sub> (cycles) | t <sub>s</sub> (μs) <sup>(1)</sup> | R <sub>AIN max</sub> (kΩ) |
|-------------------------|------------------------------------|---------------------------|
| 55.5                    | 1.3875                             | 25.4                      |
| 71.5                    | 1.7875                             | 32.9                      |
| 239.5                   | 5.9875                             | N/A                       |

<sup>(1)</sup> For channels of internal temperature sensor (V<sub>SENSE</sub>) and internal reference voltage (V<sub>REFINT</sub>), sampling time not less than 17.1us will be recommended.

Table 4-31. ADC dynamic accuracy at  $f_{ADC} = 14 \text{ MHz}^{(1)}$ 

| Symbol | Parameter Test conditions            |                                      | Min | Тур   | Max | Unit |
|--------|--------------------------------------|--------------------------------------|-----|-------|-----|------|
| ENOB   | Effective number of bits             | f <sub>ADC</sub> = 14 MHz            | _   | 10.8  |     | bits |
| SNDR   | Signal-to-noise and distortion ratio | $V_{DDA} = V_{REFP} = 3.3 \text{ V}$ | _   | 66.7  | _   |      |
| SNR    | Signal-to-noise ratio                | Input Frequency = 20 kHz             | _   | 67.4  |     | dB   |
| THD    | Total harmonic distortion            | Temperature = 25 °C                  | _   | -76.3 | _   |      |

<sup>(1)</sup> Based on characterization, not tested in production.

Table 4-32. ADC dynamic accuracy at  $f_{ADC} = 40 \text{ MHz}^{(1)}$ 

| Symbol | Parameter                            | Parameter Test conditions            |   | Тур   | Max | Unit |
|--------|--------------------------------------|--------------------------------------|---|-------|-----|------|
| ENOB   | Effective number of bits             | f <sub>ADC</sub> = 40 MHz            | _ | 10    |     | bits |
| SNDR   | Signal-to-noise and distortion ratio | $V_{DDA} = V_{REFP} = 3.3 \text{ V}$ | _ | 62    | _   |      |
| SNR    | Signal-to-noise ratio                | Input Frequency = 20 kHz             | _ | 62.2  |     | dB   |
| THD    | Total harmonic distortion            | Temperature = 25 ℃                   | _ | -68.6 | _   |      |

<sup>(1)</sup> Based on characterization, not tested in production.

Table 4-33. ADC static accuracy at  $f_{ADC} = 14 \text{ MHz}^{(1)}$ 

| Symbol | Parameter                    | Test conditions                      | Тур | Max | Unit |
|--------|------------------------------|--------------------------------------|-----|-----|------|
| Offset | Offset error                 | f - 14 MH-                           | ±1  |     |      |
| DNL    | Differential linearity error | f <sub>ADC</sub> = 14 MHz            |     | _   | LSB  |
| INL    | Integral linearity error     | $V_{DDA} = V_{REFP} = 3.3 \text{ V}$ | ±1  | _   |      |

<sup>(1)</sup> Based on characterization, not tested in production.

#### 4.15. DAC characteristics

Table 4-34. DAC characteristics

| Symbol                           | Parameter             | Conditions                      | Min | Тур              | Max       | Unit |
|----------------------------------|-----------------------|---------------------------------|-----|------------------|-----------|------|
| $V_{DDA}^{(1)}$                  | Operating voltage     | _                               | 2.6 | 3.3              | 3.6       | V    |
| V <sub>REFP</sub> (2)            | Positive Reference    |                                 | 2.6 |                  | \/·       | V    |
| VREFP <sup>(2)</sup>             | Voltage               | _                               | 2.0 | _                | $V_{DDA}$ | V    |
| V <sub>REFN</sub> (2)            | Negative Reference    |                                 |     | V                |           | V    |
| VREFN <sup>(2)</sup>             | Voltage               | _                               |     | V <sub>SSA</sub> |           | V    |
| R <sub>LOAD</sub> (2)            | Load resistance       | Resistive load with             | 5   |                  |           | kΩ   |
| T LOAD ( /                       | Load Tesistance       | buffer ON                       | 3   |                  |           | K12  |
| Ro <sup>(2)</sup>                | Impedance output with |                                 |     |                  | 15        | kΩ   |
| No. 7                            | buffer OFF            | _                               |     |                  | 15        | K12  |
| C <sub>LOAD</sub> <sup>(2)</sup> | Load capacitance      | No pin/pad capacitance included |     | _                | 50        | pF   |
| DAC_OUT                          | Lower DAC_OUT voltage | _                               | 0.2 | _                | _         | >    |



| Symbol                              | Parameter                  | Conditions  | Min | Тур | Max                | Unit |
|-------------------------------------|----------------------------|---|-----|-----|--------------------|------|
| min <sup>(2)</sup>                  | with buffer ON             |   |     |     |                    |      |
| DAC_OUT                             | Higher DAC_OUT voltage     |   |     |     | V <sub>DDA</sub> - | V    |
| max <sup>(2)</sup>                  | with buffer ON             | _   |     |     | 0.2                | V    |
| DAC_OUT                             | Lower DAC_OUT voltage      |   |     | 0.5 |                    | mV   |
| min <sup>(2)</sup>                  | with buffer OFF            | _   |     | 0.5 |                    | IIIV |
| DAC_OUT                             | Higher DAC_OUT voltage     |   |     |     | V <sub>DDA</sub> - | V    |
| max <sup>(2)</sup>                  | with buffer OFF            | _   |     |     | 1LSB               | V    |
|                                     |                            | With no load, middle code(0x800)  |     | 470 |                    | uA   |
| I <sub>DDA</sub> <sup>(1)</sup>     | DAC current consumption    | on the input, $V_{REFP} = 3.6 \text{ V}$                                  |     | 470 |                    | uA   |
| IDDA'                               | in quiescent mode          | With no load, worst code(0xF1C)   |     | 500 |                    | uA   |
|                                     |                            | on the input, $V_{REFP} = 3.6 \text{ V}$                                  |     | 300 |                    | uA   |
|                                     |                            | With no load, middle code(0x800)  |     | 06  |                    |      |
| I <sub>DDVREFP</sub> (1)            | DAC current consumption    | on the input, $V_{REFP} = 3.6 \text{ V}$                                  |     | 86  |                    | uA   |
| IDDVKEFP( /                         | in quiescent mode          | With no load, worst code(0xF1C)   |     | 298 |                    | uA   |
|                                     |                            | on the input, $V_{REFP} = 3.6 \text{ V}$                                  |     | 290 |                    | uA   |
| DNL <sup>(1)</sup>                  | Differential non-linearity | DAC in 12 hit made  |     |     | ±5                 | LSB  |
| DINE                                | error                      | DAC in 12-bit mode —  |     |     |                    | LOD  |
| INL <sup>(1)</sup>                  | Integral non-linearity     | DAC in 12-bit mode  | _   | _   | ±4                 | LSB  |
| Offset <sup>(1)</sup>               | Offset error               | DAC in 12-bit mode  | _   | _   | ±12                | LSB  |
| GE <sup>(1)</sup>                   | Gain error                 | DAC in 12-bit mode  | _   | _   | ±0.5               | %    |
| T <sub>setting</sub> <sup>(1)</sup> | Settling time              | $C_{LOAD} \leqslant~50$ pF, $R_{LOAD} \geqslant~5$ k $\Omega$             | _   | 0.3 | 1                  | μs   |
| T <sub>wakeup</sub> (2)             | Wakeup from off state      | _   | _   | 5   | 10                 | μs   |
|                                     | Max frequency for a        |   |     |     |                    |      |
| Update                              | correct DAC_OUT            | C < 50 pF D > 5 kO  |     |     | 4                  | MC/o |
| rate <sup>(2)</sup>                 | change from code i to      | $C_{LOAD} \leqslant 50 \text{ pF, } R_{LOAD} \geqslant 5 \text{ k}\Omega$ | _   | _   | 4                  | MS/s |
|                                     | i±1LSBs                    |   |     |     |                    |      |
|                                     | Power supply rejection     |   |     |     |                    |      |
| PSRR <sup>(2)</sup>                 | ratio                      | _   | 55  | 80  | _                  | dB   |
|                                     | (to V <sub>DDA</sub> )     |   |     |     |                    |      |

<sup>(1)</sup> Based on characterization, not tested in production.

# 4.16. I2C characteristics

Table 4-35. I2C characteristics(1)(2)

| Symbol Parameter Conditions mode F |                     | Fast | mode | Fast r |     | Unit |     |     |    |
|------------------------------------|---------------------|------|------|--------|-----|------|-----|-----|----|
|                                    |                     |      | Min  | Max    | Min | Max  | Min | Max |    |
| t <sub>SCL(H)</sub>                | SCL clock high time | ı    | 4.0  |        | 0.6 |      | 0.2 | ı   | μs |
| t <sub>SCL(L)</sub>                | SCL clock low time  |      | 4.7  | _      | 1.3 | _    | 0.5 | _   | μs |
| tsu(sda)                           | SDA setup time      |      | 250  | _      | 100 | _    | 50  | _   | ns |

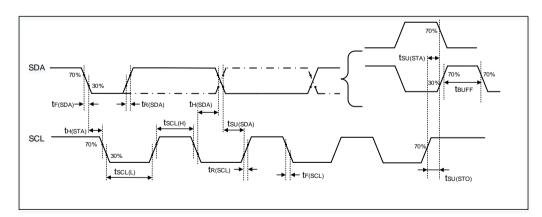
<sup>(2)</sup> Guaranteed by design, not tested in production.



| Symbol                   | Parameter                                     | Conditions | Standard Fast mode |      | mode | Fast r |      | Unit |    |
|--------------------------|---|------------|--------------------|------|------|--------|------|------|----|
|                          |   |            | Min                | Max  | Min  | Max    | Min  | Max  |    |
|                          |   | _          |                    |      |      |        |      |      |    |
| t <sub>H(SDA)</sub>      | SDA data hold time                            | _          | 0(3)               | 3450 | 0    | 900    | 0    | 450  | ns |
| t <sub>R</sub> (SDA/SCL) | SDA and SCL rise time                         |            |                    | 1000 | l    | 300    |      | 120  | ns |
| t <sub>F</sub> (SDA/SCL) | SDA and SCL fall time                         |            |                    | 300  |      | 300    |      | 120  | ns |
| t <sub>H(STA)</sub>      | Start condition hold time                     |            | 4.0                | _    | 0.6  |        | 0.26 | ı    | μs |
| t <sub>SU(STA)</sub>     | Repeated Start<br>condition<br>setup time     |            | 4.7                | _    | 0.6  | -      | 0.26 |      | μs |
| t <sub>SU(STO)</sub>     | Stop condition setup time                     | _          | 4.0                | _    | 0.6  | 1      | 0.26 |      | μs |
| t <sub>BUFF</sub>        | Stop to Start<br>condition time (bus<br>free) | _          | 4.7                | _    | 1.3  | _      | 0.5  | _    | μs |

- (1) Guaranteed by design, not tested in production.
- (2) To ensure the standard mode I2C frequency, f<sub>PCLK1</sub> must be at least 2 MHz. To ensure the fast mode I2C frequency, f<sub>PCLK1</sub> must be at least 4 MHz. To ensure the fast mode plus I2C frequency, f<sub>PCLK1</sub> must be at least a multiple of 10 MHz.
- (3) The device should provide a data hold time of 300 ns at least in order to bridge the undefined region of the falling edge of SCL.

Figure 4-6. I2C bus timing diagram



#### 4.17. SPI characteristics

Table 4-36. Standard SPI characteristics(1)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------|-----------|------------|-----|-----|-----|------|



| fsck                 | SCK clock frequency      | _   | _     | _     | 30    | MHz |  |  |  |
|----------------------|--------------------------|---|-------|-------|-------|-----|--|--|--|
| t <sub>SCK(H)</sub>  | SCK clock high time      | Master mode, f <sub>PCLKx</sub> = 120 MHz,<br>presc = 8 | 31.83 | 33.33 | 34.83 | ns  |  |  |  |
| t <sub>SCK(L)</sub>  | SCK clock low time       | Master mode, f <sub>PCLKx</sub> = 120 MHz,<br>presc = 8 | 31.83 | 33.33 | 34.83 | ns  |  |  |  |
| SPI master mode      |                          |   |       |       |       |     |  |  |  |
| t <sub>V(MO)</sub>   | Data output valid time   | _   | _     | 5     | 6     | ns  |  |  |  |
| t <sub>H(MO)</sub>   | Data output hold time    | _   | 3     |       |       | ns  |  |  |  |
| t <sub>SU(MI)</sub>  | Data input setup time    | _   | 1     |       |       | ns  |  |  |  |
| t <sub>H(MI)</sub>   | Data input hold time     | _   | 0     | _     | _     | ns  |  |  |  |
| SPI slave mode       |                          |   |       |       |       |     |  |  |  |
| t <sub>SU(NSS)</sub> | NSS enable setup time    | _   | 0     |       |       | ns  |  |  |  |
| t <sub>H(NSS)</sub>  | NSS enable hold time     | _   | 1     | 1     | 1     | ns  |  |  |  |
| t <sub>A(SO)</sub>   | Data output access time  | _   | 5     | _     | 9     | ns  |  |  |  |
| t <sub>DIS(SO)</sub> | Data output disable time | _   | 6     | -     | 10    | ns  |  |  |  |
| t <sub>V(SO)</sub>   | Data output valid time   | <u> </u>  | _     | 10    | 12    | ns  |  |  |  |
| t <sub>H(SO)</sub>   | Data output hold time    |   | 8     | _     | _     | ns  |  |  |  |
| t <sub>SU(SI)</sub>  | Data input setup time    | _   | 0     | _     | _     | ns  |  |  |  |
| t <sub>H(SI)</sub>   | Data input hold time     | _   | 1     | _     | _     | ns  |  |  |  |

<sup>(1)</sup> Based on characterization, not tested in production.

Figure 4-7. SPI timing diagram - master mode

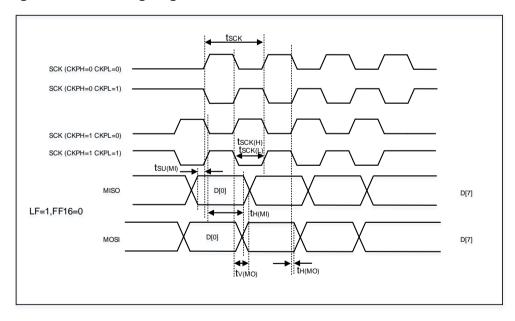
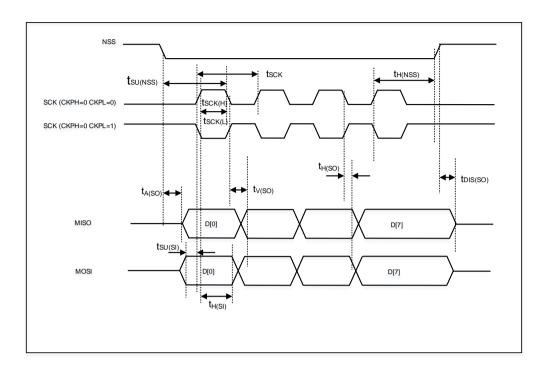




Figure 4-8. SPI timing diagram - slave mode





## 4.18. I2S characteristics

Table 4-37. I2S characteristics(1)(2)

| Symbol                 | Parameter                  | Conditions                  | Min   | Тур   | Max   | Unit |
|------------------------|----------------------------|-----------------------------|-------|-------|-------|------|
|                        |                            | Master mode (data: 16 bits, | 3.075 | 3.077 | 3.079 |      |
| fcĸ                    | Clock frequency            | Audio frequency = 96 kHz)   | 3.073 | 3.011 | 3.079 | MHz  |
|                        |                            | Slave mode                  | 0     | _     | 10    |      |
| t <sub>H</sub>         | Clock high time            |                             | 162   | _     | _     | ns   |
| t∟                     | Clock low time             | _                           | 163   | _     | _     | ns   |
| t <sub>V(WS)</sub>     | WS valid time              | Master mode                 | 0     | _     | _     | ns   |
| t <sub>H(WS)</sub>     | WS hold time               | Master mode                 | 0     | _     | _     | ns   |
| t <sub>SU(WS)</sub>    | WS setup time              | Slave mode                  | 0     | _     | _     | ns   |
| t <sub>H(WS)</sub>     | WS hold time               | Slave mode                  | 2     | _     | _     | ns   |
| December               | I2S slave input clock duty | 01                          |       | 50    |       | 0/   |
| Ducy <sub>(SCK)</sub>  | cycle                      | Slave mode                  | _     | 50    | _     | %    |
| tsu(sd_mr)             | Data input setup time      | Master mode                 | 1     | _     | _     | ns   |
| t <sub>su(SD_SR)</sub> | Data input setup time      | Slave mode                  | 0     | _     | _     | ns   |
| t <sub>H(SD_MR)</sub>  | Data in puth and time      | Master receiver             | 0     | _     | _     | ns   |
| t <sub>H(SD_SR)</sub>  | Data input hold time       | Slave receiver              | 1     | _     | _     | ns   |
| ,                      | Data autoutualidikaa       | Slave transmitter           |       |       | 40    |      |
| t <sub>V(SD_ST)</sub>  | Data output valid time     | (after enable edge)         | _     |       | 12    | ns   |
| 4                      | Data autout hald time      | Slave transmitter           | 7     |       |       | 20   |
| t <sub>H(SD_ST)</sub>  | Data output hold time      | (after enable edge)         | /     |       | _     | ns   |
|                        | Data autout valid tima     | Master transmitter          |       |       |       |      |
| t∨(SD_MT)              | Data output valid time     | (after enable edge)         |       |       | 6     | ns   |
| 4                      | Data autout hald times     | Master transmitter          | 2     |       |       | 20   |
| th(SD_MT)              | Data output hold time      | (after enable edge)         | 2     |       |       | ns   |

<sup>(1)</sup> Guaranteed by design, not tested in production.

<sup>(2)</sup> Based on characterization, not tested in production



Figure 4-9. I2S timing diagram - master mode

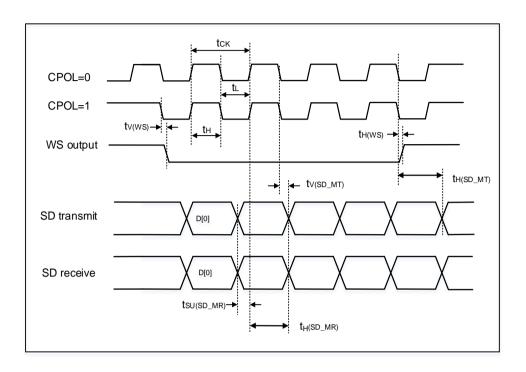
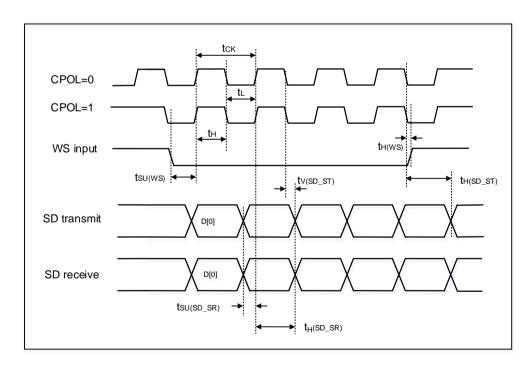


Figure 4-10. I2S timing diagram - slave mode





### 4.19. USART characteristics

Table 4-38. USART characteristics(1)

| Symbol              | Parameter           | Conditions                   | Min | Тур | Max | Unit |
|---------------------|---------------------|------------------------------|-----|-----|-----|------|
| f <sub>SCK</sub>    | SCK clock frequency | f <sub>PCLKx</sub> = 120 MHz | _   |     | 60  | MHz  |
| t <sub>SCK(H)</sub> | SCK clock high time | f <sub>PCLKx</sub> = 120 MHz | 7.5 | _   | _   | ns   |
| t <sub>SCK(L)</sub> | SCK clock low time  | f <sub>PCLKx</sub> = 120 MHz | 7.5 | _   | _   | ns   |

<sup>(1)</sup> Guaranteed by design, not tested in production.

#### 4.20. CAN characteristics

Refer to <u>Table 4-26. I/O port DC characteristics</u>(1) for more details on the input/output alternate function characteristics (CANTX and CANRX).

#### 4.21. USBFS characteristics

Table 4-39. USBFS start up time

| Symbol                   | Parameter          | Max | Unit |
|--------------------------|--------------------|-----|------|
| t <sub>STARTUP</sub> (1) | USBFS startup time | 1   | μs   |

<sup>(1)</sup> Guaranteed by design, not tested in production.

Table 4-40. USBFS DC electrical characteristics

| Symb                          | ol              | Parameter                          | Conditions                             | Min  | Тур    | Max  | Unit |
|-------------------------------|-----------------|------------------------------------|--|------|--------|------|------|
|                               | $V_{\text{DD}}$ | USBFS operating voltage            |  | 3    | _      | 3.6  |      |
|                               | $V_{DI}$        | Differential input sensitivity     | _                                      | 0.2  | _      | _    |      |
| Input levels <sup>(1)</sup>   | V <sub>CM</sub> | Differential common mode           | Includes V <sub>DI</sub> range         | 0.8  | _      | 2.5  | V    |
| ieveis                        |                 | range                              |  |      |        |      |      |
| Vs                            | Vse             | Single ended receiver<br>threshold | _                                      | 1.3  | _      | 2.0  |      |
| Output                        | Vol             | Static output level low            | $R_L of  1.0 \; k\Omega$ to $3.6 \; V$ | _    | 0.064  | 0.3  | V    |
| levels (2)                    | VoH             | Static output level high           | $R_L$ of 15 k $\Omega$ to VSS          | 2.8  | 3.3    | 3.6  | V    |
| R <sub>PD</sub> <sup>(2</sup> | 2)              | PA11, PA12(USB_DM/DP)              | \/ = \/                                | 17   | 20.574 | 24   |      |
| KPD\-                         | ,               | PA9(USB_VBUS)                      | $V_{IN} = V_{DD}$                      | 0.65 | _      | 2.0  | kΩ   |
| R <sub>PU</sub> <sup>(2</sup> | 2)              | PA11, PA12(USB_DM/DP)              | V <sub>IN</sub> = V <sub>SS</sub>      | 1.5  | 1.585  | 2.1  | K12  |
| KPU*                          | ,               | PA9(USB_VBUS)                      | VIIN - VSS                             | 0.25 | 0.326  | 0.55 |      |

<sup>(1)</sup> Guaranteed by design, not tested in production.

Table 4-41. USBFS full speed-electrical characteristics(1)

| Symbol           | Parameter               | Conditions                      | Min | Тур | Max | Unit |
|------------------|-------------------------|---------------------------------|-----|-----|-----|------|
| t <sub>R</sub>   | Rise time               | CL= 50 pF                       | 4   | _   | 20  | ns   |
| t <sub>F</sub>   | Fall time               | CL= 50 pF                       | 4   | _   | 20  | ns   |
| t <sub>RFM</sub> | Rise/fall time matching | t <sub>R</sub> / t <sub>F</sub> | 90  | _   | 110 | %    |

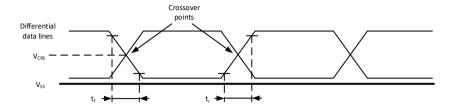
<sup>(2)</sup> Based on characterization, not tested in production.



| v <sub>CRS</sub> Output signal crossover voltage | _ | 1.3 | _ | 2.0 | V | Ì |
|--|---|-----|---|-----|---|---|
|--|---|-----|---|-----|---|---|

<sup>(1)</sup> Guaranteed by design, not tested in production.

Figure 4-11. USBFS timings: definition of data signal rise and fall time



### 4.22. EXMC characteristics

Table 4-42. Asynchronous non-multiplexed SRAM/PSRAM/NOR read timings(1)(2)(3)

| Symbol                    | Parameter                               | Min  | Max  | Unit |
|---------------------------|---|------|------|------|
| t <sub>w(NE)</sub>        | EXMC_NE low time                        | 40.5 | 42.5 | ns   |
| t <sub>V(NOE_NE)</sub>    | EXMC_NEx low to EXMC_NOE low            | 0    |      | ns   |
| t <sub>w(NOE)</sub>       | EXMC_NOE low time                       | 40.5 | 42.5 | ns   |
| t <sub>h(NE_NOE)</sub>    | EXMC_NOE high to EXMC_NE high hold time | 0    |      | ns   |
| t <sub>v(A_NE)</sub>      | EXMC_NEx low to EXMC_A valid            | 0    | _    | ns   |
| t <sub>v(BL_NE)</sub>     | EXMC_NEx low to EXMC_BL valid           | 0    | 1    | ns   |
| t <sub>su(DATA_NE)</sub>  | Data to EXMC_NEx high setup time        | 32.2 | 1    | ns   |
| t <sub>su(DATA_NOE)</sub> | Data to EXMC_NOEx high setup time       | 32.2 | 1    | ns   |
| t <sub>h(DATA_NOE)</sub>  | Data hold time after EXMC_NOE high      | 0    | 1    | ns   |
| t <sub>h(DATA_NE)</sub>   | Data hold time after EXMC_NEx high      | 0    |      | ns   |
| t <sub>v(NADV_NE)</sub>   | EXMC_NEx low to EXMC_NADV low           | 0    | _    | ns   |
| t <sub>w(NADV)</sub>      | EXMC_NADV low time                      | 7.3  | 9.3  | ns   |

<sup>(1)</sup>  $C_L = 30 pF$ .

Table 4-43. Asynchronous non-multiplexed SRAM/PSRAM/NOR write timings (1)(2)(3)

| Symbol                  | Parameter  | Min  | Max  | Unit |
|-------------------------|--|------|------|------|
| t <sub>w(NE)</sub>      | EXMC_NE low time                                       | 23.9 | 25.9 | ns   |
| t <sub>V(NWE_NE)</sub>  | EXMC_NEx low to EXMC_NWE low                           | 7.3  | 1    | ns   |
| t <sub>w(NWE)</sub>     | EXMC_NWE low time                                      | 7.3  | 9.3  | ns   |
| t <sub>h(NE_NWE)</sub>  | EXMC_NWE high to EXMC_NE high hold time                | 7.3  | 9.3  | ns   |
| t <sub>v(A_NE)</sub>    | EXMC_NEx low to EXMC_A valid                           | 0    |      | ns   |
| t <sub>V(NADV_NE)</sub> | EXMC_NEx low to EXMC_NADV low                          | 0    |      | ns   |
| t <sub>w(NADV)</sub>    | EXMC_NADV low time                                     | 7.3  | 9.3  | ns   |
| t <sub>h(AD_NADV)</sub> | EXMC_AD(address) valid hold time after  EXMC_NADV high | 15.6 |      | ns   |
| t <sub>h(A_NWE)</sub>   | Address hold time after EXMC_NWE high                  | 7.3  | _    | ns   |
| t <sub>h(BL_NWE)</sub>  | EXMC_BL hold time after EXMC_NWE high                  | 7.3  | _    | ns   |

<sup>(2)</sup> Guaranteed by design, not tested in production.

<sup>(3)</sup> Based on configure: f<sub>HCLK</sub> = 120 MHz, AddressSetupTime = 0, AddressHoldTime = 1, DataSetupTime = 1.



| $t_{v(BL\_NE)}$           | EXMC_NEx low to EXMC_BL valid      | 23.9 | 25.9 | ns |
|---------------------------|------------------------------------|------|------|----|
| t <sub>v(DATA_NADV)</sub> | EXMC_NADV high to DATA valid       | 7.3  | _    | ns |
| t <sub>h(DATA_NWE)</sub>  | Data hold time after EXMC_NWE high | 7.3  | 9.3  | ns |

- (1)  $C_L = 30 pF$ .
- (2) Guaranteed by design, not tested in production.
- (3) Based on configure: f<sub>HCLK</sub> = 120 MHz, AddressSetupTime = 0, AddressHoldTime = 1, DataSetupTime = 1.

Table 4-44. Asynchronous multiplexed PSRAM/NOR read timings (1)(2)(3)

| Symbol                    | Parameter   | Min  | Max  | Unit |
|---------------------------|---|------|------|------|
| t <sub>w(NE)</sub>        | EXMC_NE low time                                      | 57.1 | 59.1 | ns   |
| t <sub>V(NOE_NE)</sub>    | EXMC_NEx low to EXMC_NOE low                          | 23.9 |      | ns   |
| t <sub>w(NOE)</sub>       | EXMC_NOE low time                                     | 32.2 | 34.2 | ns   |
| t <sub>h(NE_NOE)</sub>    | EXMC_NOE high to EXMC_NE high hold time               | 0    | _    | ns   |
| t <sub>v(A_NE)</sub>      | EXMC_NEx low to EXMC_A valid                          | 0    | _    | ns   |
| t <sub>v(A_NOE)</sub>     | Address hold time after EXMC_NOE high                 | 0    | _    | ns   |
| t <sub>v(BL_NE)</sub>     | EXMC_NEx low to EXMC_BL valid                         | 0    | _    | ns   |
| t <sub>h(BL_NOE)</sub>    | EXMC_BL hold time after EXMC_NOE high                 | 0    |      | ns   |
| t <sub>su(DATA_NE)</sub>  | Data to EXMC_NEx high setup time                      | 33.2 |      | ns   |
| t <sub>su(DATA_NOE)</sub> | Data to EXMC_NOEx high setup time                     | 33.2 |      | ns   |
| th(DATA_NOE)              | Data hold time after EXMC_NOE high                    | 0    | _    | ns   |
| t <sub>h(DATA_NE)</sub>   | Data hold time after EXMC_NEx high                    | 0    | _    | ns   |
| t <sub>v(NADV_NE)</sub>   | EXMC_NEx low to EXMC_NADV low                         | 0    | _    | ns   |
| t <sub>w(NADV)</sub>      | EXMC_NADV low time                                    | 7.3  | 9.3  | ns   |
| T <sub>h(AD_NADV)</sub>   | EXMC_AD(adress) valid hold time after  EXMC_NADV high | 7.3  | 9.3  | ns   |

- (1)  $C_L = 30 \text{ pF}.$
- (2) Guaranteed by design, not tested in production.
- (3) Based on configure: f<sub>HCLK</sub> = 120 MHz, AddressSetupTime = 0, AddressHoldTime = 1, DataSetupTime = 1.

Table 4-45. Asynchronous multiplexed PSRAWNOR write timings<sup>(1)(2)(3)</sup>

| Symbol                    | Parameter  | Min  | Max  | Unit |
|---------------------------|--|------|------|------|
| t <sub>w(NE)</sub>        | EXMC_NE low time                                       | 40.5 | 42.5 | ns   |
| t <sub>V(NWE_NE)</sub>    | EXMC_NEx low to EXMC_NWE low                           | 7.3  | _    | ns   |
| t <sub>w(NWE)</sub>       | EXMC_NWE low time                                      | 23.9 | 25.9 | ns   |
| t <sub>h(NE_NWE)</sub>    | EXMC_NWE high to EXMC_NE high hold time                | 7.3  | 1    | ns   |
| t <sub>v(A_NE)</sub>      | EXMC_NEx low to EXMC_A valid                           | 0    |      | ns   |
| t <sub>V(NADV_NE)</sub>   | EXMC_NEx low to EXMC_NADV low                          | 0    |      | ns   |
| t <sub>w(NADV)</sub>      | EXMC_NADV low time                                     | 7.3  | 9.3  | ns   |
| t <sub>h(AD_NADV)</sub>   | EXMC_AD(address) valid hold time after  EXMC_NADV high | 7.3  | _    | ns   |
| t <sub>h(A_NWE)</sub>     | Address hold time after EXMC_NWE high                  | 7.3  |      | ns   |
| t <sub>h(BL_NWE)</sub>    | EXMC_BL hold time after EXMC_NWE high                  | 7.3  | 1    | ns   |
| t <sub>v(BL_NE)</sub>     | EXMC_NEx low to EXMC_BL valid                          | 0    |      | ns   |
| t <sub>v(DATA_NADV)</sub> | EXMC_NADV high to DATA valid                           | 7.3  | _    | ns   |
| t <sub>h(DATA_NWE)</sub>  | Data hold time after EXMC_NWE high                     | 7.3  | _    | ns   |



- (1)  $C_L = 30 pF$ .
- (2) Guaranteed by design, not tested in production.
- (3) Based on configure: f<sub>HCLK</sub> = 120 MHz, AddressSetupTime = 0, AddressHoldTime = 1, DataSetupTime = 1.

Table 4-46. Synchronous multiplexed PSRAM/NOR read timings(1)(2)(3)

| Symbol                     | Parameter                        | Min  | Max | Unit |
|----------------------------|----------------------------------|------|-----|------|
| t <sub>w(CLK)</sub>        | EXMC_CLK period                  | 33.2 | 1   | ns   |
| t <sub>d(CLKL-NExL)</sub>  | EXMC_CLK low to EXMC_NEx low     | 0    |     | ns   |
| t <sub>d(CLKH-NExH)</sub>  | EXMC_CLK high to EXMC_NEx high   | 15.6 | _   | ns   |
| t <sub>d(CLKL-NADVL)</sub> | EXMC_CLK low to EXMC_NADV low    | 0    | _   | ns   |
| t <sub>d(CLKL-NADVH)</sub> | EXMC_CLK low to EXMC_NADV high   | 0    | _   | ns   |
| t <sub>d(CLKL-AV)</sub>    | EXMC_CLK low to EXMC_Ax valid    | 0    | _   | ns   |
| t <sub>d(CLKH-AIV)</sub>   | EXMC_CLK high to EXMC_Ax invalid | 15.6 | -   | ns   |
| t <sub>d(CLKL-NOEL)</sub>  | EXMC_CLK low to EXMC_NOE low     | 0    | 1   | ns   |
| t <sub>d(CLKH-NOEH)</sub>  | EXMC_CLK high to EXMC_NOE high   | 15.6 |     | ns   |
| t <sub>d(CLKL-ADV)</sub>   | EXMC_CLK low to EXMC_AD valid    | 0    | _   | ns   |
| t <sub>d(CLKL-ADIV)</sub>  | EXMC_CLK low to EXMC_AD invalid  | 0    | _   | ns   |

- (1)  $C_L = 30 pF$ .
- (2) Guaranteed by design, not tested in production.
- (3) Based on configure: f<sub>HCLK</sub> = 120 MHz, BurstAccessMode = Enable; Memory Type = PSRAM; WriteBurst = Enable; CLKDivision = 3 (EXMC\_CLK is 4 divided by HCLK); Data Latency = 1.

Table 4-47. Synchronous multiplexed PSRAM write timings<sup>(1)(2)(3)</sup>

| Symbol                     | Parameter                              | Min  | Max | Unit |
|----------------------------|--|------|-----|------|
| t <sub>w(CLK)</sub>        | EXMC_CLK period                        | 33.2 | ı   | ns   |
| t <sub>d(CLKL-NExL)</sub>  | EXMC_CLK low to EXMC_NEx low           | 0    | 1   | ns   |
| t <sub>d(CLKH-NExH)</sub>  | EXMC_CLK high to EXMC_NEx high         | 15.6 |     | ns   |
| t <sub>d(CLKL-NADVL)</sub> | EXMC_CLK low to EXMC_NADV low          | 0    |     | ns   |
| t <sub>d(CLKL-NADVH)</sub> | EXMC_CLK low to EXMC_NADV high         | 0    |     | ns   |
| t <sub>d(CLKL-AV)</sub>    | EXMC_CLK low to EXMC_Ax valid          | 0    | ı   | ns   |
| t <sub>d(CLKH-AIV)</sub>   | EXMC_CLK high to EXMC_Ax invalid       | 15.6 | ı   | ns   |
| t <sub>d(CLKL-NWEL)</sub>  | EXMC_CLK low to EXMC_NWE low           | 0    | ı   | ns   |
| t <sub>d(CLKH-NWEH)</sub>  | EXMC_CLK high to EXMC_NWE high         | 15.6 | ı   | ns   |
| t <sub>d(CLKL-ADIV)</sub>  | EXMC_CLK low to EXMC_AD invalid        | 0    | _   | ns   |
| t <sub>d(CLKL-DATA)</sub>  | EXMC_A/D valid data after EXMC_CLK low | 0    | _   | ns   |
| t <sub>h(CLKL-NBLH)</sub>  | EXMC_CLK low to EXMC_NBL high          | 0    | _   | ns   |

- (1)  $C_L = 30 pF$ .
- (2) Guaranteed by design, not tested in production.
- (3) Based on configure: f<sub>HCLK</sub> = 120 MHz, BurstAccessMode = Enable; MemoryType = PSRAM; WriteBurst = Enable; CLKDivision = 3 (EXMC\_CLK is 4 divided by HCLK); DataLatency = 1.



Table 4-48. Synchronous non-multiplexed PSRAM/NOR read timings(1)(2)(3)

| Symbol                     | ol Parameter                     |      | Max | Unit |
|----------------------------|----------------------------------|------|-----|------|
| t <sub>w(CLK)</sub>        | EXMC_CLK period                  | 33.2 | _   | ns   |
| t <sub>d(CLKL-NExL)</sub>  | EXMC_CLK low to EXMC_NEx low     | 0    | _   | ns   |
| t <sub>d(CLKH-NExH)</sub>  | EXMC_CLK high to EXMC_NEx high   | 15.6 | _   | ns   |
| t <sub>d(CLKL-NADVL)</sub> | EXMC_CLK low to EXMC_NADV low    | 0    | _   | ns   |
| t <sub>d(CLKL-NADVH)</sub> | EXMC_CLK low to EXMC_NADV high   | 0    | _   | ns   |
| t <sub>d(CLKL-AV)</sub>    | EXMC_CLK low to EXMC_Ax valid    | 0    | _   | ns   |
| t <sub>d(CLKH-AIV)</sub>   | EXMC_CLK high to EXMC_Ax invalid | 15.6 | _   | ns   |
| t <sub>d(CLKL-NOEL)</sub>  | EXMC_CLK low to EXMC_NOE low     | 0    | _   | ns   |
| t <sub>d(CLKH-NOEH)</sub>  | EXMC_CLK high to EXMC_NOE high   | 15.6 | _   | ns   |

<sup>(1)</sup>  $C_L = 30 pF$ .

Table 4-49. Synchronous non-multiplexed PSRAM write timings<sup>(1)(2)(3)</sup>

| Symbol                     | Parameter                              | Min  | Max | Unit |
|----------------------------|--|------|-----|------|
| t <sub>w(CLK)</sub>        | EXMC_CLK period                        | 33.2 | ı   | ns   |
| t <sub>d(CLKL-NExL)</sub>  | EXMC_CLK low to EXMC_NEx low           | 0    | 1   | ns   |
| t <sub>d(CLKH-NExH)</sub>  | EXMC_CLK high to EXMC_NEx high         | 15.6 |     | ns   |
| t <sub>d(CLKL-NADVL)</sub> | EXMC_CLK low to EXMC_NADV low          | 0    |     | ns   |
| t <sub>d(CLKL-NADVH)</sub> | EXMC_CLK low to EXMC_NADV high         | 0    |     | ns   |
| t <sub>d(CLKL-AV)</sub>    | EXMC_CLK low to EXMC_Ax valid          | 0    | ı   | ns   |
| t <sub>d(CLKH-AIV)</sub>   | EXMC_CLK high to EXMC_Ax invalid       | 15.6 | _   | ns   |
| t <sub>d(CLKL-NWEL)</sub>  | EXMC_CLK low to EXMC_NWE low           | 0    | _   | ns   |
| t <sub>d(CLKH-NWEH)</sub>  | EXMC_CLK high to EXMC_NWE high         | 15.6 | _   | ns   |
| t <sub>d(CLKL-DATA)</sub>  | EXMC_A/D valid data after EXMC_CLK low | 0    | _   | ns   |
| th(CLKL-NBLH)              | EXMC_CLK low to EXMC_NBL high          | 0    | _   | ns   |

<sup>(1)</sup>  $C_L = 30 pF$ .

<sup>(2)</sup> Guaranteed by design, not tested in production.

<sup>(3)</sup> Based on configure: HCLK=120 MHz, BurstAccessMode = Enable; MemoryType = PSRAM; WriteBurst = Enable; CLKDivision = 3 (EXMC\_CLK is 4 divided by HCLK); DataLatency = 1.

<sup>(2)</sup> Guaranteed by design, not tested in production.

<sup>(3)</sup> Based on configure: HCLK = 120 MHz, BurstAccessMode = Enable; MemoryType = PSRAM; WriteBurst = Enable; CLKDivision = 3 (EXMC\_CLK is 4 divided by HCLK); DataLatency = 1.



### 4.23. TIMER characteristics

Table 4-50. TIMER characteristics(1)

| Symbol           | Parameter                         | Conditions                       | Min    | Max                       | Unit                    |
|------------------|-----------------------------------|----------------------------------|--------|---------------------------|-------------------------|
| $t_{res}$        | Timer resolution time             | _                                | 1      |                           | tTIMERXCLK              |
| res              | Timer resolution time             | f <sub>TIMERxCLK</sub> = 120 MHz | 8.4    |                           | ns                      |
| <b>4</b>         | Timer system al ala ak fraguen av | _                                | 0      | f <sub>TIMERxCLK</sub> /2 | MHz                     |
| f <sub>EXT</sub> | Timer external clock frequency    | f <sub>TIMERxCLK</sub> = 120 MHz | 0      | 60                        | MHz                     |
| RES              | Timer resolution                  | _                                | _      | 16                        | bit                     |
| 4                | 16-bit counter clock period       |                                  | 1      | 65536                     | t <sub>TIMERxCLK</sub>  |
| tCOUNTER         | when internal clock is selected   | f <sub>TIMERxCLK</sub> = 120 MHz | 0.0084 | 546                       | μs                      |
| tury count       | Maximum possible count            | _                                | _      | 65536x65536               | t <sub>TIMERx</sub> CLK |
| tmax_count       | Maximum possible count            | f <sub>TIMERxCLK</sub> = 120 MHz |        | 35.7                      | s                       |

<sup>(1)</sup> Guaranteed by design, not tested in production.

### 4.24. WDGT characteristics

Table 4-51, FWDGT min/max timeout period at 40 kHz (IRC40K)<sup>(1)</sup>

| Prescaler divider | PR[2:0] bits | Min timeout RLD[11:0] =<br>0x000 | Max timeout RLD[11:0]<br>= 0xFFF | Unit |  |
|-------------------|--------------|----------------------------------|----------------------------------|------|--|
| 1/4               | 000          | 0.025                            | 409.525                          |      |  |
| 1/8               | 001          | 0.025                            | 819.025                          |      |  |
| 1/16              | 010          | 0.025                            | 1638.025                         |      |  |
| 1/32              | 011          | 0.025                            | 3276.025                         | ms   |  |
| 1/64              | 100          | 0.025                            | 6552.025                         |      |  |
| 1/128             | 101          | 0.025                            | 13104.025                        |      |  |
| 1/256             | 110 or 111   | 0.025                            | 26208.025                        |      |  |

<sup>(1)</sup> Guaranteed by design, not tested in production.

Table 4-52. WWDGT min-max timeout value at 60 MHz (f<sub>PCLK1</sub>)<sup>(1)</sup>

| Prescaler divider | PSC[1:0] | Min timeout value<br>CNT[6:0] = 0x40 | Unit | Max timeout value<br>CNT[6:0] = 0x7F | Unit |
|-------------------|----------|--------------------------------------|------|--------------------------------------|------|
| 1/1               | 00       | 68.2                                 |      | 4.3                                  |      |
| 1/2               | 01       | 136.4                                |      | 8.6                                  | mo   |
| 1/4               | 10       | 272.8                                | μs   | 17.2                                 | ms   |
| 1/8               | 11       | 545.6                                |      | 34.4                                 |      |

 $<sup>(1) \</sup>qquad \hbox{Guaranteed by design, not tested in production.}$ 

#### 4.25. Parameter condition

Unless otherwise specified, all values given for  $V_{DD} = V_{DDA} = 3.3 \text{ V}$ ,  $T_A = 25 \text{ }^{\circ}\text{C}$ .



# 5. Package information

## 5.1. LQFP144 package outline dimensions

DETAIL: F

DETAIL: F

SECTION B-B

SECTION B-B

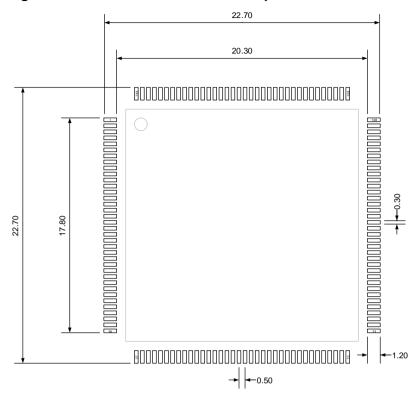
Figure 5-1. LQFP144 package outline

Table 5-1. LQFP144 package dimensions

| Symbol | Min   | Тур   | Max   |
|--------|-------|-------|-------|
| Α      | _     |       | 1.60  |
| A1     | 0.05  |       | 0.15  |
| A2     | 1.35  | 1.40  | 1.45  |
| A3     | 0.59  | 0.64  | 0.69  |
| b      | 0.18  | _     | 0.26  |
| b1     | 0.17  | 0.20  | 0.23  |
| С      | 0.13  |       | 0.17  |
| c1     | 0.12  | 0.13  | 0.14  |
| D      | 21.80 | 22.00 | 22.20 |
| D1     | 19.90 | 20.00 | 20.10 |
| E      | 21.80 | 22.00 | 22.20 |
| E1     | 19.90 | 20.00 | 20.10 |
| е      | _     | 0.50  | _     |
| L      | 0.45  | _     | 0.75  |
| L1     | _     | 1.00  | _     |
| θ      | 0°    | _     | 7°    |









## 5.2. LQFP100 package outline dimensions

Figure 5-3. LQFP100 package outline

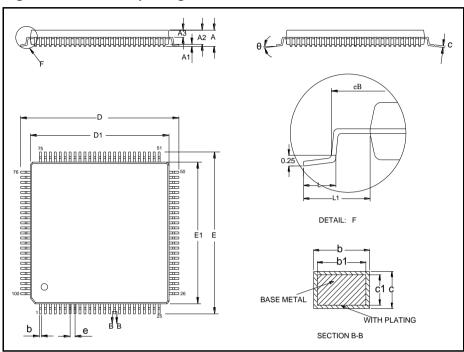
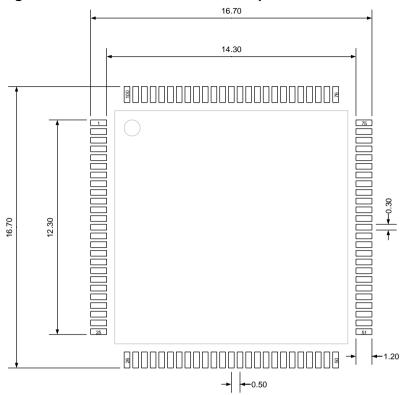


Table 5-2. LQFP100 package dimensions

| Symbol | Min   | Тур   | Max   |
|--------|-------|-------|-------|
| A      | _     | -77   | 1.60  |
| A1     | 0.05  | _     | 0.15  |
| A2     | 1.35  | 1.40  | 1.45  |
| A3     | 0.59  | 0.64  | 0.69  |
| b      | 0.18  | _     | 0.26  |
| b1     | 0.17  | 0.20  | 0.23  |
| С      | 0.13  | _     | 0.17  |
| c1     | 0.12  | 0.13  | 0.14  |
| D      | 15.80 | 16.00 | 16.20 |
| D1     | 13.90 | 14.00 | 14.10 |
| E      | 15.80 | 16.00 | 16.20 |
| E1     | 13.90 | 14.00 | 14.10 |
| е      | _     | 0.50  | _     |
| eB     | 15.05 | _     | 15.35 |
| L      | 0.45  | _     | 0.75  |
| L1     | _     | 1.00  | _     |
| θ      | 0°    | _     | 7°    |









## 5.3. LQFP64 package outline dimensions

Figure 5-5. LQFP64 package outline

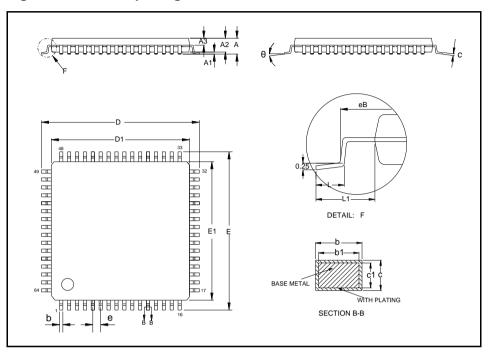
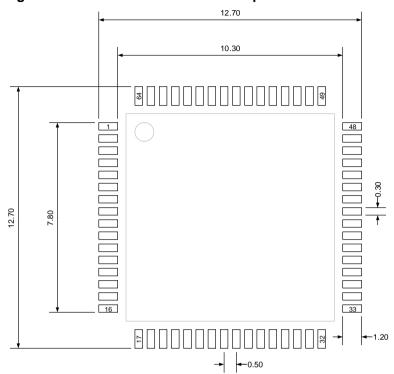


Table 5-3. LQFP64 package dimensions

| Symbol | Min   | Тур   | Max   |
|--------|-------|-------|-------|
| А      | _     |       | 1.60  |
| A1     | 0.05  |       | 0.15  |
| A2     | 1.35  | 1.40  | 1.45  |
| A3     | 0.59  | 0.64  | 0.69  |
| b      | 0.18  |       | 0.26  |
| b1     | 0.17  | 0.20  | 0.23  |
| С      | 0.13  | _     | 0.17  |
| c1     | 0.12  | 0.13  | 0.14  |
| D      | 11.80 | 12.00 | 12.20 |
| D1     | 9.90  | 10.00 | 10.10 |
| Е      | 11.80 | 12.00 | 12.20 |
| E1     | 9.90  | 10.00 | 10.10 |
| е      | _     | 0.50  | _     |
| eB     | 11.25 | _     | 11.45 |
| L      | 0.45  | _     | 0.75  |
| L1     | _     | 1.00  | _     |
| θ      | 0°    | _     | 7°    |



Figure 5-6. LQFP64 recommended footprint





#### 5.4. Thermal characteristics

Thermal resistance is used to characterize the thermal performance of the package device, which is represented by the Greek letter "0". For semiconductor devices, thermal resistance represents the steady-state temperature rise of the chip junction due to the heat dissipated on the chip surface.

 $\theta_{JA}$ : Thermal resistance, junction-to-ambient.

 $\theta_{JB}$ : Thermal resistance, junction-to-board.

 $\theta_{JC}$ : Thermal resistance, junction-to-case.

Ψ<sub>JB</sub>: Thermal characterization parameter, junction-to-board.

Ψ<sub>JT</sub>: Thermal characterization parameter, junction-to-top center.

$$\theta_{\mathsf{JA}} = (\mathsf{T}_{\mathsf{J}} - \mathsf{T}_{\mathsf{A}})/\mathsf{P}_{\mathsf{D}} \tag{5-1}$$

$$\theta_{JB} = (T_J - T_B)/P_D \tag{5-2}$$

$$\theta_{\rm JC} = (T_{\rm J} - T_{\rm C})/P_{\rm D} \tag{5-3}$$

Where,  $T_J$  = Junction temperature.

 $T_A$  = Ambient temperature

 $T_B$  = Board temperature

T<sub>C</sub> = Case temperature which is monitoring on package surface

 $P_D$  = Total power dissipation

 $\theta_{JA}$  represents the resistance of the heat flows from the heating junction to ambient air. It is an indicator of package heat dissipation capability. Lower  $\theta_{JA}$  can be considerate as better overall thermal performance.  $\theta_{JA}$  is generally used to estimate junction temperature.

 $\theta_{JB}$  is used to measure the heat flow resistance between the chip surface and the PCB board.

 $\theta_{JC}$  represents the thermal resistance between the chip surface and the package top case.  $\theta_{JC}$  is mainly used to estimate the heat dissipation of the system (using heat sink or other heat dissipation methods outside the device package).

Table 5-4. Package thermal characteristics(1)

| Symbol        | Condition                    | Package       | Value | Unit |
|---------------|------------------------------|---------------|-------|------|
|               |                              | LQFP144       | 48.76 |      |
| $\theta_{JA}$ | Natural convection, 2S2P PCB | LQFP100       | 47.19 | °C/W |
|               |                              | LQFP64        | 61.80 |      |
|               |                              | LQFP144       | 35.00 |      |
| θЈВ           | Cold plate, 2S2P PCB         | LQFP100 27.43 | °C/W  |      |
|               |                              | LQFP64        | 42.83 |      |
| θЈС           | Cold plate, 2S2P PCB         | LQFP144       | 12.03 | °C/W |



## GD32F307xx Datasheet

| Symbol      | Condition                    | Package | Value | Unit |
|-------------|------------------------------|---------|-------|------|
|             |                              | LQFP100 | 8.57  |      |
|             |                              | LQFP64  | 21.98 |      |
|             |                              | LQFP144 | 35.32 |      |
| $\Psi_{JB}$ | Natural convection, 2S2P PCB | LQFP100 | 31.42 | °C/W |
|             |                              | LQFP64  | 43.05 |      |
|             |                              | LQFP144 | 1.86  |      |
| $\Psi_{JT}$ | Natural convection, 2S2P PCB | LQFP100 | 1.00  | °C/W |
|             |                              | LQFP64  | 1.58  |      |

<sup>(1)</sup> Thermal characteristics are based on simulation, and meet JEDEC specification.



# 6. Ordering information

Table 6-1. Part ordering code for GD32F307xx devices

| Ordering code | Flash (KB) | Package | Package type | Temperature operating range  |
|---------------|------------|---------|--------------|------------------------------|
| GD32F307ZGT6  | 1024       | LQFP144 | Green        | Industrial<br>-40°C to +85°C |
| GD32F307ZET6  | 512        | LQFP144 | Green        | Industrial<br>-40°C to +85°C |
| GD32F307ZCT6  | 256        | LQFP144 | Green        | Industrial<br>-40°C to +85°C |
| GD32F307VGT6  | 1024       | LQFP100 | Green        | Industrial<br>-40°C to +85°C |
| GD32F307VET6  | 512        | LQFP100 | Green        | Industrial<br>-40°C to +85°C |
| GD32F307VCT6  | 256        | LQFP100 | Green        | Industrial<br>-40°C to +85°C |
| GD32F307RGT6  | 1024       | LQFP64  | Green        | Industrial<br>-40°C to +85°C |
| GD32F307RET6  | 512        | LQFP64  | Green        | Industrial<br>-40°C to +85°C |
| GD32F307RCT6  | 256        | LQFP64  | Green        | Industrial<br>-40°C to +85°C |



# 7. Revision history

Table 7-1. Revision history

| Revision No. | Description   | Date         |
|--------------|---|--------------|
| 1.0          | Initial Release   | Mar.20, 2017 |
| 1.1          | Repair history accumulation error   | Jan.24, 2018 |
| 1.2          | Repair history accumulation error   | Dec.16, 2018 |
| 1.3          | Add functional description of PD0 and PD1 to the packages below 100pin. Update electrical characteristics and package information.  | Mar.6.2020   |
| 1.4          | Correct the total number of ADC channel in features and peripheral list. refer to <i>Table 2-1. GD32F307xx devices</i> features and peripheral list   | Jun.30, 2021 |
| 1.5          | <ol> <li>Format adjustment</li> <li>Modify comment below table of absolute maximum ratings from 6.5V to 5.5V</li> <li>Modify sequence chart of SPI and I2S</li> <li>Modify DAC DNL from +-3 to +-5LSB</li> <li>Modify Vesd(cdm) from 800v to 750v</li> <li>Add PD parameter in Table4-1</li> <li>Modify min value of VIL(NRST) to -0.3, max value of VIH(NRST) to +0.3</li> <li>Add EMI parameters</li> <li>Correct pin number in LQFP64 POD</li> <li>Update the parameter of internal crystal temperature drift accuracy</li> <li>Add tread parameter in chapter of memory characteristics</li> <li>Add requirement description of sampling time of vrefint and internal temperature sensor is 17.1us</li> </ol> | Dec.31, 2022 |



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